



GT-64111

System Controller for RC4640,
RM523X and VR4300 CPUs

Product Preview
Revision 1.1
FEB 4, 1999

Please contact Galileo Technology for possible updates before finalizing a design.

FEATURES

- Integrated PCI system controller for high-performance cost sensitive embedded applications
- Support the following 32-bit bus CPUs:
 - IDT RC4640 and RC4650 (in 32-bit mode)
 - QED RM523X
 - NEC/Toshiba VR4300
- Up to 66MHz CPU bus frequency
- 64 byte CPU write posting buffer
 - 32-bit wide, 16 levels deep
 - Accepts CPU writes with zero wait-states
- EDO and Fast Page Mode DRAM controller
 - 512MB address space
 - Supports DRAM bank interleaving
 - 256KB-16MB device depth
 - 1- 4 banks supported
 - 32-bit or 64-bit data width
 - Parity supported
 - Zero wait-state interleaved burst accesses at 66MHz
- Device controller
 - 5 chip selects
 - Programmable timing for each chip select
 - Supports many types of standard memory and I/O devices
 - Up to 160MB address space
 - Optional external wait-state support
 - 8-,16-,32- and 64-bit width device support
 - Support for boot ROMs
 - Parity supported for devices
- Four channel DMA controller
 - Chaining via linked-lists of records
 - Byte alignment on source and destination
 - Transfers through 32-byte internal FIFO
 - Moves data between PCI, memory, and devices
- High-performance 32-bit Universal PCI 2.1 interface
 - 96-bytes of posted write and read prefetch buffers
 - 32-bit PCI master and target operations
 - PCI bus speed of up to 66MHz with no wait states
 - Operates either synchronous or asynchronous to CPU clock
 - Burst transfers used for efficient data movement
 - Doorbell interrupts provided between CPU and PCI
 - Supports flexible byte swapping through PCI interface
 - Synchronization barrier support
 - PCI configuration registers can be accessed from both CPU and PCI side
 - Support for both 5V and 3.3V operation
- Host to PCI bridge
 - Translates CPU cycles into PCI I/O or Memory cycles
 - Generates PCI Configuration, Interrupt Acknowledge, and Special cycles on PCI bus
- PCI to Main Memory bridge
 - Supports fast back-to-back transactions
 - Supports memory and I/O transactions to internal configuration registers
 - Supports locked operations
- Three 24-bit wide and one 32-bit wide timer/counters
- Plug and Play Support
 - PC compatible configuration registers
 - PCI configuration header can be loaded from boot PROM
 - PCI configuration registers are accessed from both CPU and PCI bus
- 3.3V Supply Voltage (PCI and Peripherals)
 - 5V tolerant I/Os
- 208 PQFP

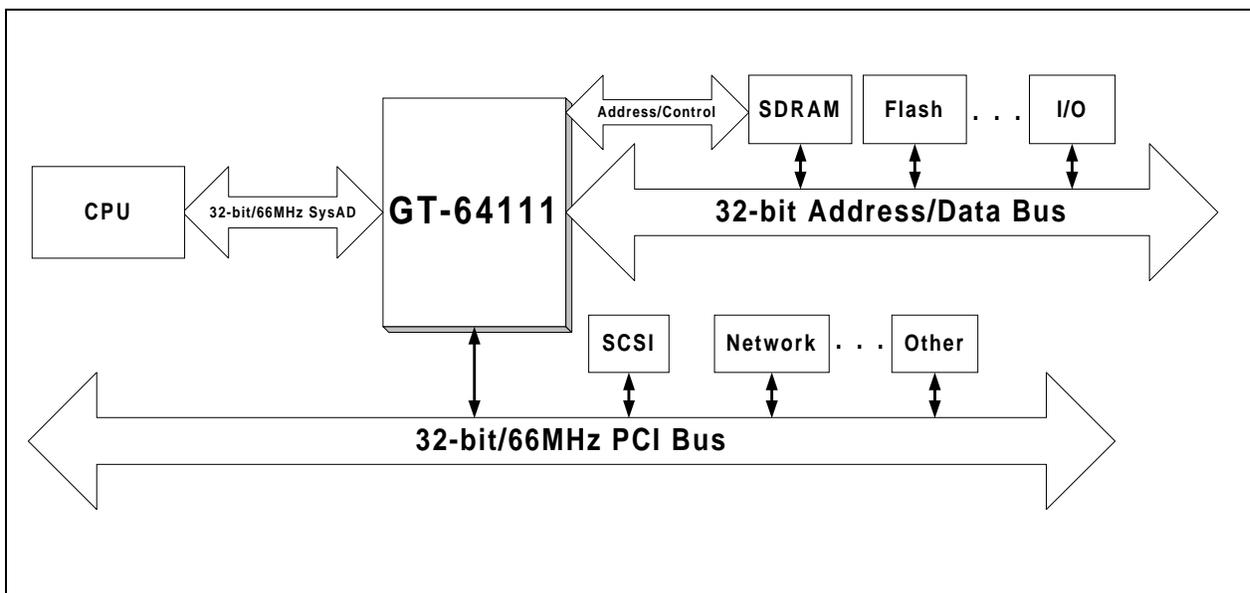


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1. OVERVIEW

The GT-64111 provides a single-chip solution for designers building systems around 32-bit bus/64-bit internal MIPS embedded processors. The architecture of the GT-64111 supports several system implementations for different applications and cost/performance points. It is possible to design a powerful system with minimal glue logic, or add commodity logic (controlled by the GT-64111) for differentiated system architectures that attain higher performance.

The GT-64111 has a three bus architecture:

- A 32-bit interface to the CPU bus (SysAD bus)
- A 32-bit interface to the memory and device subsystem.
- A 32-bit interface to the PCI bus.

The three buses are de-coupled from each other in most accesses, enabling concurrent operation of the CPU bus, PCI devices, and accesses to memory. For example, the CPU bus can write to the on-chip write buffer, a DMA agent can move data from DRAM to its own buffers, and a PCI device can write into an on-chip FIFO, all simultaneously.

1.1 CPU bus Interface

The GT-64111 SysAD bus allows the CPU and other local bus masters to access the PCI and memory/device buses. The SysAD bus protocol supports byte and 32-bit word operations with burst lengths up to 8 words (sub-word, 2 word, and 4 word transfers are also supported.) With a maximum frequency of 66MHz, the CPU can transfer in excess of 150 Mbytes/sec.

The GT-64111 can automatically determine if the attached MIPS processor is using the 8-bit SysCmd protocol (RC4640, RM523X) or the 5-bit SysCmd protocol (VR4300).

1.2 DRAM and Device Interface

The GT-64111 has a flexible DRAM controller that supports EDO as well as standard page mode DRAMs. With 45ns standard DRAMs, the GT-64111 can return data at 8-2-2-2-2-2-2¹ clocks with 32-bit DRAMs and at 8-1-1-1-1-1-1-1 clocks with 64-bit interleaved DRAMs to the CPU bus- at 66Mhz local bus speed. (In "wait-state" nomenclature this equates to 5-1-1-1-1-1-1-1 and 5-0-0-0-0-0-0-0.) The DRAM controller supports different depth devices in each bank.

NOTE: The performance achieved in interleave mode is equivalent to that possible with SDRAM. Furthermore, EDO does not have the granularity/memory waste issues associated with SDRAM (i.e. it is easy to build the smaller arrays required in many systems.)

The GT-64111 memory controller supports different types of memory and I/O devices. It has the control signals and the timing programmability to support devices such as Flash, EPROMs, SRAMs, FIFOs, and I/O controllers. Device widths from 8-bits to 64-bits are supported.

Parity generation and checking is supported externally and is optional for each bank of DRAM or any other device on the memory bus.

1.3 PCI Interface

The GT-64111 interfaces directly with the PCI bus. The GT-64111 can be either a master initiating a PCI bus operation, or a target responding to a PCI bus operation. The GT-64111 incorporates 96-bytes of posted write and read prefetch buffers for efficient data transfer between the CPU bus/DMA to PCI, and PCI to main memory.

The GT-64111 becomes a PCI bus master when the CPU bus or the internal DMA engine initiates a bus cycle to a PCI device. The following PCI bus cycles are supported: Memory Read/Write, Interrupt Acknowledge, Special, I/O Read/Write, or Configuration Read/Write.

The GT-64111 acts as a target when a PCI device initiates a memory access (or an I/O access in the case of internal registers). It responds to all memory read/write accesses, as well as to all configuration and I/O cycles in the case of internal registers.

The GT-64111 contains the required PCI configuration registers. All internal registers, including the PCI configuration

1. Note that Galileo uses "total clock" nomenclature and not "wait-state" nomenclature. This means that 8-1-1-1... means 8 clocks to the first data, 1 clock for each additional data (zero wait-states).

registers, can be accessed from both the CPU bus and the PCI bus. The GT-64111 configuration register set is PC Plug and Play compatible.

The PCI interface can operate up to 66MHz and is Universal PCI compatible (3.3V/5V).

1.4 DMA Engines

The GT-64111 incorporates four high performance DMA engines. Each DMA engine has the capability to transfer data between PCI devices, between PCI devices and main memory, or between devices residing on the device/memory bus. The DMA uses an internal 32-byte FIFO for temporary storage of DMA data. Source and destination addresses can be non-aligned on any byte address boundary. The DMA channels can be programmed by the CPU bus or by PCI masters, or without CPU bus intervention via a linked list of records that is loaded by the DMA controller into the channel's working set when a DMA transaction ends. The DMA supports increment/decrement/hold on source and destination addresses independently.

1.5 CPUs Supported

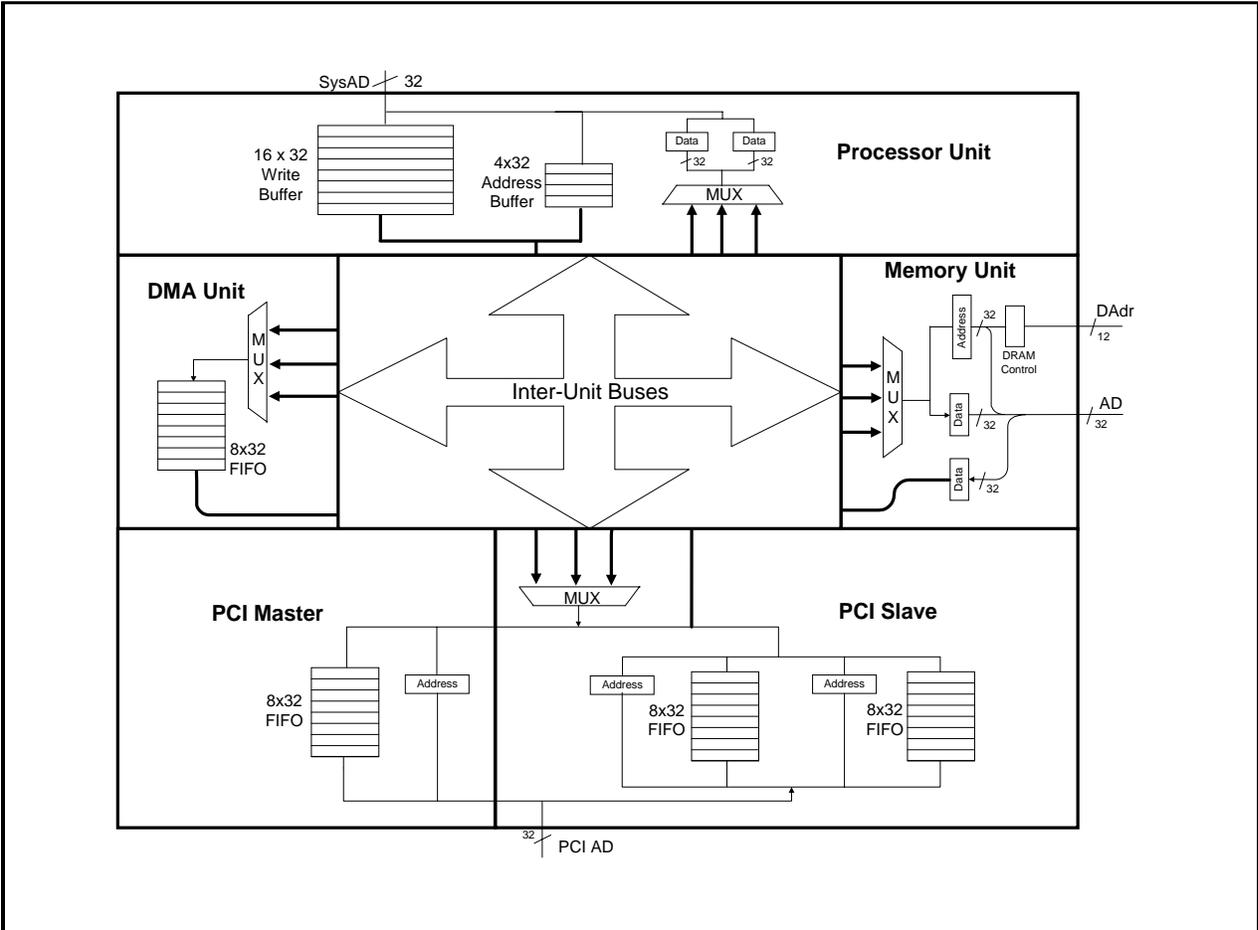
The GT-64111 can be used with the following processors:

- Integrated Device Technology's (www.idt.com) RC4640 and RC4650 (in 32-bit bus mode)
- Quantum Effect Design's (www.qedinc.com) RM523X
- NEC and Toshiba VR4300

1.6 Block Diagram

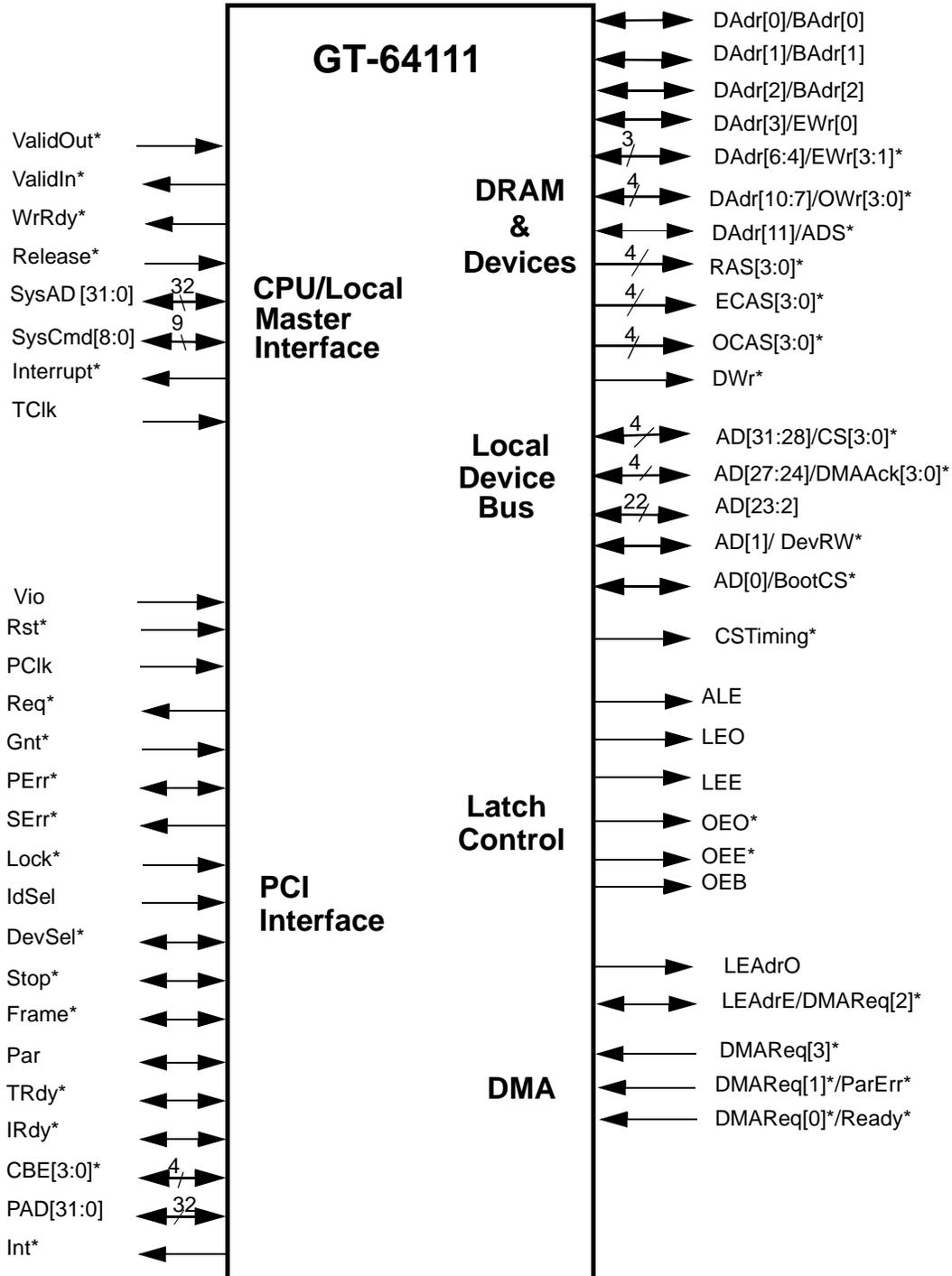
Figure 1, below, shows a simplified block diagram of the GT-64111.

Figure 1: GT-64111 Internal Block Diagram



2. Pin Information

2.1 Logic Symbol



2.2 Pin Assignment Table

Pin Name	I/O	Description
CPU/Local Master Interface		
Release*	I	Release Interface: Signals to the GT-64111 that the CPU/Local Master has released the SysAD and SysCmd buses for completion of a read request.
WrRdy*	O	Write Ready: The GT-64111 signals that it can accept a CPU/Local Master write request (i.e. there is room in the write posting FIFO.)
ValidIn*	O	Valid Input: The GT-64111 signals that it is driving valid data on the SysAD bus, and a valid data identifier on the SysCmd bus.
ValidOut*	I	Valid Output: Signals that the CPU/Local Master is driving valid address or data on the SysAD bus and a valid command or data identifier on the SysCmd bus.
SysAD[31:0]	I/O	System Address/Data Bus: A 32-bit address and data bus for communication between the CPU/Local Master and GT-64111.
SysCmd[8:0]	I/O	System Command/Data Identifier Bus: A 9-bit bus for command and data identifier transmission between the CPU/Local Master and GT-64111. Only bits SysCmd[4:0] are used when supporting the 4300 bus protocol.
Interrupt*	I/O	Interrupt: An "OR" of all the internal interrupt sources on the GT-64111. This pin is also sampled as an input at reset for configuration purposes.
TClk	I	Clock: The input clock to the GT-64111 (up to 66MHz). TClk is used for both the SysAD and Device interface. TClk must be driven for all applications, including those that do not use the CPU/Local Master bus.
PCI Interface		
PClk	I	PCI Clock: This pin provides the timing for the PCI transactions. The PCI clock range is between 0 and 66MHz. The PClk frequency must be lower than TClk by at least 1 MHz. Please see AC Timing Specifications for more information.
Rst*	I	Reset: Resets the GT-64111 to its initial state. This signal must be asserted for at least 10 PCI clock cycles. When in the reset state, all PCI output pins are put into tristate and all open drain signals are floated.
PAD[31:0]	I/O	PCI Address/Data: 32-bit multiplexed PCI address and data lines. During the first clock of the transaction, PAD[31:0] contains a physical byte address (32 bits). During subsequent clock cycles, PAD[31:0] contains data.
CBE[3:0]*	I/O	PCI Bus Command/Byte Enable: During the address phase of the transaction, CBE[3:0]* provide the PCI bus command. During the data phase, these lines provide the byte enables.
Par	I/O	Parity: Calculated by the GT-64111 as an even parity bit for the PAD[31:0] and CBE[3:0]* lines.
Frame*	I/O	Frame: Asserted by the GT-64111 to indicate the beginning and duration of a master transaction. Frame* asserts to indicate the beginning of the cycle. While Frame* is asserted, data transfer continues. Frame* deasserts to indicate that the next data phase is the final data phase transaction. Frame* is monitored by the GT-64111 when it acts as a target.
IRdy*	I/O	Initiator Ready: Indicates the bus master's ability to complete the current data phase of the transaction. A data phase is completed on any clock when both TRdy* and IRdy* are asserted. Wait cycles are inserted until TRdy* and IRdy* are asserted together.
TRdy*	I/O	Target Ready: Indicates the target agent's ability to complete the current data phase of the transaction. A data phase is completed on any clock when both TRdy* and IRdy* are asserted. Wait cycles are inserted until TRdy* and IRdy* are asserted together.

Pin Name	I/O	Description
Stop*	I/O	Stop: Indicates that the current target is requesting the bus master to stop the current transaction. As a master, the GT-64111 responds to the assertion of Stop* by disconnecting, retrying or aborting. As a target, the GT-64111 asserts Stop* to retry or disconnect.
Lock*	I	Lock: Indicates an atomic operation that may require multiple transactions to complete. When the GT-64111 is a PCI target, Lock* is sampled on the rising edge of the PClk when Frame* is asserted. If Lock* is sampled asserted, the GT-64111 enters into a locked state and remains in this state until Lock* is sampled deasserted on the following rising edge of PClk, when Frame* is sampled asserted.
IdSel	I	Initialization Device Select: Asserted to act as a chip select during PCI configuration read and write transactions.
DevSel*	I/O	Device Select: Asserted by the target of the current access. When the GT-64111 is bus master, it expects the target to assert DevSel* within 5 bus cycles, confirming the access. If the target does not assert DevSel* within the required bus cycles, the GT-64111 aborts the cycle. As a target, when the GT-64111 recognizes its transaction, it asserts DevSel* in a medium speed (two cycles after the assertion of Frame*).
Req*	O	Bus Request: Asserted by the GT-64111 to indicate to the PCI bus arbiter that it requires use of the PCI bus.
Gnt*	I	Bus Grant: Indicates to the GT-64111 that access to the PCI bus is granted.
PErr*	I/O	Parity Error: Asserted when a data parity error is detected.
SErr*	O	System Error: Asserted when a serious system error (not necessarily a PCI error) is detected. The GT-64111 asserts the SErr* two cycles after the failing address. This output features an open-drain driver.
Int*	O	Interrupt Request: Asserted by the GT-64111 when one of the unmasked internal interrupt sources is asserted. This output features an open-drain driver.
Vio	I	PCI Voltage Sense: This pin is used to detect the signalling voltage level of the PCI bus (5V or 3.3V). NOTE: This pin was Vref on the GT-64011 device.
DRAM & Devices		
DWr*	O	DRAM Write: LOW when the GT-64111 writes to the DRAM.
DAdr[0]/BAdr[0]	O	DRAM Address 0 / Burst Address 0: This pin has two functions. In an access to a DRAM bank, this pin functions as a DRAM address bit. In write and read accesses from devices that are 8-bit wide, this pin functions as byte address 0 in the packing process of data into 64-bits. In accesses to a word wide (32-bit) device, this bit functions as address 0 in a burst access (equivalent to SysAD[2]). Not used for 16/64 bit devices.
DAdr[1]/BAdr[1]	O	DRAM Address [1] / Burst Address [1]: In DRAM accesses, this pin functions as an address bit. In read accesses to devices that are 8-, or 16-bit wide, BAdr[2:1] function as a half word address in the packing process of data into 64 bits. In accesses to a 32-bit bank, BAdr[2:1] function as part of the (two MSB) burst address bits of an address into an eight word line or when packing/unpacking a 64-bit access (equivalent to SysAD[4:3]). In accesses to a 64-bit bank, BAdr[2:1] function as the two burst address bits of a four double word line (equivalent to SysAD[4:3]).

Pin Name	I/O	Description
DAdr[2]/BAdr[2]/ EROMEn*	O	<p>DRAM Address [2] / Burst Address [2]: In DRAM accesses, this pin functions as an address bit. In read access to devices that are 8- or 16-bit wide, BAdr[2:1] function as a half word address in the packing process of data into 64 bits. In accesses to a 32-bit bank, BAdr[2:1] function as part of the (two MSB) burst address bits of an address into an eight word line or when packing/unpacking a 64-bit access (equivalent to SysAD[4:3]). In accesses to a 64-bit bank, BAdr[2:1] function as the two burst address bits of a four double word line (equivalent to SysAD[4:3]).</p> <p>This pin is sampled at RESET to determine if the PCI expansion ROM Base Address register is enabled.</p>
DAdr[3]/EWr[0]*	O	<p>DRAM Address [3] / Even Bank Byte Write [0]: In DRAM accesses this pin functions as DRAM address. In device writes it functions as a byte write enable indication to the even bank byte 0.</p>
DAdr[6:4]/ EWr[3:1]*	I/O	<p>DRAM Address [6:4] / Even Bank Byte Write [3:1]: In DRAM accesses these pins function as DRAM address. In device writes, they function as byte write enable indications to the even bank bytes [3:1]. These pins are sampled as inputs at reset for configuration purposes.</p>
DAdr[10:7]/ OWr[3:0]*	I/O	<p>DRAM Address [10:7] / Odd Bank Byte Write [3:0]: In DRAM accesses these pins function as DRAM address. In device writes, they function as byte write enable indications to the odd bank bytes [3:0]. These pins are sampled as inputs at reset for configuration purposes.</p>
DAdr[11]/ADS*	I/O	<p>DRAM Address [11] / Address Strobe: The default state of DAdr[11]/ADS* is to function only as DAdr[11]. Optionally, this pin is software configurable to only behave as ADS* via bit 17 of the DRAM Configuration register. When this pin functions as ADS*, it is an active LOW address data strobe which indicates the beginning of a device transaction. This pin is sampled as an input at reset for configuration purposes.</p>
RAS[3:0]*	O	<p>Row Address Select: Supports four banks of DRAM. The DRAM banks can be 32-(36-) bit or 64-(72-) bit wide.</p>
ECAS[3:0]*	O	<p>Even Column Address Select: Supports byte writes/reads to the even bank of the DRAM (when interleaved.) If the bank is not interleaved, ECAS[3:0]* is the same as OCAS[3:0]*.</p>
OCAS[3:0]*	O	<p>Odd Column Address Select: Supports byte writes/reads to the odd bank of the DRAM (when interleaved.) If the bank is not interleaved, OCAS[3:0]* is the same as ECAS[3:0]*.</p>
Local AD Bus		
AD[31:28]/ CS[3:0]*	I/O	<p>Data [31:28] / Chip Select [3:0]: In the data phase, these pins function as data bits [31:28]. In the address phase, Device Chip Selects are valid (and should be latched). The Chip Selects need to be qualified with the CSTiming* signal. Latching is done via ALE.</p> <p>CS3* is also used to indicate an access to the expansion ROM from the PCI bus interface.</p>
AD[27:24]/ DMAAck[3:0]*	I/O	<p>Data [27:24] / DMA Acknowledge[3:0]: In the data phase, these pins function as data bits [27:24]. In the address phase, DMA Acknowledges are valid (and should be latched). They need to be qualified with the CSTiming* signal. Latching is done via ALE.</p>
AD[23:2]	I/O	<p>Address/Data[23:2]: Multiplexed address and data bus to the DRAM (data only) and the devices (address and data).</p>

Pin Name	I/O	Description
AD[1]/DevRW*	I/O	Data [1] / Device Read-Write: In the data phase it is data bit 1. In the address phase, it indicates if an access to a device is a read ('1') or a write ('0'). Latching is done via ALE.
AD[0]/BootCS*	I/O	Data [0]/ Boot Chip Select: In the data phase it is data bit 0. In the address phase, it is the boot device chip select. Latching is done via ALE.
CSTiming*	O	Chip Select Timing: Active for the number of cycles that the device that is currently being accessed was programmed to. Used to qualify the CS[3:0]*, BootCS and the DMAAck[3:0]* signals.
Latch Control		
ALE	O	Address Latch Enable: Used to latch the Address, BootCS*, CS[3:0]*, DevRW* and DMAAck[3:0]* from the AD bus.
LEO	O	Latch Enable Odd: Used to latch data to or from the odd bank devices.
LEE	O	Latch Enable Even: Used to latch data to or from the even bank devices.
OEO*	O	Output Enable Odd: Output data from the latch of the odd bank to the AD bus.
OEE*	O	Output Enable Even: Output data from the latch of the even bank to the AD bus.
OEB	O	Output Enable Write: Output data from the latch of the AD bus to the memory bus. This signal is only active during writes to DRAM or devices, and its polarity is programmable at reset.
LEAdrO	O	Latch Enable Address Odd: Used to latch the DRAM address and device burst address of the odd bank.
LEAdrE/ DMAReq[2]*	I/O	Latch Enable Address Even / DMA Request: Multiplexed signal that can be used to latch the DRAM address and device address of the even bank or, as a DMA request indication by an external device. Its function is designated at reset.
DMA		
DMAReq[3]*/ AutoLoad*	I	DMA Request[3]: DMA request indication by an external device. This pin is sampled on Rst* to enable auto-load mode of PCI configuration registers. 0 - Auto-load mode Enabled 1 - Auto-load mode Disabled
DMAReq[1]*/ ParErr*	I	DMA Request [1] / DMA Parity Error: DMA request indication by an external device or parity error indication by external logic. The function of this pin is programmable at reset.
DMAReq[0]*/ Ready*	I	DMA Request [0] / Ready: This pin has two functions: it serves as a DMA request indication by an external device, or as a cycle extender (when inactive during a device access, an access will extend until Ready* is asserted). The function of this pin is programmable at reset.

3. CPU/Local Master Interface

The GT-64111 SysAD bus interface allows the CPU/Local Master to gain access to the GT-64111’s internal registers, PCI interface and the memory/device bus (AD bus). The SysAD bus supports accesses from one to 32 bytes in length.

The SysAD bus on the GT-64111 is a slave-only interface; the GT-64111 will never master the SysAD bus.

3.1 CPU/Local Master Interface Signals

The CPU/Local Master interface incorporates the following signals:

- SysAD[31:0] - Master Address/Data. This bus transfers multiplexed address/data.
- SysCmd[8:0] - Master Port Command. The SysCmd bus transfers information about the access (read/write, size) and the data identifier (good/bad, last word.) Only SysCmd[4:0] are used in VR4300 mode.
- ValidOut* - Indicates that the CPU/Local Master is driving valid address/data/command on the CPU/Local Master bus.
- ValidIn* - Indicates that the GT-64111 is driving valid data/data identifier on the CPU/Local Master bus.
- WrRdy* - Indicates that the GT-64111 is capable of accepting a write transaction up to 8 words in length.
- Release* - Indicates to the GT-64111 that the CPU/Local Master will not drive the SysAD after the current clock cycle (i.e. the CPU/Local Master is floating the SysAD and SysCmd bus for completion of a read.)

The SysAD bus is synchronous with respect to TClk and is locked with respect to the AD bus. The SysAD may be asynchronous with respect to the PCI bus, or locked to the PCI bus for lower synchronization latency.

3.2 SysAD and SysCmd Buses (9-bit SysCmd Mode)

The SysAD and SysCmd bus protocol implemented by the GT-64111 is completely compatible with the 32-bit Orion bus protocol used by the IDT R4640 and R4650 processors. The GT-64111 extends this protocol to support bursts less than 8 32-bit words. These extensions can be used by DMA engines on the SysAD bus for more efficient use of the interface.

The SysAD[31:0] bus is a 32-bit multiplexed address/data bus. The CPU/Local Master drives address for a single cycle then either drives data (for a write) or floats the bus in anticipation of returned data (for a read.)

The SysCmd[8:0] bus conveys information about the transaction such as the direction (read/write), the size (byte, short, word, multi-word) and the status of the data (good/bad/last.) SysCmd is driven by the CPU/Local Master during the address phase of a transaction (with direction/size information) and for the duration of a write (with good/bad/last information.) The GT-64111 drives SysCmd during the data phase of read transactions.

The encodings for SysCmd[8:0] are shown in the tables below. Note that many encodings are not defined; these encodings are reserved and must not be used. A summary of bit usage is shown below.

TABLE 1. SysCmd Bit Summary

SysCmd Bit	Function
SysCmd[8]	0 = Transaction information (read/write/size) 1 = Data information (good/bad/last)
SysCmd[7]	Indicates last data/not last data during data cycles. Must be '0' for address cycles.
SysCmd[6]	0 = Read transaction (during address cycles) 1 = Write transaction (during address cycles) Must be '0' for data cycles.
SysCmd[5]	Indicates error status for data cycles. Must be '0' for address cycles.

TABLE 1. SysCmd Bit Summary

SysCmd Bit	Function
SysCmd[4]	CPU mode select 0 - VR4300 mode 1 - R4600 mode
SysCmd[3:0]	Encoded to indicate size of the transfer

TABLE 2. Address Phase SysCmd[8:0] Encodings (driven by CPU/Local Master)

SysCmd[8:0] Encoding ¹									Command Mnemonic	Command Description
8	7	6	5	4	3	2	1	0		
0	0	0	0	1	1	0	0	0	RdByte	Read a single byte
0	0	0	0	1	1	0	0	1	RdShort	Read 16 bits
0	0	0	0	1	1	0	1	0	RdTriByte	Read 3 bytes
0	0	0	0	1	1	0	1	1	RdWord	Read 4 bytes (single word)
0	0	0	0	1	1	1	X	X	Rd2Words	Read 2 words (8 bytes) in a burst
0	0	0	0	1	0	X	X	0	Rd4Words	Read 4 words (16 bytes) in a burst
0	0	0	0	1	0	X	X	1	Rd8Words	Read 8 words (32 bytes) in a burst
0	0	1	0	1	1	0	0	0	WrByte	Write a single byte
0	0	1	0	1	1	0	0	1	WrShort	Write 16 bits
0	0	1	0	1	1	0	1	0	WrTriByte	Write 3 bytes
0	0	1	0	1	1	0	1	1	WrWord	Write 4 bytes (single word)
0	0	1	0	1	1	1	X	X	Wr2Words	Write 2 words (8 bytes) in a burst
0	0	1	0	1	0	X	X	0	Wr4Words	Write 4 words (16 bytes) in a burst
0	0	1	0	1	0	X	X	1	Wr8Words	Write 8 words (32 bytes) in a burst

1. 'X' denotes "don't care" but 'X' signals must be driven to a valid 0/1.

TABLE 3. Data Identifier SysCmd[8:0] Encodings (driven by GT-64111)

SysCmd[8:0] Encoding ¹									Command Mnemonic	Command Description
8	7	6	5	4	3	2	1	0		
1	0	0	E	X	X	X	X	X	REOD	Indicates last valid data in a burst E = 0 Data is good E = 1 Data is erroneous
1	1	0	E	X	X	X	X	X	RD	Indicates valid data within a burst E = 0 Data is good E = 1 Data is erroneous

1. 'X' denotes "don't care" but 'X' signals are driven to a valid 0/1 by GT-64111.

TABLE 4. CPU/Local Master Data Identifier SysCmd[8:0] Encodings (driven by CPU/Local Master)

SysCmd[8:0] Encoding ¹									Command Mnemonic	Command Description
8	7	6	5	4	3	2	1	0		
1	0	1	E	X	X	X	X	X	WEOD	Indicates last valid data in a burst E = 0 Data is good E = 1 Data is erroneous
1	1	1	E	X	X	X	X	X	WD	Indicates valid data within a burst E = 0 Data is good E = 1 Data is erroneous

1. 'X' denotes "don't care" but 'X' signals are driven to a valid 0/1.

3.2.1 SysAD Read Protocol

SysAD reads occur in three phases:

- The address phase in which address information is driven on the SysAD bus and command information is driven on SysCmd.
- The mid-burst data phase during which the GT-64111 drives data on the SysAD bus and a data identifier on SysCmd. The mid-burst data phase is entered between the address phase and the last data of the burst.
- The last data phase of the burst is when the GT-64111 drives data on the SysAD bus and a read end-of-data (REOD) data identifier on SysCmd.

The address phase for all transactions begin with the assertion of ValidOut* to the GT-64111. Valid address and command information must be present on SysAD and SysCmd during this phase. Release* must also be asserted to the GT-64111 to indicate that the CPU/Local Master is releasing mastership of the SysAD/SysCmd buses to the GT-64111 for completion of the read. ValidOut* is deasserted at the end of the address phase since the CPU/Local Master is no longer driving information on SysAD/SysCmd.

For transactions longer than 32 bits, the mid-burst data phase is entered next. The GT-64111 will drive valid data on SysAD, a valid data identifier (mnemonic = RD) on SysCmd, and will assert ValidIn* to qualify the SysAD and SysCmd buses (see Figure 2).

The last data phase of the read burst is differentiated from the mid-burst state by the REOD data identifier driven on the SysCmd bus. The last data phase of the burst is also entered for the datum returned for a single word, or sub-word, read.

On the clock cycle following REOD, the GT-64111 floats the SysAD and SysCmd buses, returning ownership to the CPU/Local Master.

Figure 2: Single Word Read Through CPU/Local Master Interface

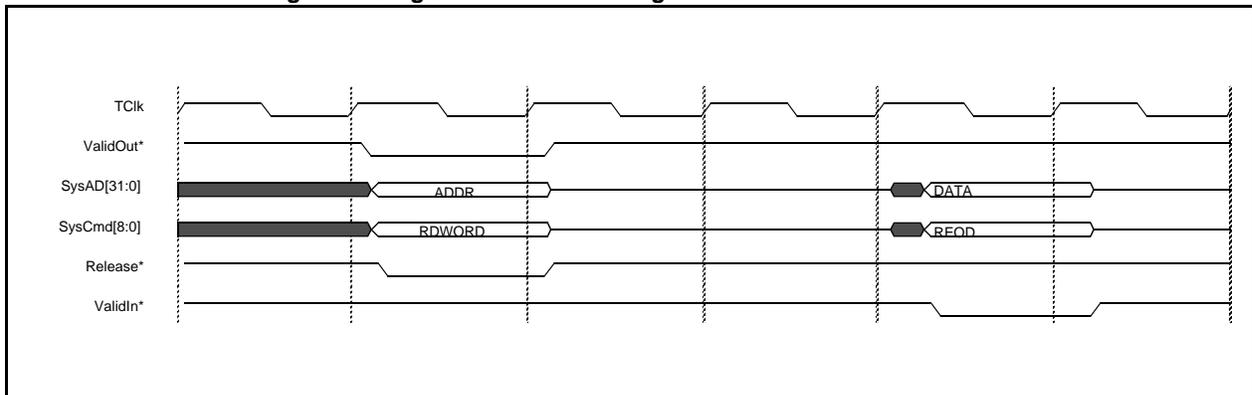
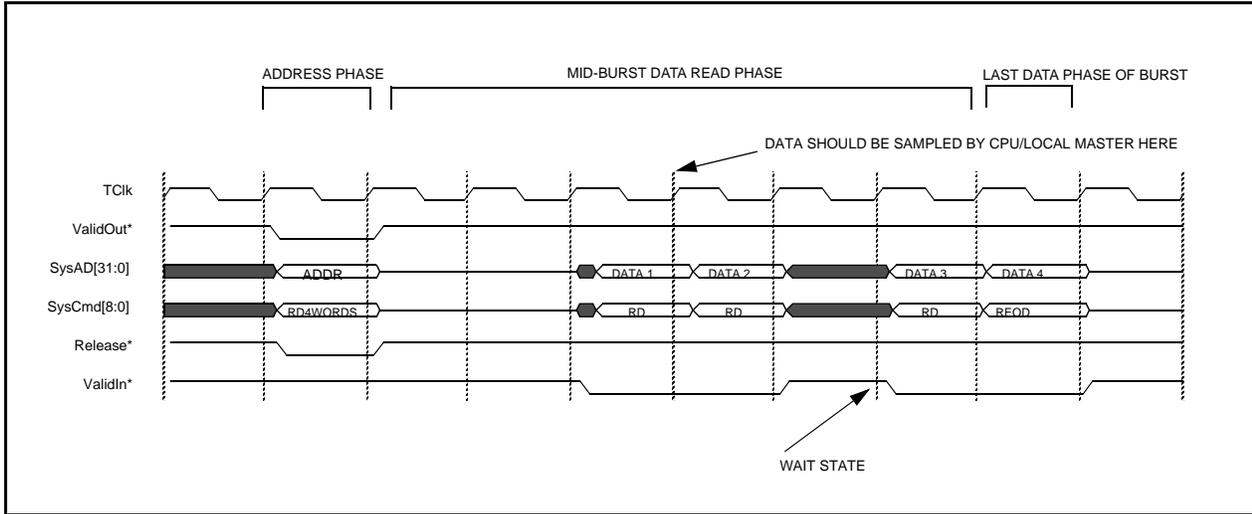


Figure 3: Four Word Burst Read through CPU/Local Master Interface



3.2.2 SysAD Write Protocol

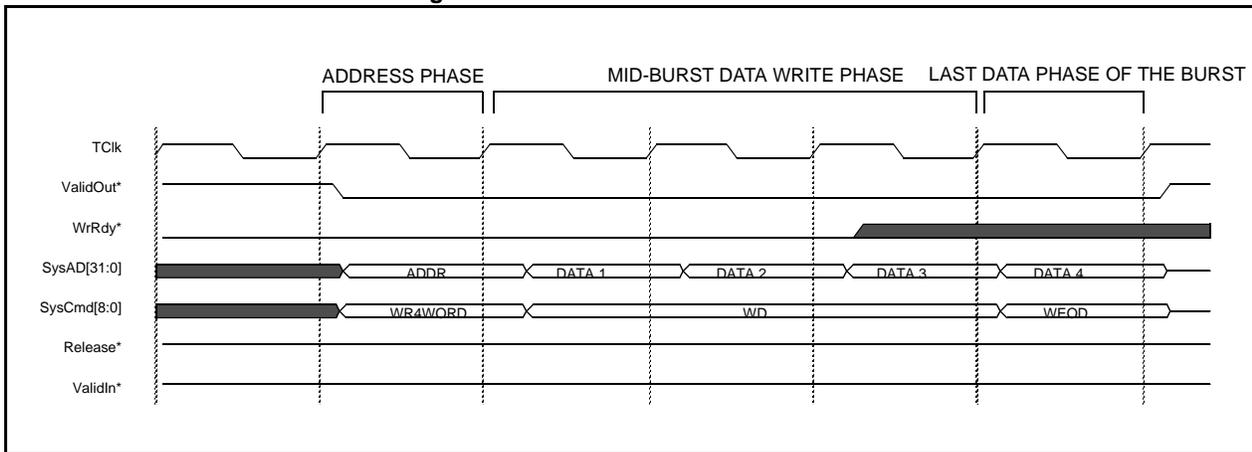
CPU/Local Master writes occur in three phases:

- The address phase in which address information is driven on the SysAD bus and command information is driven on SysCmd.
- The mid-burst write data phase during which the CPU/Local Master drives data on the SysAD bus and a write data identifier (mnemonic = WD) on SysCmd. The mid-burst write data phase is entered between the address phase and the last data phase of the write burst.
- The last data phase of the write burst is when the CPU/Local Master drives data on the SysAD bus and a write end-of-data (WEOD) data identifier on SysCmd.

The address phase for write transactions begin with the assertion of ValidOut* to the GT-64111. Valid address and command information must be present on SysAD and SysCmd during this phase. Release* remains high for write transactions since the CPU/Local Master is not relinquishing ownership of the bus. ValidOut* is remains asserted throughout a write transaction as the CPU/Local Master always driving valid information on SysAD/SysCmd.

For transactions longer than 32 bits, the mid-burst data write phase is entered next. The CPU/Local Master drives valid data on SysAD, a valid write data identifier (mnemonic = WD) on SysCmd (see Figure 4).

Figure 4: CPU/Local Master Burst Write



The last data phase of the write burst is differentiated by from the mid-burst state by the WEOD data identifier driven on the SysCmd bus. The last data phase of the burst is also entered for the datum written for a single word, or sub-word, write. On the clock cycle following WEOD, the GT-64111 returns to the idle state.

NOTE: CPU/Local Master writes cannot be issued as long as WrRdy* is deasserted (HIGH). If WrRdy* is high and an CPU/Local Master write is attempted, data from previous write cycles may be corrupted (see section 3.4.) Note that all MIPS compliant processors follow this protocol, it is only DMA engines on the SysAD bus that need to be concerned with sampling WrRdy* before initiating a write.

3.3 4300 Bus Mode Support (5-bit SysCmd Mode)

The GT-64111 can automatically detect (during the first read transaction) when a 4300 bus compatible processor is attached. The 4300 uses a 5-bit SysCmd bus encoding that is similar, but incompatible, with the 9-bit SysCmd used by 4640 style processors. All other bus signals and timings are compatible between the two processor bus protocols.

The encodings for SysCmd[4:0] are shown in the tables below. Note that many encodings are not defined; these encodings are reserved and must not be used. In 4300 mode, SysCmd[8:5] are not used and should be tied to GND. A summary of bit usage is shown below.

TABLE 5. SysCmd Bit Summary

SysCmd Bit	Function
SysCmd[4]	0 = Transaction information (read/write/size) 1 = Data information (good/bad/last)
SysCmd[3]	Read/Write Indicator for address cycles 0 = Read transaction 1 = Write transaction Last data indicator for data cycles 0 = Last data 1 = Not last data
SysCmd[2]	Read/Write Attributes for address cycles 0 = single read/write 1 = block read/write Response data indicator for data cycles 0 = response data 1 = not response data Reserved for CPU driven data cycles
SysCmd[1:0]	Size indicator for reads/writes for address cycles Error status indicator for data cycles.

TABLE 6. Address Phase SysCmd[4:0] Encodings (driven by CPU/Local Master)

SysCmd[4:0] Encoding					Command Mnemonic	Command Description
4	3	2	1	0		
0	0	0	0	0	RdByte	Read a single byte
0	0	0	0	1	RdShort	Read 16 bits
0	0	0	1	0	RdTriByte	Read 3 bytes
0	0	0	1	1	RdWord	Read 4 bytes (single word)
0	0	1	0	0	Rd2Words	Read 2 words (8 bytes) in a burst
0	0	1	0	1	Rd4Words	Read 4 words (16 bytes) in a burst
0	0	1	1	0	Rd8Words	Read 8 words (32 bytes) in a burst
0	1	0	0	0	WrByte	Write a single byte
0	1	0	0	1	WrShort	Write 16 bits
0	1	0	1	0	WrTriByte	Write 3 bytes
0	1	0	1	1	WrWord	Write 4 bytes (single word)
0	1	1	0	0	Wr2Words	Write 2 words (8 bytes) in a burst
0	1	1	0	1	Wr4Words	Write 4 words (16 bytes) in a burst
0	1	1	1	0	Wr8Words	Write 8 words (32 bytes) in a burst

TABLE 7. Data Identifier SysCmd[4:0] Encodings (driven by GT-64111)

SysCmd[4:0] Encoding ¹					Command Mnemonic	Command Description
4	3	2	1	0		
1	0	0	E	X	REOD	Indicates last valid data in a burst E = 0 Data is good E = 1 Data is erroneous
1	1	0	E	X	RD	Indicates valid data within a burst E = 0 Data is good E = 1 Data is erroneous

1. 'X' denotes "don't care" but 'X' signals are driven to a valid 0/1.

TABLE 8. CPU/Local Master Data Identifier SysCmd[4:0] Encodings (driven by CPU/Local Master)

SysCmd[4:0] Encoding ¹					Command Mnemonic	Command Description
4	3	2	1	0		
1	0	1	E	X	WEOD	Indicates last valid data in a burst E = 0 Data is good E = 1 Data is erroneous
1	1	1	E	X	WD	Indicates valid data within a burst E = 0 Data is good E = 1 Data is erroneous

1. 'X' denotes "don't care" but 'X' signals are driven to a valid 0/1.

3.4 Operation of WrRdy* and the Internal Write Posting Queues

The GT-64111's CPU/Local Master interface includes a write posting queue that absorbs local CPU/Local Master writes at zero wait-states. This is required per the MIPS SysAD bus write protocol.

The write posting queue has 4 address entries and 16 32-bit data entries. The GT-64111 signals if there is "room" in the CPU/Local Master write posting queue by asserting WrRdy*. If WrRdy* is asserted then the CPU/Local Master may issue a write of up to 8 words.

WrRdy* will be deasserted the cycle immediately following when:

- The address FIFO has two valid entries and a third address is being pushed, or...
- The address FIFO has more than two valid entries, or...
- The address FIFO has two valid entries or more, the data FIFO has four valid entries and a fifth one is being pushed, or...
- The address FIFO has two valid entries or more, the data FIFO has more than four valid entries, or...
- The address FIFO has one valid entry, the data FIFO has six valid entries and a seventh one is being pushed, or...
- The address FIFO has one valid entry, the data FIFO has more than six valid entries.

WrRdy* will be re-asserted the cycle following a transaction away from the states above.

It is not necessary to take the above scenarios into account when designing a system with the GT-64111. MIPS compliant processors such as the R4640 and R4650 sample WrRdy* automatically before issuing a write. Only DMA devices on SysAD need to be concerned about the functionality of WrRdy*, as mentioned above.

3.5 MIPS Write Modes and Write Patterns Supported

The GT-64111 supports both pipelined and R4000 compatible write modes (with 2 dead cycles between consecutive writes). The default mode is pipelined, however R4000 mode can be selected in the CPU/Local Master Interface Configuration Register.

The CPU/Local Master interface supports only DDDDDDDD and DXDXDXDXDXDXDXDX write patterns. Be sure to select one of these two write patterns via the MIPS serial initialization bitstream during the CPU/Local Master reset process.

3.6 CPU/Local Master Interface Endianess

The GT-64111 provides the capability to swap the endianess of data transferred to/from the internal registers, to/from the PCI interface, and to/from the memory bus. Please see the relevant chapter in the applications section for more information.

3.7 Burst Order

The GT-64111 supports the sub-block ordered bursts used by Orion MIPS processors, by default. Sub-block ordered bursts are optimized for the burst patterns used by most synchronous SRAMs and SDRAMs.

Linear burst order is also supported for attaching processors other than the MIPS family. Linear burst order is enabled by setting bit 9 in the DRAM Bank2 Parameters register at offset 0x454.

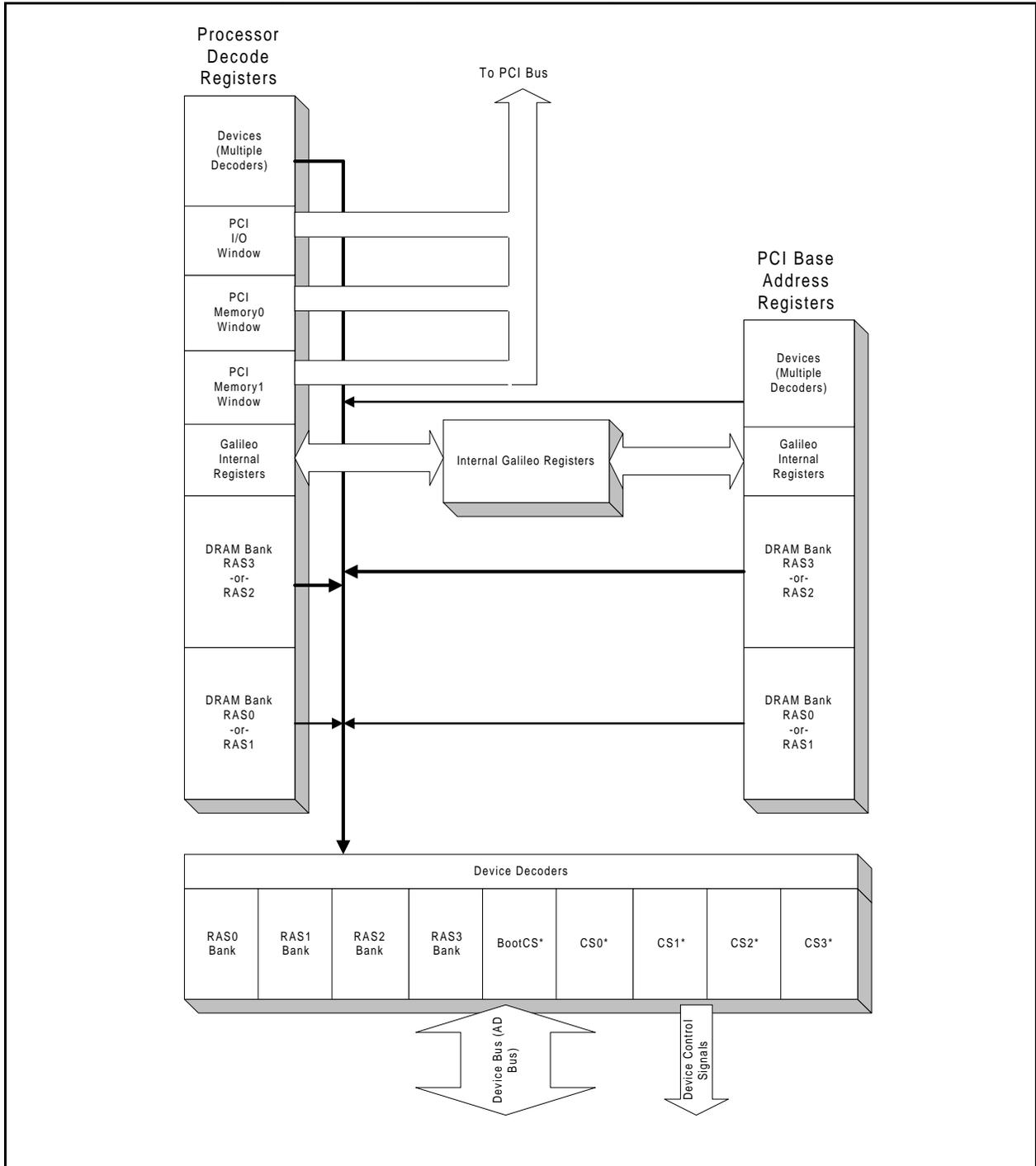
3.8 CPU/Local Master Interface Restrictions

1. The CPU should not attempt an access before 10 TClk cycles following deassertion of Rst* have expired.
2. CacheOpMap should not be written to a value other than 0 unless CachePres bit is set (see Register Section).
3. The CPU Interface supports only DDDDDDDD and DXDXDXDXDXDXDXDX write patterns.
4. A PCI I/O read intended for synchronization barrier should not be more than one long word (4 bytes). Any PCI I/O read of more than 4 bytes will be carried out without checking the internal FIFOs.
5. A write of more than 4 bytes to internal space will be ignored. A read of more than 4 bytes to internal space will result in transaction termination with bus-error indication (SysCmd[5] equal '1').
6. ValidOut* signal must have a pullup resistor to VCC. This is done in order to prevent GT-64111 to identify wrongly the CPU type (RC4640/RM523X or R4300) due to unstable ValidOut* signal when getting out of reset.

4. Address Space Decoding

The GT-64111 has a fully programmable address map. Two address spaces exist: the CPU/Local Master address space and the PCI address space (see Figure 5.) Both address maps use a two-stage decoding process where major device regions are decoded first, then the individual devices are subdecoded.

Figure 5: Two Stage Address Decoding- Conceptual View



4.1 Two Stage Decoding Process

The system resources are divided into eight groups: RAS[1:0], RAS[3:2], CS[2:0], CS[3] & BootCS, Internal Registers, PCI I/O, and PCI Memory 0/1. Each group can have a minimum of 2 Mbytes and a maximum of 256 Mbytes of address space. The individual devices in the device groups (e.g. RAS[0]) are further sub decoded to 1 Mbyte resolution. Table 9 shows the CPU/Local Master decode and device sub-decode associations, Table 10 shows the same process for PCI.

TABLE 9. CPU/Local Master and Device Decoder Mappings

CPU/Local Master Decoder	Associated Device Sub-Decoders
RAS[1:0]	Ras0* Ras1*
RAS[3:2]	Ras2* Ras3*
CS[2:0]	CS0* CS1* CS2*
BootCS*/CS3*	BootCS* CS3*
PCI I/O	None, accesses decoded for PCI I/O are bridged to PCI I/O transfers.
PCI Memory 0/1	None, accesses decoded for PCI Memory 0/1 are bridged to PCI Memory transfers.
Internal	None, decodes to GT-64111 internal registers.

TABLE 10. PCI Base Address Register and Device Decoder Mappings

PCI Base Address Register (BAR) Decoder ¹	Associated Device Sub-Decoders
RAS[1:0] - BAR 0 at 0x10	Ras0* Ras1*
RAS[3:2] - BAR 1 at 0x14	Ras2* Ras3*
CS[2:0] - BAR 2 at 0x18	Cs0* Cs1* Cs2*
BootCS*/Cs3* - BAR 3 at 0x1C	BootCS* Cs3*
Internal Registers (Memory) - BAR 4 at 0x20	None, decodes PCI memory accesses to GT-64111 internal registers.
Internal Registers (I/O) - BAR 5 at 0x24	None, decodes PCI I/O accesses to GT-64111 internal registers.
Expansion ROM - BAR at 0x30	None, decodes directly to CS3* ²

1. This mapping also applies to the swap BARs located in PCI function 1, if enabled.
2. This feature is available only in the GT-64011-P-1 stepping

4.1.1 CPU/Local Master Side Decoding Process

Decoding on the CPU/Local Master side starts with the SysAD address being compared with the values in the various CPU/Local Master Low and High decoder registers. For example, the RAS[1:0] CPU/Local Master High and Low decoder registers set the address range in which the Ras0* and Ras1* signals are active (i.e. where DRAM banks 0 and 1 are located.) The comparison works as follows:

- Bits 31:28 of the SysAD address are compared against bits 10:7 in the various CPU/Local Master Low decode registers. These values must match exactly. This effectively sets a 256 Mbyte “page” for the resource group.
- Bits 27:21 of the SysAD address are then compared against bits 6:0 in the various CPU/Local Master Low decode registers. The value of the SysAD bits must be greater than or equal to the Low decode value. This sets the lower boundary for the region.
- Bits 27:21 of the SysAD address are then compared against the High decode registers. The value of the SysAD bits must be less than or equal to this value. This sets the upper bound for the region.
- If all of the above are true, then the resource group is selected and a subdecode is performed to determine the specific resource.

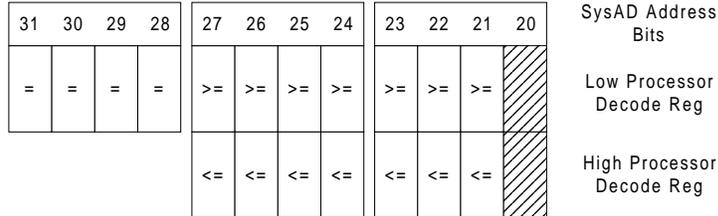
Once a CPU/Local Master resource group has been decoded, it must be subdecoded to determine which physical device should be accessed within that group. This decoding is controlled by the device Low and High decode registers. The comparison works as follows:

- Bits 27:20 of the SysAD address are then compared against the relevant device Low decode registers. The value of the SysAD bits must be greater than or equal to the Low decode value. This sets the lower boundary for the sub-decode region.
- Bits 27:20 of the SysAD address are then compared against the relevant device High decode registers. The value of the SysAD bits must be less than or equal to this value. This sets the upper bound for the sub-decode region.
- If all of the above are true, then the specific device is selected and an access to that device is performed.

Examples of the CPU/Local Master-side decode process are shown in Figure 6 and Figure 7.

Figure 6: CPU/Local Master-Side Resource Group Decode Function and Example

If the SysAD address is between the Low and the High decode addresses, then the access is passed to the Device Unit for sub-decode.



Example: Set up a SysAD decode region that starts at 0x4000.0000 and is 64Mbytes in length (0x4000.0000 to 0x43FF.FFFF):

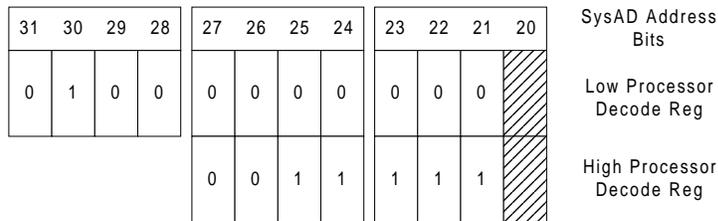
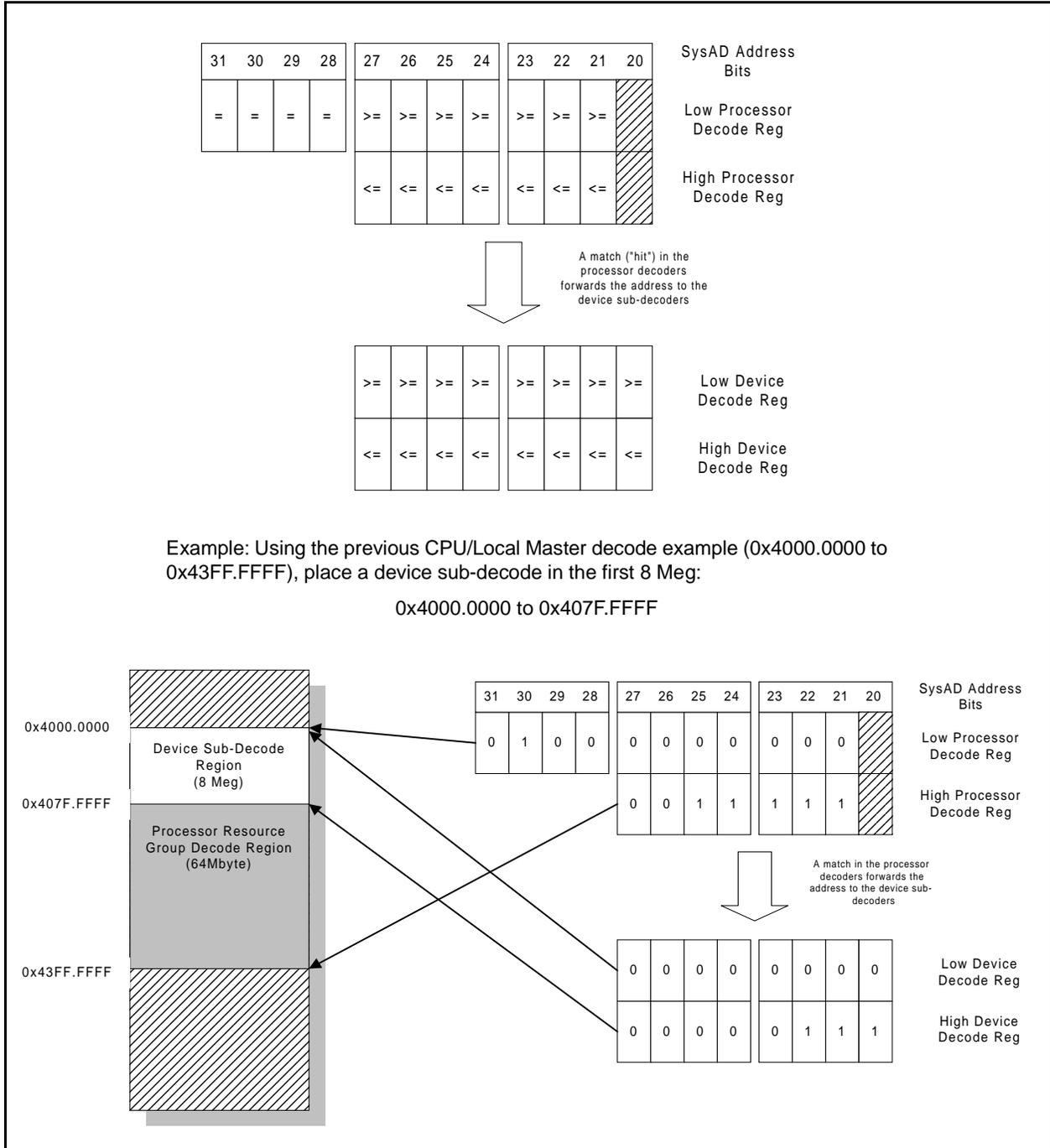


Figure 7: Device Sub-Decode Function and Example

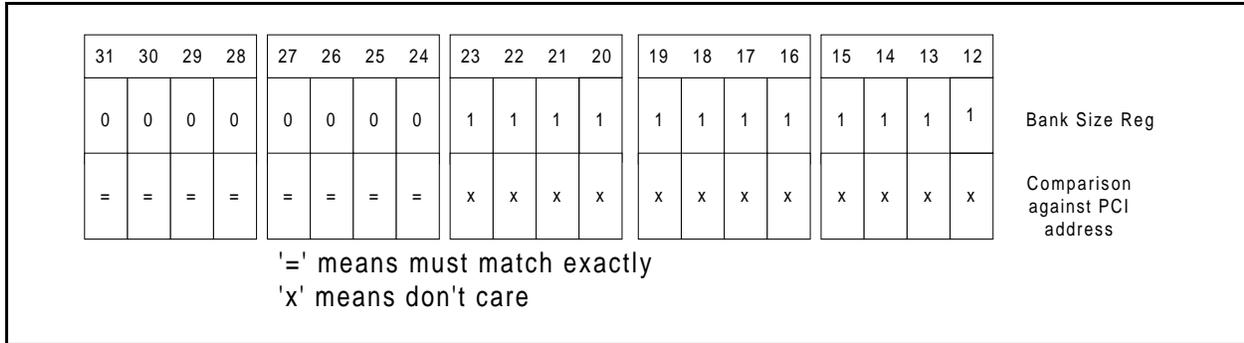


4.2 PCI Side Decoding Process

Decoding on the PCI side starts with the PCI address being compared with the values in the various Base Address Registers. For example, the RAS[1:0] Base Address Register sets the PCI base address range in which the Ras0* and Ras1* signals are active (i.e. where DRAM banks 0 and 1 are located in PCI space.)

The size of the “window” in PCI space for each Base Address Register is set by the Bank Size registers for each Base Address Register. The bank size sets which address bits are significant for the comparison between the active PCI address and the values in the Base Address Registers (see Figure 8).

Figure 8: Bank Size Register Function Example (16Meg Decode)



The comparison works as follows:

- Bits 31:N of the PCI address are compared against bits 31:N in the various Base Address Registers (BAR). These values must match exactly. The value of 'N' is set by the least significant bit with a '0' in the Bank Size Registers (for example, 'N' would be equal to 24 in the example shown in Figure 8, above.)
- If all of the above is true, then the resource group is selected and a subdecode is performed to determine the specific resource.

Once a resource group has been decoded by a BAR, it must be subdecoded to determine which physical device should be accessed within that group. This decoding is controlled by the Device Low and High decode registers. *Note that these registers are the same ones used for CPU/Local Master-side decoding. This means that the PCI and SysAD memory maps are coupled at the device decoders. Address bits 27:20 (the bits compared by the Device decoders) for any given device overlap in both the PCI and SysAD maps.*

The sub-decoding comparison works as follows:

- Bits 27:20 of the PCI address are then compared against bits the relevant device Low decode registers. The value of the PCI address bits must be greater than or equal to the Low decode value. This sets the lower boundary for the sub-decode region.
- Bits 27:20 of the PCI address are then compared against the relevant device High decode registers. The value of the PCI address bits must be less than or equal to this value. This sets the upper bound for the sub-decode region.
- If all of the above are true, then the specific device is selected and an access to that device is performed.

Note that the coupling of the SysAD, PCI, and device memory maps requires special attention for designers of PC Plug and Play adapters. Please see Galileo’s apnote for this application on our website.

4.3 Disabling the Device Decoders

Any Device sub-decoder can be disabled by setting the value of the “Low” decoder to be higher than the “High” decoder.

4.4 DMA Unit Address Decoding

The DMA controller uses the address mapping of the CPU/Local Master interface when accessing the device/DRAM bus. The DMA Unit can access the PCI bus independent of the CPU/Local Master-side PCI bridge decoders on the GT-64011 and GT-64060 devices only (see DMA section.)

4.5 Address Space Decoding Errors

When the CPU/Local Master tries to access an address from the SysAD that is not supported, the GT-64111 will latch the address into the Bus Error register, and will issue a bus error (over SysCmd[5]) if the access was a read access, and an interrupt if it was a read or write access. This feature is especially useful during software debug, when errant code can cause fetches from unsupported addresses.

When a PCI access hits in a Base Address Register then *misses* in the associated subdecoders, the result will be random data returned on a read; write data is discarded. The MemOut bit in the interrupt Cause register is also set. Accesses that miss all of the GT-64111 BARs result in no response at all from the GT-64111, as you would expect.

NOTE: Address space decoders must never be programmed to overlap; unpredictable behavior will result.

4.6 Default Memory Map

The default CPU/Local Master memory map that is valid following RESET is shown in Table 11 below. The default PCI map and BAR sizing information is shown in Table 12 and Table 13.

TABLE 11. CPU/Local Master and Device Decoder Default Address Mapping

CPU/Local Master Decode Range and Size	Resource Group	Device Decode Range and Size	Device Selected
0x0 to 0x00FF.FFFF 16 Megabytes	RAS[1:0]	0x0 to 0x007F.FFFF 8 Megabytes	Ras0*
		0x0080.0000 to 0x00FF.FFFF 8 Megabytes	Ras1*
0x0100.0000 to 0x01FF.FFFF 16 Megabytes	RAS[3:2]	0x0100.0000 to 0x017F.FFFF 8 Megabytes	Ras2*
		0x0180.0000 to 0x01FF.FFFF 8 Megabytes	Ras3*
0x1000.0000 to 0x11FF.FFFF 32 Megabytes	PCI I/O	No subdecode, access bridged directly to PCI I/O space	PCI
0x1200.0000 to 0x13FF.FFFF 32 Megabytes	PCI Mem0	No subdecode, access bridged directly to PCI memory space	PCI
0x1C00.0000 to 0x1E1F.FFFF ~32 Megabytes	CS[2:0]	0x1C00.0000 to 0x1C7F.FFFF 8 Megabytes	CS0*
		0x1C80.0000 to 0x1CFF.FFFF 8 Megabytes	CS1*
		0x1D00.0000 to 0x1DFF.FFFF 16 Megabytes	CS2*
0x1F00.0000 to 0x1FFF.FFFF 16 Megabytes	CS[3] and BootCS*	0x1F00.0000 to 0x1FBF.FFFF 12 Megabyte	CS3*
		0x1FC0.0000 to 0x1FFF.FFFF 4 Megabytes	BootCS*
0xF200.0000 to 0xF3FF.FFFF 32 Megabytes	PCI Mem1	No subdecode, access bridged directly to PCI memory space	PCI

TABLE 12. PCI Function 0 and Device Decoder Default Address Mapping

PCI Function 0 Decode Range and Size	Resource Group	Device Decode Range and Size	Device Selected
0x0 to 0x00FF.FFFF 16 Megabytes in Memory Space	RAS[1:0]	0x0 to 0x007F.FFFF 8 Megabytes	Ras0*
		0x0080.0000 to 0x00FF.FFFF 8 Megabytes	Ras1*
0x0100.0000 to 0x01FF.FFFF 16 Megabytes in Memory Space	RAS[3:2]	0x0100.0000 to 0x017F.FFFF 8 Megabytes	Ras2*
		0x0180.0000 to 0x01FF.FFFF 8 Megabytes	Ras3*
0x1400.0000 to 0x1400.0FFF 4 Kbytes in Memory Space	Internal Registers	No subdecode	Internal Registers
0x1400.0000 to 0x1400.0FFF 4 Kbytes in I/O Space	Internal Registers	No subdecode	Internal Registers
0x1C00.0000 to 0x1DFF.FFFF 32 Megabytes in Memory Space	CS[2:0]	0x1C00.0000 to 0x1C7F.FFFF 8 Megabytes	CS0*
		0x1C80.0000 to 0x1CFF.FFFF 8 Megabytes	CS1*
		0x1D00.0000 to 0x1DFF.FFFF 16 Megabytes	CS2*
0x1F00.0000 to 0x1FFF.FFFF 16 Megabytes in Memory Space	CS[3] and BootCS*	0x1F00.0000 to 0x1FBF.FFFF 12 Megabyte	CS3*
		0x1FC0.0000 to 0x1FFF.FFFF 4 Megabytes	BootCS*
0x1F00.000 to 0x1FFF.FFFF 16 Megabytes (uses CS[3] and BootCS* size register)	PCI Expansion ROM	No subdecode. This decoder is used only during PC BIOS initialization.	CS3*

TABLE 13. PCI Function 1 (Byte Order Swap) and Device Decoder Default Address Mapping

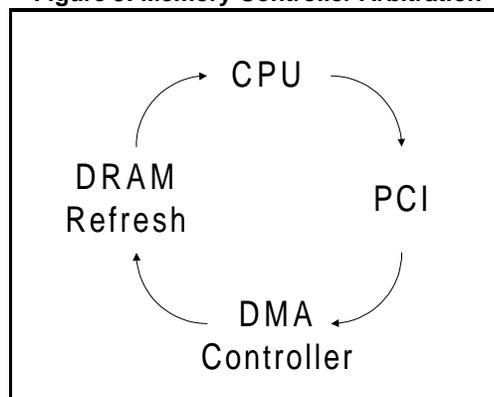
PCI Function 0 Decode Range and Size	Resource Group	Device Decode Range and Size	Device Selected
0x0 to 0x00FF.FFFF 16 Megabytes in Memory Space	RAS[1:0]	0x0 to 0x007F.FFFF 8 Megabytes	Ras0*
		0x0080.0000 to 0x00FF.FFFF 8 Megabytes	Ras1*
0x0100.0000 to 0x01FF.FFFF 16 Megabytes in Memory Space	RAS[3:2]	0x0100.0000 to 0x017F.FFFF 8 Megabytes	Ras2*
		0x0180.0000 to 0x01FF.FFFF 8 Megabytes	Ras3*
0x1F00.0000 to 0x1FFF.FFFF 16 Megabytes in Memory Space	CS[3] and BootCS*	0x1F00.0000 to 0x1FBF.FFFF 12 Megabyte	CS3*
		0x1FC0.0000 to 0x1FFF.FFFF 4 Megabytes	BootCS*

5. Memory Controller

The GT-64111's Memory Controller consists of a DRAM Controller and a device Controller. The DRAM Controller has an independent 12-bit address bus (DAdr[11:0]) and shares the 32-bit address/data (AD) bus for data transfers. The device controller uses the 32-bit AD bus for both address and data transfers. All memory and I/O devices in a GT-64111 system are connected to the AD bus (the SysAD bus is used primarily as a point-to-point connection between CPU and chipset.) The memory controller will only master read and write transactions to DRAM or devices, as instructed from the CPU, DMA controller, or a PCI master on the PCI bus. *A device on the AD bus may NOT master transactions to other devices, DRAM or the PCI via the GT-64111's memory controller.* The GT-64111's Memory Controller can support 32 or 64-bit (32-bit interleaved) DRAM as well as 8-, 16-, 32-, and 64-bit (32-bit interleaved) devices.

The GT-64111 implements a round robin arbitration scheme for requests of the memory controller as shown in Figure 9.

Figure 9: Memory Controller Arbitration



5.1 DRAM Controller

The DRAM controller supports up to four banks of page mode or EDO DRAM. The DRAM configuration register (0x448) contains configuration information which is valid for all banks. Various access parameters can be programmed on a per bank basis as each bank has its own parameters register (0x44c - 0x458). The supported address depth of the DRAM can vary for each bank separately from 256K (9-bit RAS*, 9-bit CAS*) to 16M (12-bit RAS*, 12-bit CAS*), and the width of each bank may be 32 bits or 64 bits (32-bit interleaved). With these options, each DRAM bank can vary in size from 1 Mbyte to 128 Mbytes. The maximum total DRAM address space is 512Mbytes for four banks.

5.1.1 DRAM Refresh

5.1.1.1 Refresh Rates

The GT-64111 implements standard CAS* before RAS* refreshing. Refresh rates for all banks can be programmed to occur at different frequencies according to the RefIntCnt, a 14-bit value DRAM configuration register. For example, the default value of RefIntCnt is 0x200. If TClk is 50 MHz, then a refresh sequence will occur every 10us. This is derived from $50\text{MHz} (=20\text{ns}) * 0x200 (512\text{d}) = 10.24\text{us}$. Every instance that the refresh counter in the GT-64111 reaches its terminal count, a refresh request is sent to the Memory Controller. This DRAM refresh request enters the arbiter, and the refresh cycle will begin once the Memory Controller has been arbitrated for this request.

5.1.1.2 Non-staggered and staggered Refresh

Non-staggered or staggered refresh for all banks can be programmed according to StagRef in the DRAM configuration register. In non-staggered refresh, RAS[3:0] will simultaneously assert following the low-going CAS* refreshing all banks at the same time as shown in Figure 10. If the DRAM Controller is programmed to performed staggered refresh

(default), RAS[3:0] will not simultaneously assert LOW following the low-going CAS*. Rather, RAS[0] will first go LOW, followed by RAS[1] on the next TClk, and so on. After the last RAS, RAS[3] has asserted LOW, CAS* will go HIGH again followed by RAS[0] on the next TClk, RAS[1] on the following TClk, and so on. Staggered Refresh is useful for load balancing, shown in Figure 11.

Figure 10: Non-Staggered Refresh Waveform

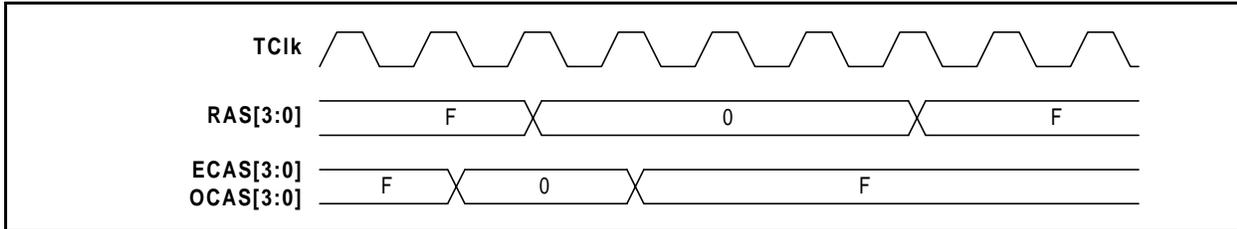
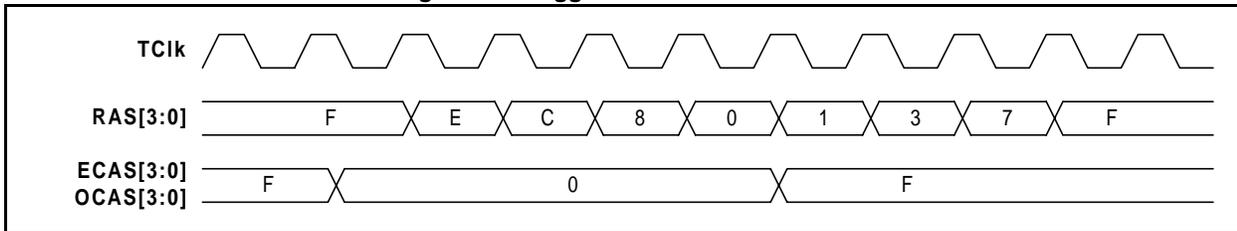


Figure 11: Staggered Refresh Waveform



5.1.2 Assymmetrically RAS*/CAS* Addressing

The GT-64111 supports assymetrical RAS*/CAS* addressing. In other words, a different number of addressing bits may be valid for row addressing as compared to column addressing. 9, 10, 11 or 12 bits can be used for DRAM row addressing and is specified on a per bank basis by programming bits 5:4 of the DRAM Bank[3:0] Parameter registers (0x44c-0x458). These bits determine the decoding of an address asserted on the SysAD bus from a device such as a CPU or from a PCI System on the PCI bus. Some bits of the address are used for RAS* while others are used for CAS*. The active SysAD or PAD pins which are translated to the DAdr pins are shown in Table 14 for 32-bit DRAM and in Table 15 for 64-bit DRAM (32-bit interleaved).

TABLE 14. Active DAdr[11:0] bits for RAS* and CAS*, 32-bit DRAM

DRAM Bank Para. 5:4	Row Addr. Depth	Active RAS* DAdr Bits ¹	SysAD/PAD Bits Used for RAS* on DAdr	SysAD/PAD Bits Used for CAS* on DAdr[11:0]
00	512	8:0	13:5	22..20, 16..14, 19..17, 4..2
01	1K	9:0	14:5	23..21, 16..15, 20..17, 4..2
10	2K	10:0	15:5	24..22, 16, 21..17, 4..2
11	4K	11:0	16:5	25..17, 4..2

1. Regardless of 5:4, DAdr[11:0] will always have the value of SysAD/PAD[16:5] during RAS*.

TABLE 15. Active DAdr[11:0] bits for RAS* and CAS*, 64-bit DRAM (32-bit interleaved)

DRAM Bank Para. 5:4	Row Addr. Depth	Active RAS* DAdr Bits ¹	SysAD/PAD Bits Used for RAS* on DAdr	SysAD/PAD Bits Used for CAS* on DAdr[11:0]
00	512	8:0	13:5	23..20, 16..14, 19..17, 4..3
01	1K	9:0	14:5	24..21, 16..15, 20..17, 4..3
10	2K	10:0	15:5	25..22, 16, 21..17, 4..3
11	4K	11:0	16:5	26..17, 4..3

1. Regardless of 5:4, DAdr[11:0] will always have the value of SysAD/PAD[16:5] during RAS*.

For example, when using 32-bit DRAM, if bits 5:4 are 01, for a particular bank, an address decoded to that bank from the SysAD/PAD bus will cause the DAdr bus to act as follows: During RAS* phase, DAdr[9:0] will have the values of SysAD/PAD[13:5]. During CAS* phase, DAdr[11:0] will have the values of {SysAD/PAD[23:21], SysAD/PAD[16:15], SysAD/PAD[20:17], SysAD/PAD[4:2]}.

5.1.3 DAdr[11]/ADS* Function

The default state of DAdr[11]/ADS* is to function only as DAdr[11]. Optionally, this pin is software configurable to only behave as ADS* via bit 17 of the DRAM Configuration register. When this pin functions as ADS*, it is an active LOW address strobe which indicates the beginning of a device transaction. This pin is sampled as an input at reset for configuration purposes.

5.1.4 Programmable DRAM Timing Parameters

The DRAM controller of the GT-64111 supports a wide range of DRAMs with different access times and each bank can be programmed independently by the DRAM Bank[3:0] Parameter registers (0x44c-0x458). These parameters include the number of clock cycles (based on TCik) that CAS* is asserted (LOW) in a write access (CASWr, bit 0) and in a read access (CASRd, bit 2). The number of clock cycles (based on TCik) between active RAS* and CAS* in a write access (RASStoCASWr, bit 1) and in read access (RASStoCASRd, bit 3) can also be programmed.

5.1.4.1 Asserted CAS*

The number of clocks that CAS* is asserted in LOW in write and read accesses can be programmed to be either one (Figure 12) or two clocks (Figure 13). 2 clocks is the default number that CAS* is LOW for both write and read accesses. Both the high and low-going edges of CAS* are driven from a rising TCik.

Figure 12: CAS* Asserted for 1 Clock

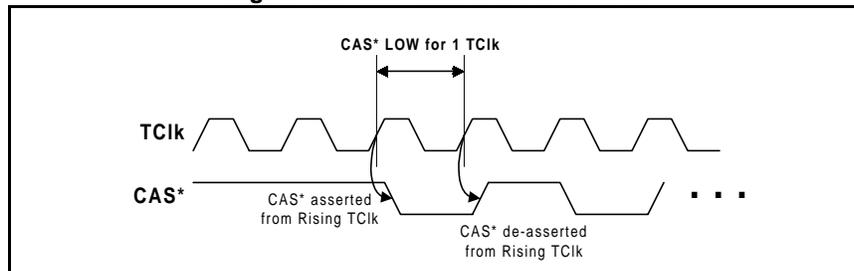
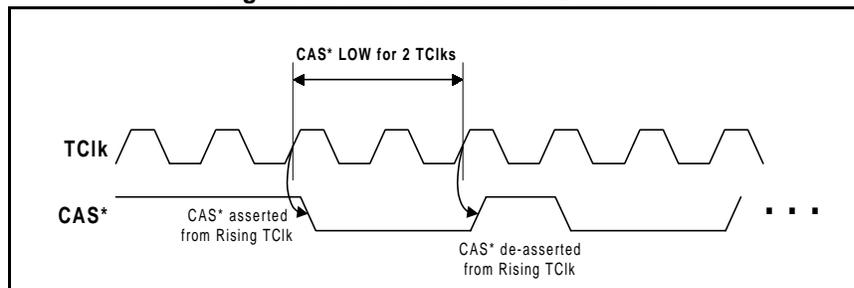


Figure 13: CAS* Asserted for 2 Clocks



Selecting the CASWr and CASRd parameter will depend on

- DRAM CAS* pulse width minimum requirement time
- TCik frequency

For example, standard 60ns EDO DRAM has a 10ns minimum pulse requirement for CAS*. If TCik is set to 50 MHz (20ns), both CASWr and CASRd can be programmed to one cycle for maximum performance. This will result in reading/writing one datum every two clocks (for 32-bit DRAM). On the other hand, slower Page Mode DRAMs will have

longer access times requiring the GT-64111 to assert CAS* for two clocks instead of one.

5.1.4.2 RAS* to CAS*

The number of clocks between active RAS* and CAS* in write and read accesses can be programmed to be either two (Figure 14) or three clocks (Figure 15). 3 clocks is the default delay between active RAS* and active CAS*.

Figure 14: Two Clock Delay between Active RAS* to Active CAS*

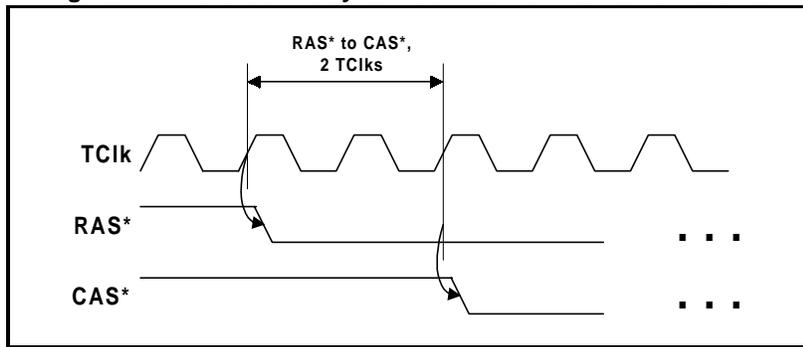
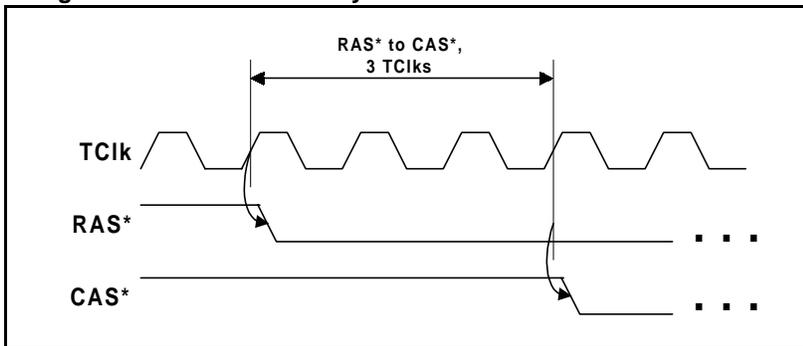


Figure 15: Three Clock Delay between Active RAS* to Active CAS*



Selecting the RAS_{toCASWr} and RAS_{toCASRd} parameter will depend on

- DRAM RAS* to CAS* maximum delay time
- TCik frequency

5.1.5 DRAM Bank Width and Location

Bit 6 of the DRAM Bank[3:0] Parameter registers (0x44c-0x458), BankWidth, specifies whether the data width of the particular bank of DRAM is 32-bit (default) or 64-bit (32-bit interleaved). If the bank is set for 32-bit operation, it can either reside on the even (default) or odd bank by setting bit 7, BankLoc. Selecting the even or the odd bank allows for load balancing.

If the BankWidth is programmed to '1' indicating the bank is set for 64-bit (32-bit interleaved), the setting of BankLoc is irrelevant as both banks will be populated.

5.1.6 DRAM Performance

DRAM performance is based on the width of DRAM implemented (32 or 64-bit) as well as the setting of the DRAM parameters. Table 16 lists the performance when the CPU reads a cache line (8 32-bit words) from DRAM. The performance is measured from ValidOut* asserted by the processor with the Rd8Words command to the GT-64111 asserting ValidIn* responding with the first datum. For example, 8-1-1-1-1-1-1-1 performances indicates 8 TCik from ValidOut* asserted to ValidIn* asserted for the first datum and 1 TCik for every following datum (0 wait states). 10-3-3-3-3-3-3-3 indicates 10 TCik from ValidOut* asserted to ValidIn* asserted for the first datum and 3 TCik for every following

datum (2 wait states).

TABLE 16. DRAM Performance

DRAM Width	RAS _{to} CasRd = 0 CASRd = 0 ¹	RAS _{to} CasRd = 0 CASRd = 1	RAS _{to} CasRd = 1 CASRd = 0	RAS _{to} CasRd = 1 CASRd = 1
32-bit	8-2-2-2-2-2-2-2	9-3-3-3-3-3-3-3	9-2-2-2-2-2-2-2	10-3-3-3-3-3-3-3
64-bit (32-bit interleaved)	8-1-1-1-1-1-1-1	9-1-2-1-2-1-2-1	9-1-1-1-1-1-1-1	10-1-2-1-2-1-2-1

1. 8-2-2-2-2-2-2-2 with 32-bit DRAMs and 8-1-1-1-1-1-1-1 clocks with 64-bit (32-bit interleaved) DRAMs is the performance for Ras_{to}CasRd = 0 and CasRd = 0. In "wait-state" nomenclature this equates to 5-1-1-1-1-1-1-1 and 5-0-0-0-0-0-0-0.)

5.2 Device Controller

The device controller supports up to five banks of devices. Various access parameters can be programmed on a per bank basis as each bank has its own parameters register (0x45c - 0x46c). The supported memory space of each device bank can vary for each bank separately up to 32 Mbytes, and the width of each bank may be 8, 16, 32 or 64 bits. The maximum total device address space is 160Mbytes for five banks. The 5 individual chip selects are typically broken up into 4 individual device banks plus one chip select for a boot device (non-volatile memory).

BootCS* has the exact same functionality as CS[3:0] and devices which need to be read from and written to can be attached to this chip select. The only difference between BootCS* and CS[3:0] is that by default, BootCS* is mapped to the physical boot address of 0x1FC0.0000 (which can be reprogrammed) and its device width can be programmed by input pins on reset.

Each device bank can have unique programmable timing parameters to accommodate different device types (e.g. Flash, SRAM, ROM, I/O Controllers). The devices share the local AD bus with the DRAM, but unlike DRAM, the devices use the AD bus as a multiplexed address and data bus.

In the address phase, the device controller puts on the AD bus an address with a corresponding Chip Select asserted. ALE (and ADS* if programmed, Section 5.1.3) indicates the AD bus is outputting an address and CS*, DevRW* and DMAAck*. ALE is used to latch the address, CS*, DevRW* and DMAAck* in an external 373. CS* should then be qualified (OR-tied) with CSTiming*. A read or write cycle is indicated by the latched DevRW*. The CSTiming* signal will be valid for the programmable number of cycles of the specific CS* that is active. TurnOff, AccToFirst and AccToNext can be set in registers 0x45c - 0x46c for each bank's read timing parameters (see Figure 16 for waveform example without latches enabled, see Figure 17 for waveform example with latches enabled). ADStoWr, WrActive and WrHigh can be set for each bank's write timing parameters (see Figure 18 for waveform example). Please see Section 5.6 before configuring these bits. AcctoFirst, AccToNext and WrActive can be extended by the Ready* pin (see Section 5.2.10).

5.2.1 TurnOff, bits [2:0]

TurnOff is the number of TClk cycles that the GT-64111 will not drive the memory bus after a read from a device. This prevents contentions on the memory bus after a read cycle for a slow device. This parameter is measured from the the number of cycles between the deassertion of DevOE* (an externally extracted signal which is the logical OR between CSTiming* and inverted DevRW*) to an new AD bus cycle.

5.2.2 AccToFirst, bits [6:3]

AccToFirst defines the number of cycles in a read access from the assertion of CS* to the cycle that the data will be latched (by external latches). This parameter can also be thought as the delay between the rising edge of TClk which drives ALE HIGH to the the rising edge of TClk where the first data will be latched by the external latches. If there are no latches in the system, AccToFirst defines the number of cycles between TClk which drives ALE HIGH to the rising edge of TClk where the first data is latched into the GT-64111. This parameter can be extended by the Ready* pin.

5.2.3 AccToNext, bits [10:7]

AccToNext defined as the number of cycles in a read access from the cycle that the first data was latched to the cycle

to the next data will be latched (in burst accesses). This parameter can also be thought of as the delay between the rising edge of TClk which data is latched to the rising edge of TClk where the next data is latched in a burst cycle. This parameter can be extended by the Ready* pin.

5.2.4 ADStoWr, bits[13:11]

There are eight byte write signals, four for even bank devices (EWr[3:0]*) and four for odd bank devices (OWr[3:0]*). ADStoWr can also be thought as the delay between the rising edge of TClk which drives ADS* LOW (ALE HIGH) from to the assertion of EWr* or OWr*, or for the first write pulse.

5.2.5 WrActive, bits[16:14]

WrActive is the number of TCIs that EWr* and OWr* are active (asserted). This parameter is measured from the first rising edge of TClk where EWr* or OWr* is asserted LOW to the last rising edge of TClk where EWr* or OWr* is LOW for that particular write pulse. This parameter can be extended by the Ready* pin.

5.2.6 WrHigh, bits[19:17]

WrHigh is the number of TCIs that EWr* and OWr* are inactive between burst writes. This parameter is measured from the first rising edge of TClk where EWr* or OWr* is de-asserted HIGH to the last rising edge of TClk where EWr* or OWr* is HIGH. On the next rising edge of TClk, EWr* and OWr* will be asserted LOW for the next write pulse. These signals are driven off of the falling edge of TClk.

Figure 16: Waveform Showing Device Read Parameters, LatchFunc = 0

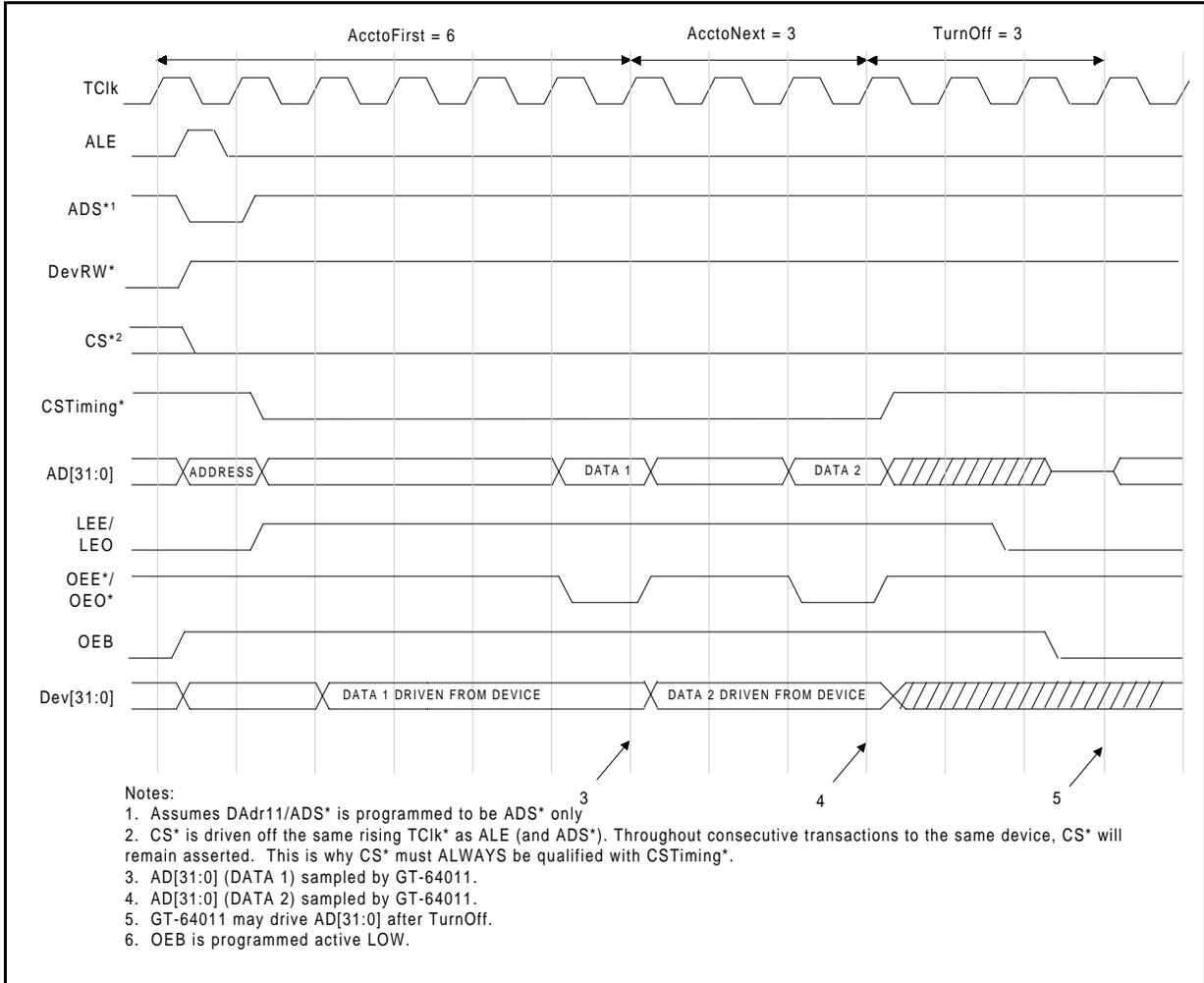


Figure 17: Waveform Showing Device Read Parameters, LatchFunc = 1

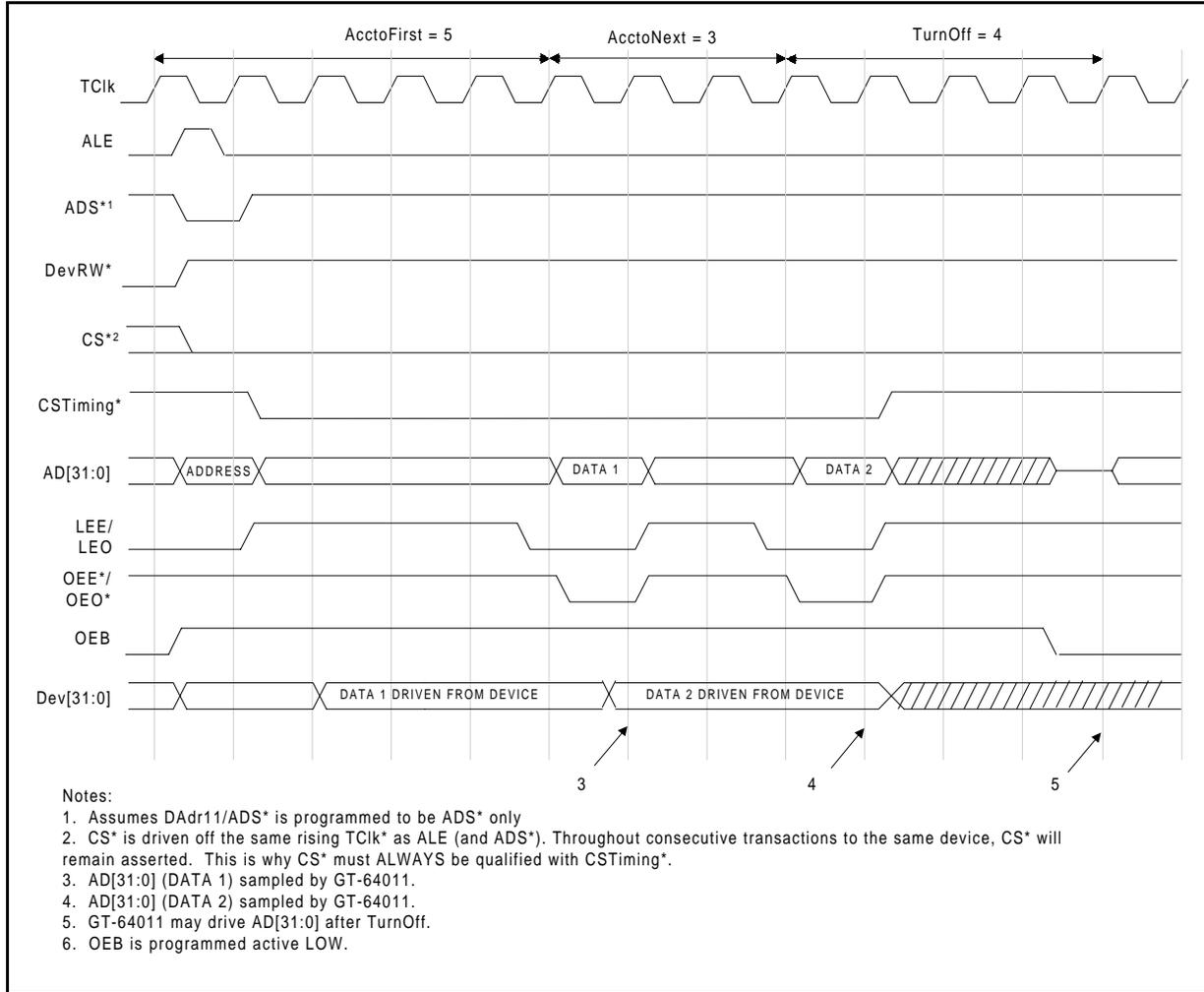
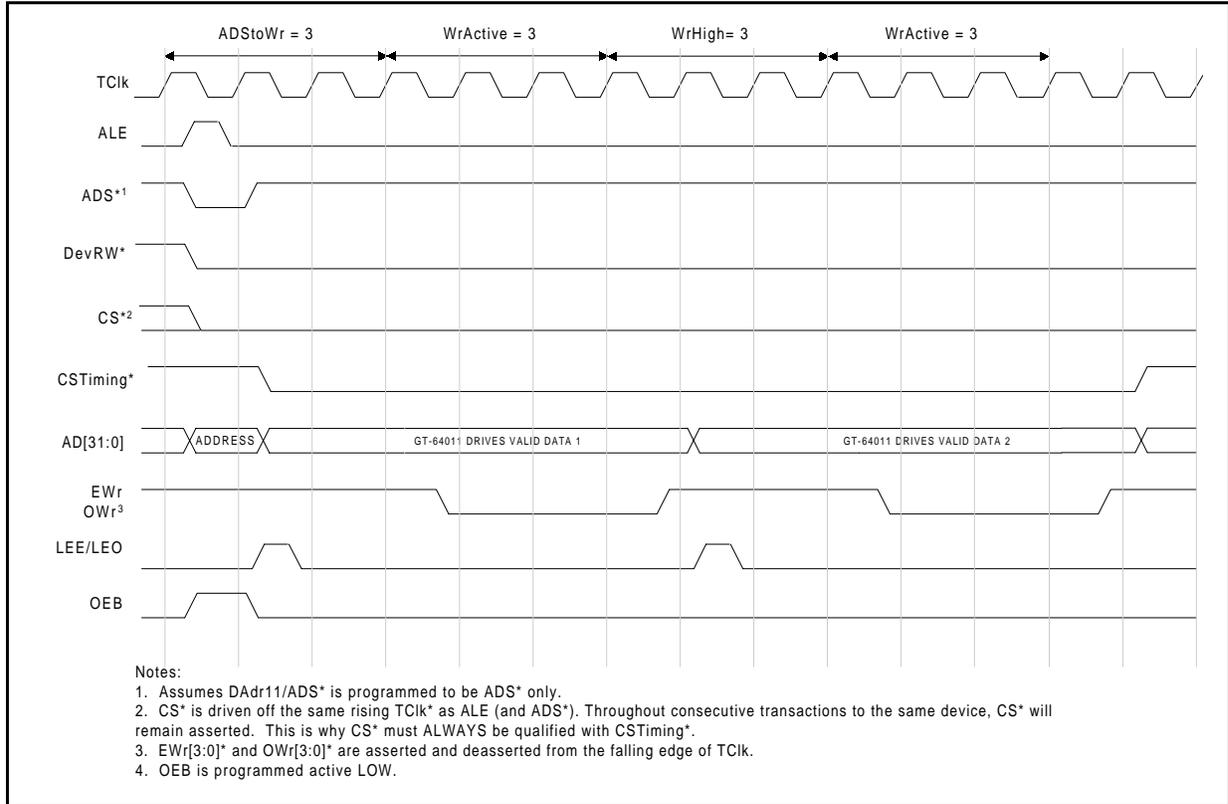


Figure 18: Waveform Showing Device Write Parameters



5.2.7 Burst Transactions

The device controller supports a maximum of 8 32-bit word burst accesses. The burst address is supported by a three bit wide address bus (BAdr[2:0]) that is different from the latched address on the multiplexed AD bus. Note that BAdr[2:0] are the same pins as the least significant DRAM address lines, DAdr[2:0]. See pin assignment table for more detail.

5.2.8 Packing and Unpacking Data and Burst Support

The GT-64111 supports the packing of data into a 32-bit word, in reads from devices that are 8 or 16-bits wide. Devices that are 8-bits or 16-bits wide only are supported by partial reads (up to 64-bits). The controller supports CPU writes of 1 to 8 bytes to 8-bit or 16-bit wide devices. Therefore, 8 and 16-bit devices MUST NOT be mapped to cacheable regions. The reason is that the R4640 has an 8-word (32 bytes) cache line size. This would equate to a burst of 32 8-bit accesses or 16 16-bit accesses.

The GT-64111 supports cached accesses to 32 and 64-bit device spaces. It supports DMA/PCI writes of 1 to 4 bytes to 8-bit or 16-bit wide devices.

5.2.9 “Destructive” Reads

When the CPU performs a device read from an 8-bit device, there are certain conditions where the device controller will fetch additional data even though it is never read by the CPU. Designers using devices such as FIFOs must be aware of these “destructive” reads. *Destructive reads will not occur on read accesses from 16, 32 or 64-bit devices.*

When a PCI master reads data from 8 or 16-bit devices, or when data is read from 8 or 16-bit devices via the DMA con-

trollers, only single word reads are allowed.

5.2.9.1 8-Bit Devices

If a device bank is set to support 8-bit devices, and the CPU executes a 2 or 3 byte read, the device controller will fetch extra data. If the CPU executes a 1 or 4 byte read, the device controller will not fetch extra data. See Table 17 for a summary.

TABLE 17. Destructive Reads, 8-bit Device

# Byte Read from CPU	Destructive Read?	# of Additional Bytes Read
1	No	0
2	Yes	2
3	Yes	1
4	No	0

5.2.10 Ready* Support

The Ready* pin is sampled on three occasions: one clock before the data is sampled to the GT-64111 during both AccToFirst (see Figure 19) and AccToNext (see Figure 20) phases of read cycles and on the last rising edge of the WrActive (see below) phase during a write cycle. During all other phases Ready* is not sampled by the GT-64111.

If Ready* is not asserted during these clocks, the WrActive, AccToFirst or AccToNext phases are extended until Ready* is asserted again. The transaction may be indefinitely held off until Ready* is asserted.

Figure 19: Ready* Extending AccToFirst on Read Cycle, Latches Disabled

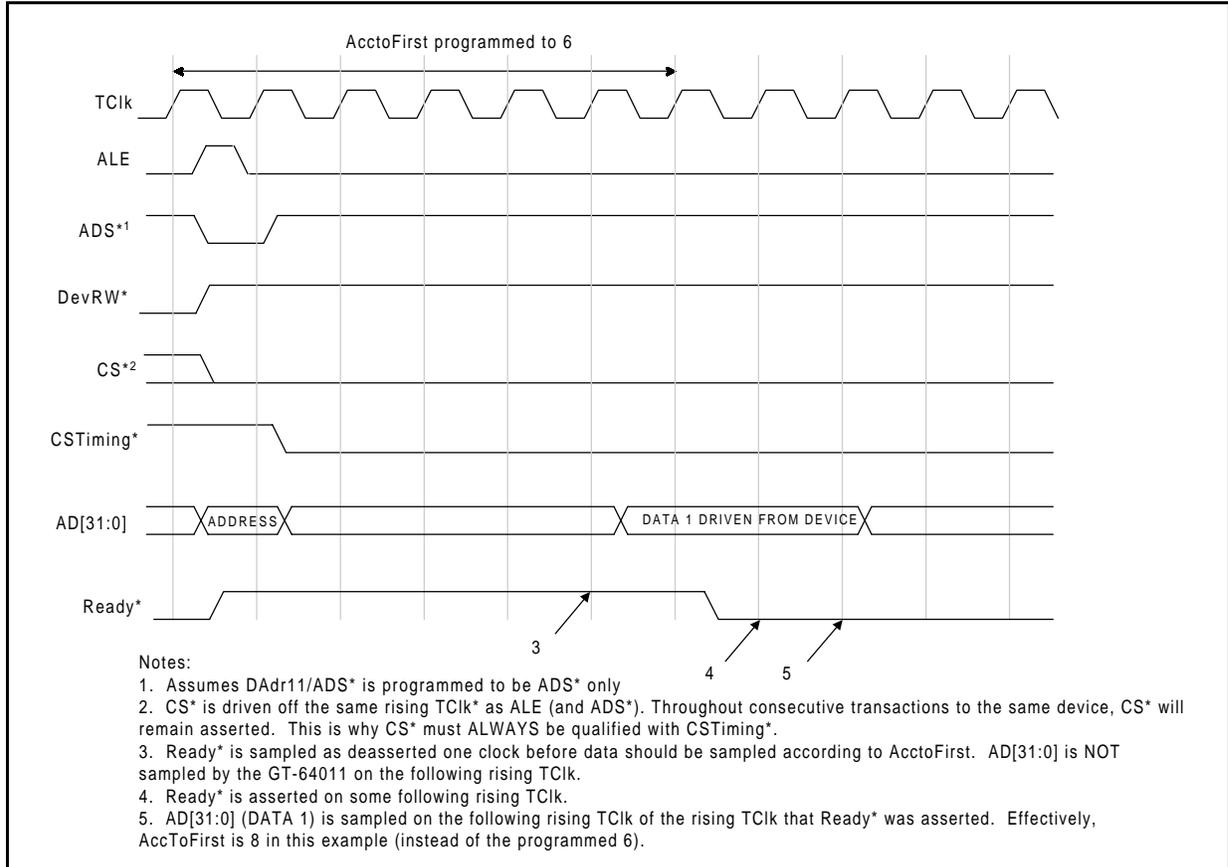


Figure 20: Ready* Extending AccToNext on Read Cycle, Latches Disabled

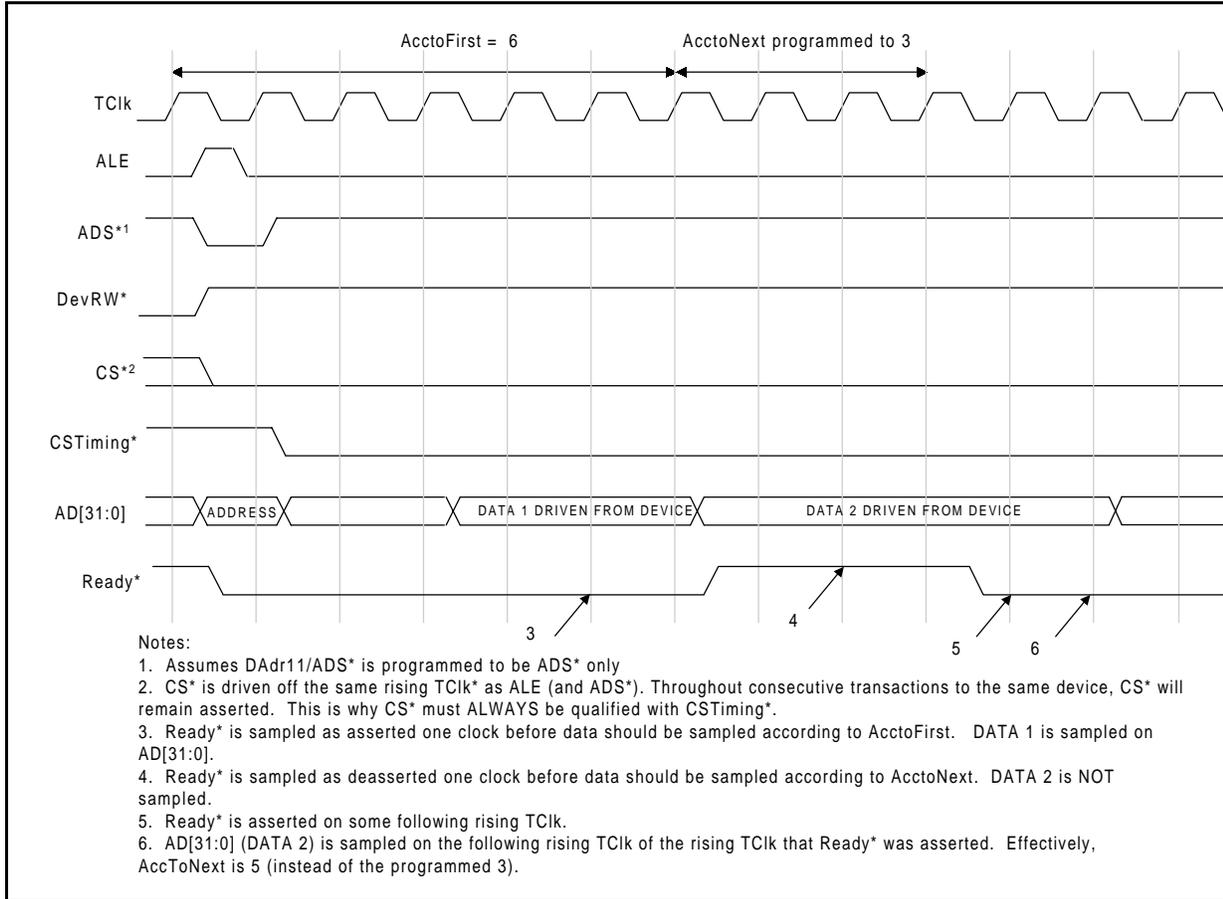
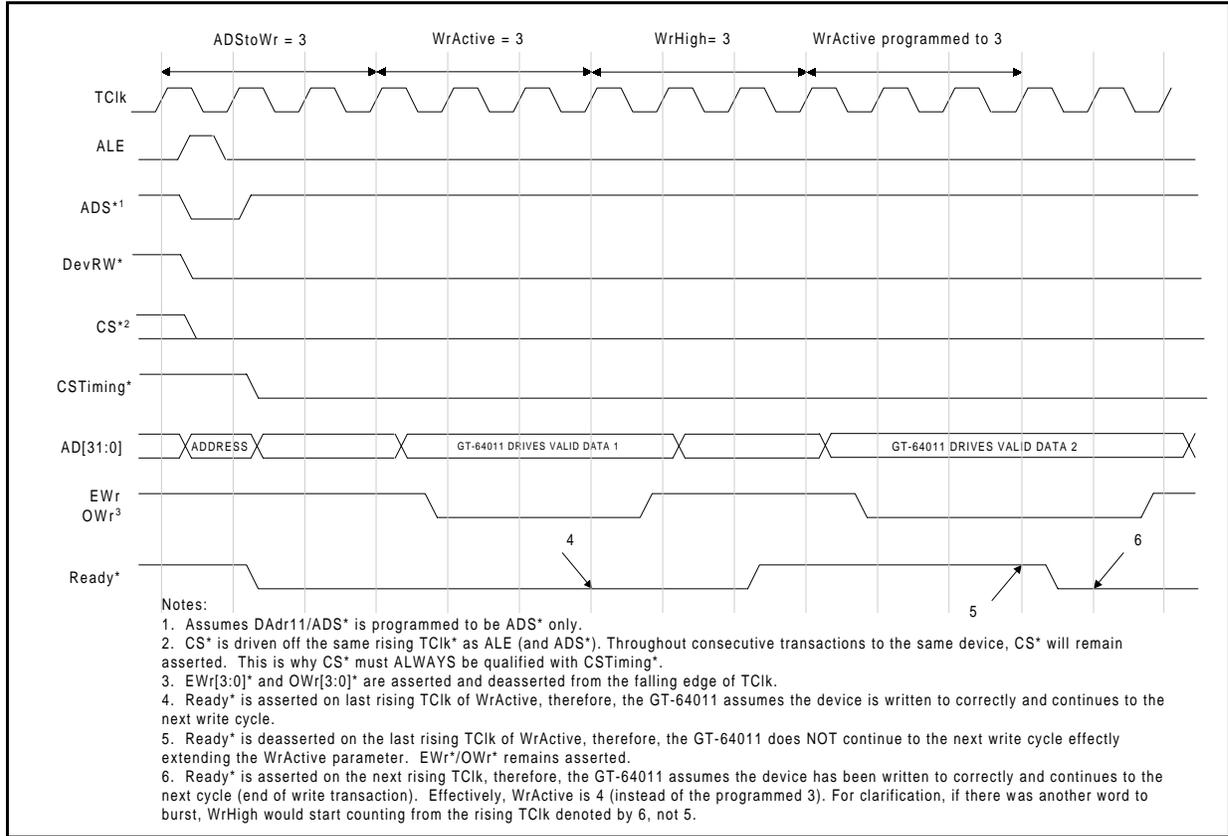


Figure 21: Extending WrActive Parameter on Write Cycle



5.2.11 Device Bank Width and Location

Bit 21:20 of the Device Bank[3:0] Parameter registers (0x45c-0x46c), DevWidth, specifies whether the data width of the particular device bank is 8, 16, 32 (default except for BootCS*), or 64-bit (32-bit interleaved). If the bank is set for 8, 16 or 32-bit, it can be placed on the even or odd bank depending on the setting of DevLoc. If the DevWidth is programmed to '11' indicating the bank is set for 64-bit (32-bit interleaved), the setting of DevLoc is irrelevant as both banks will be populated. Selecting the even or the odd bank allows for load balancing.

5.2.12 SysAD to AD Addressing

When an address is presented on the SysAD bus which decodes to a peripheral on the device controller, the address will be conveyed on the AD bus according to Table 18.

TABLE 18. SysAD to AD Addressing

Device Width	SysAD[24]..					
	SysAD[5]	SysAD[4]	SysAD[3]	SysAD[2]	SysAD[1]	SysAD[0]
8-bit	AD23..AD4	AD3	AD2	BAdr[2]	BAdr[1]	BAdr[0]
16-bit	AD23..AD4	AD3	AD2	BAdr[2]	BAdr[1]	N/A
32-bit ¹	AD23..AD4	BAdr[2]	BAdr[1]	BAdr[0]	N/A	N/A
64-bit	AD23..AD4	BAdr[2]	BAdr[1]	N/A	N/A	N/A

1. AD3 and AD2 are not used when addressing 32 or 64-bit devices.

5.3 Data Latches

Since both the DRAM and device controller share the AD bus for data transactions, typical system have multiple devices attached to the AD bus. The GT-64111's AD bus provides +16mA of drive and is tested to meet all timing requirements with a maximum load of 50pF. As typical DRAM configurations require multiple chips and often SIMMs which greatly load the bus, in addition to other devices, the capacitive load can easily exceed 50pF. Excessive capacitive loading will make the rise and fall times of the signals driven by the AD bus become much longer and may cause timing violations.

The solution to a heavily loaded AD bus is to add latches which act as strong drivers for greater fanout. Using external latches also improves timing since data does not need to be sampled precisely on a certain clock edge. Instead, the latched data is valid on the bus longer and the window for clocking in the data is wider. This is extremely important with Fast Page Mode DRAM since data becomes invalid as soon as CAS* is de-asserted. Without latching the data, the CAS* assertion time must be extended to meet the GT-64111's setup and hold requirements. A longer CAS* assertion time will degrade the overall system performance.

NOTE: Latches are REQUIRED for 64-bit DRAM or devices.

The GT-64111 outputs all of the control signals for a standard 501 bi-directional latch. There is a separate set of latch control signals for both the even and odd banks as shown in Table 19.

TABLE 19. Memory Controller Latch Controls for DRAM and Devices

Signal	Description	Active Cycles ¹	Asserted from TClk	De-asserted from Tclk
LEE, LEO	Latch Enable	DRAM Reads (if configured)	Rising	Rising
LEE, LEO	Latch Enable	Device Reads (if configured)	Rising	Falling
LEE, LEO	Latch Enable	DRAM and Device Writes	Rising	Falling
OEE*, OEO*	Output Enable	DRAM and Device Reads (if configured)	Rising	Rising
OEB	Output Enable	DRAM and Device Writes	Rising	Rising

1. The latch enable signals will be active on read cycles only if they are set in the DRAM Bank Parameters Registers or the Device Bank Parameters Registers. See Section 5.3.1.

NOTE: The latch signals are ALWAYS active during DRAM and device writes.

5.3.1 Enabling Latch Control Signals on Read Transactions

Enabling the latch signals on DRAM read cycles is set by bit 18, DRAMLatch, of the DRAM Configuration Register (0x448). This controls the read latch signals for all DRAM banks. If DRAMLatch is set to 0, the latch control signals are active on read accesses. If DRAMLatch is set to 1, the external data latches are transparent in DRAM read accesses when CASRd* is programmed to be one cycle long. *If CASRd* is programmed to be 2 cycles, the latch enables will always be active regardless of DRAMLatch setting.*

Enabling the latch signals on device read cycles is set by bit 25, LatchFunc, of the Device Bank Parameters Registers (0x45c-0x46c). Each device bank can be individually configured to have latch control signals active during device reads. If LatchFunc is set to 0, the external data latches are transparent on all device read cycles for this particular device bank. If LatchFunc is set to 1, the latch control signals are active on read accesses.

5.4 Parity Checking Support

Each bank of DRAM and devices can be configured individually for parity checking. This allows the flexibility to designate certain banks for peripherals which support parity checking, and other banks for devices which do not. Bit 8 of the DRAM Bank Parameters Registers (0x44c to 0x458) controls whether the GT-64111 will sample ParErr* on DRAM reads. Bit 30 of the Device Parameters Registers (0x45c to 0x46c) controllers whether the GT-64111 will sample ParErr* on device reads. ParErr* is sampled on the same rising edge of TClk that data is sampled.

In the case of DRAM or device writes, parity should be generated by external logic (i.e. 511s). In the case of DRAM or device reads, parity errors should be detected by external logic. If parity error checking is enabled for a particular bank, and a parity error is detected by the external logic on a CPU read cycle, it will report this error to the GT-64111 via the ParErr* pin. On CPU read accesses from a 32-bit device or memory, the GT-64111 will not assert SysCmd[4] even if the bank that was accessed has the parity integrity bit set. If a parity error is detected in this case (indicated by ParErr*), the GT-64111 will return the data with SysCmd[5] asserted and will cause a parity error interrupt. In DMA read accesses, detection of a parity error from a bank with the parity integrity bit set, will cause an interrupt.

In the case of PCI read accesses, the GT-64111 will assert SErr* (if unmasked) if the bank that data was read from has the parity integrity bit set, and will assert a parity error interrupt. The GT-64111 will generate and check word (32 bits) parity on data that is read from the PCI with compliance to the PCI requirements for every transaction. A parity error detection on the PCI will cause the assertion of PErr*.

5.5 Addressing

When the CPU reads a block of data from the memory controller, the controller will read it from DRAM or devices in sub-block order and the GT-64111 will return the data to the CPU in sub block order. For more information about sub block ordering, please see your CPU manual.

When a PCI master or the DMA Controller accesses data from the memory controller, data is always addressed linearly.

5.6 Memory Interface Restrictions

1. If latches are not present, all banks must be programmed to be on the even bus. Programming the registers to 64-bit mode or to dynamically controlled latches will result in an error.
2. Unless the boot device is 64-bits wide, the boot must be on the even bank.
3. For 8 and 16-bit devices, all Device Parameters except Turnoff (Section 5.2.2 - Section 5.2.6) must be greater or equal to 3. i.e., AccToFirst, AccToNext, ADSToWr, WrActive and WrHigh.
4. For 32 and 64-bit devices, the fastest timing parameters (best performance) are as follows:
 - AccToFirst = 3
 - AccToNext = 1 (if latches are transparent) or 2 (if latches are active)
 - ADSToWr = 2
 - WrActive = 1
 - WrHigh = 1
5. When working with an 8- or 16-bit configured bank from CPU, a read/write operation can not exceed 64-bits (8 bytes).
6. When working with an 8- or 16-bit configured bank from DMA/PCI, a read/write operation can't exceed 32-bits (4 bytes).
7. When an erroneous address is issued or a burst operation is performed to an 8- or 16-bit device, the GT-64111 forces an interrupt (unless masked). If a sequence of address misses occurs, there will be no other interrupt prior to resetting the appropriate bit in the cause register and no new address will be registered in the Address Decode Error register (0x470) prior to reading it.
8. When the CPU reads from an address which is decoded in the CPU Interface Unit as being a hit for CS[2:0]* or CS[4:3]* and decoded as a miss in the DRAM/Device Interface Unit, the cycle will complete only if Ready* is asserted (i.e., driven LOW). Although being a result of improper and inconsistent programming of the address space defining registers, the following 2 workarounds exist:
 - Ready* should always be asserted (LOW) when CSTiming* is inactive (HIGH).
 - If the Ready* signal is not needed in the system, the DMAReq[0]/Ready* pin should either be programmed as

Ready* and constantly driven active (LOW) or be programmed as DMAReq[0]*.

6. PCI Bus

The GT-64111 includes a Revision 2.1 compliant PCI interface. As a PCI device, the GT-64111 can be either a master initiating a PCI bus operation or a target responding to a PCI bus operation. Operation up to 66MHz is supported, as is 3.3V and 5V signalling.

6.1 PCI Master Operation

When the CPU/Local Master or the internal DMA machine initiates a bus cycle to a PCI device, the GT-64111 becomes a PCI bus master and translates the cycle into the appropriate PCI bus cycle. Supported master PCI cycles are:

- Memory Read
- Memory Write
- Memory Read line
- Memory Write & Invalidate
- I/O Read
- I/O Write
- Configuration Read
- Configuration Write
- Interrupt Acknowledge
- Special Cycle

Memory Write & Invalidate and Memory Read Line cycles are carried out when the transaction accessing PCI memory space requests a data transfer equal to the PCI cache line size. When the PCI cache line size is set equal to 0, the GT-64111 will never issue Memory Write & Invalidate or Memory Read Line cycles.

As a master, the GT-64111 does not issue Dual Address cycles or Lock cycles on the PCI.

The PCI posted write buffer in the GT-64111 permits the CPU/Local Master to complete CPU-to-PCI memory writes even if the PCI bus is busy. The posted data is written to the PCI device when the PCI bus is available.

6.1.1 PCI Master CPU/Local Master Address Space Decode and Translation

CPU/Local Master access the PCI space through the PCI Memory 0, PCI Memory 1 and PCI I/O decoders in CPU/Local Master address space. CPU/Local Master accesses that are claimed by these decoders are translated into the appropriate PCI cycles. The address seen on the CPU/Local Master bus is copied directly to the PCI bus. For example, if an access to 0x1200.0040 is programmed to be bridged as a memory read from PCI, then the active PCI address for this cycle will be 0x1200.0040. Access to the full PCI space is possible by relocating the CPU/Local Master PCI decoders within CPU/Local Master space as needed. This relocation can be made transparent to user code by using the memory remapping capabilities of the CPU/Local Master (MMU or base/bounds function.)

6.1.2 PCI Master CPU/Local Master Byte Swapping

All accesses to PCI space through the CPU/Local Master can have the data byte order swapped as the data moves through the GT-64111. Byte swapping is turned on via the ByteSwap bit in the PCI Internal Command register (0xc00.)

NOTE: Regardless of the setting of ByteSwap, PCI accesses from a PCI Master to the GT-64111's internal registers or PCI Configuration registers will NOT be swapped.

6.1.3 PCI Master FIFOs

The PCI master interface includes a FIFO of 8 entries, each 32 bit. During writes to the PCI interface, it receives write data from the CPU/Local Master interface or the DMA unit. When the PCI bus is granted, the FIFO delivers the write data to the target on the PCI bus.

Upon receiving the first 32-bit word from the CPU/Local Master interface or DMA unit, the PCI master interface will request the PCI bus (if the GT-64111 is not already parked). Once granted, the appropriate write cycle is started on the PCI bus.

During reads, the PCI master interface FIFO receives read data from the PCI bus and delivers it to the CPU/Local Mas-

ter interface or the DMA unit. Upon receiving the first 32-bit word from the PCI target, the data is forwarded to the requesting unit (CPU/Local Master interface or DMA unit). The GT-64111 supports sub-block ordering during CPU/Local Master reads, therefore if the original read request address is not aligned to a cache line boundary, the first 32-bit word returned to the requesting unit will be delayed until it is received from the PCI target, since reads across the PCI bus are linear.

The GT-64111 internal architecture allows zero wait-state data transfer over the PCI bus (IrDY* continuously asserted) during both master reads and writes.

6.1.4 PCI Master DMA

The GT-64111's internal DMA engines can act as PCI bus masters while transferring data to/from the PCI bus. The DMA engines will only issue memory space read and write cycles. The type of cycle issued follows the same rules as for the CPU/Local Master. The DMA engines can transfer data between PCI devices using the on-chip DMA FIFOs for temporary storage.

6.1.5 PCI Master RETRY Counter

RETRY's detected by the PCI master interface are normally handled transparently from the point of view of the CPU/Local Master or DMA engines. In some rare circumstances, however, a target device may RETRY the GT-64111 excessively (or forever.) The Retry Counter can be used to recover from this condition. Every time the number of RETRYs equals the value in the Retry Counter, the GT-64111 will abort the cycle and send an interrupt to the CPU/Local Master. If the cycle was a read, undefined data is returned and the ERROR bit is set in the data command.

The Retry Counter can be disabled by setting the Retry count to zero.

6.1.6 Cache Line Size

The CacheLine in PCI configuration register at 0x00c specifies the cache line size. The setting of this register specifies the PCI master policy regarding Memory Read Line/Memory Write & Invalidate commands placed on the PCI bus, based on the following:

- If cache line size is equal to zero, the master will NOT issue Memory Read Line/Memory Write & Invalidate commands.
- For cache line sizes greater than zero but less than or equal seven the master will issue Memory Read Line/Memory Write & Invalidate commands when the transaction-length matches the cache line size.
- For cache line sizes greater than seven, the master will NOT issue Memory Read Line/Memory Write & Invalidate commands.

6.2 PCI Target Interface

The GT-64111 responds to the following PCI cycles as a target device:

- Memory Read
- Memory Write
- Memory Read Line
- Memory Read Multiple
- Memory Write and Invalidate
- I/O Read
- I/O Write
- Configuration Read
- Configuration Write

The GT-64111 will lock a cache line (32-bytes) in the local memory address space when responding to Lock sequences on the PCI bus. The GT-64111 will not act as a target for Interrupt Acknowledge, Special, and Dual Address cycles (these cycles will be ignored.)

6.2.1 PCI Target FIFOs

The GT-64111 incorporates dual 32-byte posted write/read prefetch buffers to allow full memory (AD) and PCI bus concurrency. The dual FIFOs operate in a “ping-pong” fashion, each FIFO alternating between filling and draining.

When the GT-64111 is the target of PCI write cycles, data is first written to one of the FIFOs. When the first FIFO fills up (32 bytes), the data is written to the destination from the first FIFO while the second FIFO is filled. This “ping-pong” operation continues as long as data is received from the PCI bus.

Occasionally the PCI target interface cannot drain the FIFOs (i.e. write to local memory) as fast as data is received. This will only happen when access to memory is prevented (possibly by excessive CPU/Local Master accesses) or when the target memory is particularly slow. In this case, the GT-64111’s PCI target interface will issue a DISCONNECT to the PCI bus.

Figure 22: PCI Target Interface “Ping-Pong” FIFOs

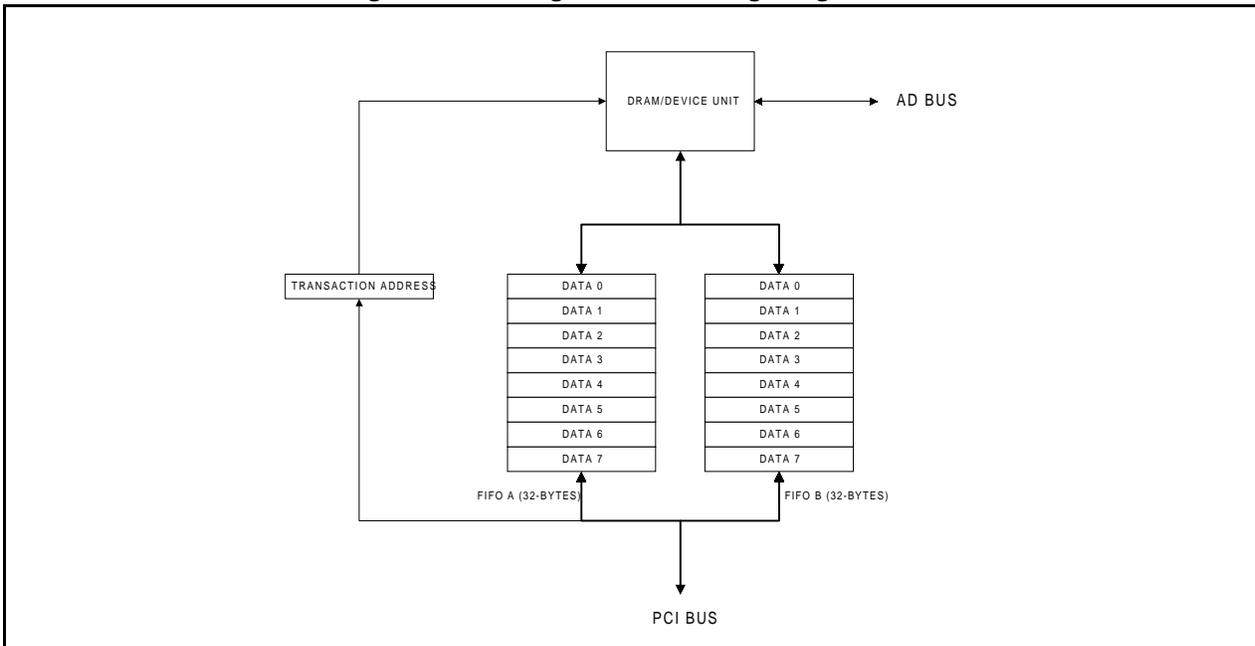
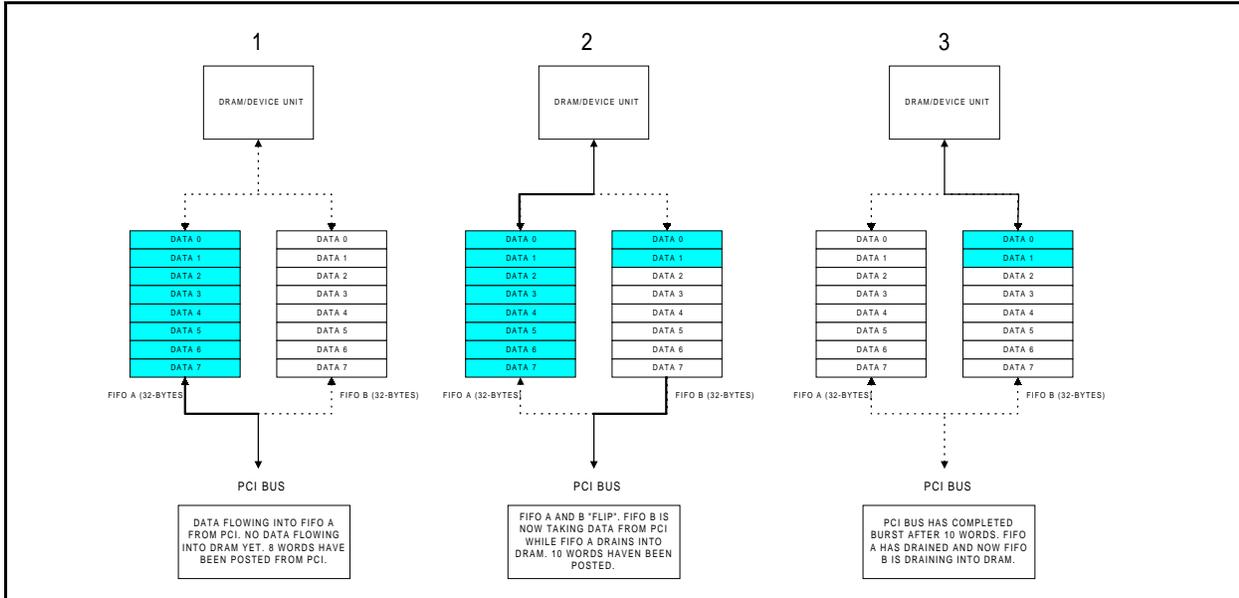


Figure 23: PCI Target Interface FIFOs Operational Example



The target FIFOs are also used for read prefetch. The Memory Read Multiple (MRM) cycle is the only prefetchable read cycle. In response to any target PCI read cycle, the GT-64111 will read an entire cache line (32 bytes) from memory into one of the target FIFOs.

If the read is a Memory Read Multiple, as soon as at least two words are delivered from the FIFO to the PCI bus, another 32 bytes is prefetched into the second FIFO. In this case, the GT-64111 is essentially “guessing” that MRM cycle will be longer than 32 bytes.

In a non-prefetchable read cycle, data is not fetched into the second FIFO until after all data from the first FIFO is delivered to the PCI bus.

Cycles to internal registers and Configuration cycles are non-postable or prefetchable.

6.2.2 PCI Target Address Space Decode and Byte Swapping

The GT-64111 decodes accesses on the PCI bus for which it may be a target by the values programmed into its Base Address Registers (BARs). There are two sets of BARs: regular BARs (in PCI Function 0) and swap BARs (in PCI Function 1). Accesses decoded by the swap BARs are passed with to/from the target memory device after converting the endianness of the data (e.g. little-endian to big-endian). Accesses decoded by the regular BARs, by comparison, are passed without modifying the data to/from the target memory device.

The GT-64111 uses a two stage decode process for accesses through the PCI target interface. Once a PCI accesses is determined to be a “hit” based on the BAR comparison, the address is passed to the Device Unit for sub-decode. For example, Base Address Register 0 in Function 0 (BAR0) decodes non-byte swapped accesses to the DRAM controlled by either RAS0* or RAS1*. The GT-64111 then uses the values programmed into the RAS0 Low and RAS0 High decode registers to determine if the access is to the DRAM connected to RAS0. Note that the second stage decoders are shared with the CPU/Local Master (see “CPU/Local Master Address Space Decode” for a nice picture showing this.)

On reads, if the target PCI address “hits” based on the BAR decode, then misses in the Device Unit, will return random data. On writes, if the target PCI address “hits” based on the BAR decode, then misses in the Device Unit, the data will be discarded. In both situations, the MemOut interrupt will be set (bit 1 of the Interrupt Cause Register, 0xc18).

Further, when the GT-64111 is a PCI target and there is a hit in one of the Base Address Registers, the MemEn/IOEn bit of the Status and Command Register (PCI Config. Register 0x04) must be set to ‘1’ in order for the GT-64111 to respond to PCI memory/IO transactions. If MemEn/IOEn is set to ‘0’ and there is a hit in one of the Base Address Reg-

isters, the GT-64111 will not respond to memory/IO transactions.

6.2.3 Tweaking the Performance of the Target Interface

The GT-64111 includes special performance tuning features for the PCI target interface. The Timeout0 and Timeout1 registers allow the designer to force the GT-64111 to wait either longer than normal, or shorter than normal, before issuing a RETRY/DISCONNECT. The Timeout0 value sets the number of clocks the GT-64111 will wait for the first data of an access before issuing a RETRY. The Timeout1 value sets the number of clocks the GT-64111 will wait between subsequent data phases during an access before issuing a DISCONNECT. The PCI 2.1 specifications sets the maximum for both of these at 16 clocks (Timeout0) and 8 clocks (Timeout1) respectively. However, in many systems, especially those with long DRAM latencies, it may be necessary to “bend” these restrictions.¹

If you see what appears to be excessive RETRY/DISCONNECT behavior in your system, try lengthening the Timeout0/1 values. It may be because there is a lot of memory activity due to the CPU/Local Master or DMA engines, and the PCI interface cannot get to the DRAM within 16 clocks.

6.3 PCI Synchronization Barriers

The GT-64111 considers some cycles to be “synchronization barrier” cycles. In such cycles, the GT-64111 makes sure that at the end of the cycle there remains no posted data within the chip.

The target “synchronization barrier” cycles are Lock Read and Configuration Read. If there is no posted data within the GT-64111, the cycle ends normally. If after a retry period there is still posted data, the cycle will be retried. Until the original cycle ends, any other (different address/command) “synchronization barrier” cycles will be retried. Lock Read is a “synchronization barrier” cycle which lasts during the entire Lock period, i.e. when the slave is locked all Configuration Reads will be retried. Also, all cycles addressed to internal registers will be retried until Lock ends.

The CPU/Local Master interface treats I/O Reads to PCI and Configuration Reads as “synchronization barrier” cycles as well. These reads will be responded to once no posted data remains within the GT-64111.

6.4 PCI Master Configuration

The GT-64111 translates CPU/Local Master read and write cycles into configuration cycles using PCI configuration mechanism #1 (per the PCI specification). Mechanism #1 defines a way to translate the CPU/Local Master cycles into both PCI configuration cycles on the PCI bus, and accesses to the GT-64111’s internal configuration registers.

The GT-64111 includes two registers: Configuration Address (at offset 0xcfc8) and Configuration Data (at offset 0xcfc). The mechanism for accessing configuration registers is to write a value into the Configuration Address register that specifies:

- PCI bus number (usually bus 0, the bus attached directly to the GT-64111)
- The device on that bus
- The function number within the device
- The configuration register within that device/function being accessed

A subsequent read or write to the Configuration Data register (at 0xcfc) then causes the GT-64111 to translate that Configuration Address value to the requested cycle on the PCI bus.

If the BusNum field in the Configuration Address register equals ‘0’ but the DevNum field is other than ‘0’, a Type0 access is performed which addresses a device attached to the local PCI bus. If the BusNum field in the Configuration Address register is other than ‘0’, a Type1 access is done which addresses a device attached to a remote PCI bus.

The GT-64111 performs address stepping for PCI configuration cycles. This allows for the use of the high-order PCI AD signals as IdSel signals through resistive coupling.² Table 20 shows DevNum to IdSel mapping.

1. The PCI specification also states that a master may not enforce target rules. In other words, even if the GT-64111 takes longer than 16 clocks to return the first data, the master must just wait patiently.

2. “Resistive Coupling” is a fancy way of saying “hook a resistor from ADx to IdSel” on a given device. Look at the Galileo-4PB backplane schematics for examples.

TABLE 20. DevNum to IdSel Mapping

DevNum[15:11]	PAD[31:11]
00001	0 0000 0000 0000 0000 0001
00010	0 0000 0000 0000 0000 0010
00011	0 0000 0000 0000 0000 0100
00100	0 0000 0000 0000 0000 1000
-	-
-	-
-	-
10101	1 0000 0000 0000 0000 0000
00000, 10110 - 11111	0 0000 0000 0000 0000 0000

The CPU/Local Master accesses the GT-64111's internal configuration registers when the fields DevNum and BusNum in the Configuration Address register are equal to '0'. The GT-64111 configuration registers are also accessed from the PCI bus when the GT-64111 is a target responding to PCI configuration read and write cycles.

Note: The CPU/Local Master interface unit cannot distinguish between an access to the GT-64111 PCI configuration space and an access to an external PCI device configuration space. This is because both are accessed using an access to the GT-64111 internal space (i.e. Configuration Data register). When the CPU/Local Master is operating in big-endian mode, any access to the GT-64111 internal space undergoes byte swapping as all internal registers are little-endian. With the CPU/Local Master operating in big-endian mode and the PCI ByteSwap bit (bit [0] @ 0xc00) set to '0' (i.e., swap bytes), bytes will be swapped once for PCI configuration accesses intended for the GT-64111 configuration space but will be swapped twice for PCI configuration accesses intended for devices external to the GT-64111. This requires the software to format write data and interpret read data differently for PCI configuration accesses to the GT-64111's registers and configuration accesses through the GT-64111 to an external device.

IMPORTANT: The configuration enable bit (ConfigEn) in the Configuration Address register must be set before the Configuration Data register is read or written. Failure to do this will "lock up" the GT-64111 and require a RESET to recover.

6.4.1 Special Cycles and Interrupt Acknowledge

A Special cycle is generated whenever the Configuration Data register is written to while the Configuration Address register has been previously written with '0' for BusNum, '1f' for DevNum, '7' for FunctNum and '0' for RegNum.

An Interrupt acknowledge cycle is generated whenever the Interrupt Acknowledge (0xc34) register is read.

6.5 Target Configuration and Plug and Play

The GT-64111 includes all of the required plug and play PCI configuration registers. These registers, as well as the GT-64111's internal registers, may be accessed from both the CPU/Local Master and the PCI bus.

The GT-64111 acts as a two function device when being configured from the PCI bus. The base address registers available in Function 0 are used to decode accesses for which there is no byte swapping; Function 1 is used to decode byte swapped addresses. All other registers are shared between Function 0 and Function 1.

6.5.1 Plug and Play Base Address Register Sizing

Systems adhering to the plug and play configuration standard determine the size of a base address register's decode range by first writing 0xFFFF.FFFF to the BAR, then reading back the value contained in the BAR. Any bits that were unchanged (i.e. read back a zero) indicate that they cannot be set and are therefore not part of the address comparison. With this information the size of the decode region can be determined.¹

The GT-64111 responds to BAR sizing requests based on the values programmed into the Bank Size Registers. These

registers can be loaded automatically after RESET from the system ROM (see below).

6.5.2 Multi-Function Device, Swap BARs

If one of the Swap Base Address Registers is enabled after Rst* (see Reset Configuration), the GT-64111 will be configured as a multi-function device (bit 7 in the Header Type register set to 1, 0xe). To access any of the Swap Base Address Registers, a configuration access addressed to function #1 should be used with the appropriate register offset. If a different offset other than 0x010, 0x014, or 0x01c is accessed when specifying function #1, the transaction will access the corresponding offset register in function #0. Configuration transactions to any other function number will be ignored.

If none of the Swap Base Address Registers are enabled after Rst*, the GT-64111 will be configured as a single function device (bit 7 in the Header Type register set to 0, 0xe) and the function #1 configuration registers will be unaccessible.

Note: If the GT-64111 is programmed as a single function device, the Swap Base Address Registers can still be programmed by a configuration access addressed to function #1 and the appropriate register offset. But, any PCI access which is a hit in these Swap Base Address Registers will be ignored by the GT-64111.

6.5.3 PCI Autoconfiguration at RESET

Eight PCI registers can be automatically loaded after Rst*. Autoconfiguration mode is enabled by asserting the DMAReq[3]* LOW on Rst*. Any PCI transactions targeted for the GT-64111 will be retried while the loading of the PCI configuration registers is in process.

It is highly recommended that all PC applications utilize the PCI Autoconfiguration at RESET feature. The auto-load feature can be easily implemented with a very low cost EPLD. Galileo provides sample EPLD equations upon request. (You can always pull the EPLD off your final product if you find there are no issues during testing.)

NOTE: The GT-64111's default Class Code is 0x0580 (Memory Controller) which is a change from the GT-64011. The GT-64011 used the Class Code 0x0600 which denotes Host Bridge. Some PCs refuse to configure host bridges if they are found plugged into a PCI slot (ask the BIOS vendors why...). The "Memory Controller" Class Code does not cause a problem for these non-compliant BIOSes, so we used this as the default in the GT-64111. The Class Code can be reprogrammed in both devices via autoloading or CPU register writes.

1. Please refer to the PCI specification for more information on the BAR sizing process.

The PCI register values are loaded from the ROM controlled by BootCS* are shown in Table 21, below.

TABLE 21. PCI Registers Loaded at RESET

Register	Offset	Boot Device Address
Device and Vendor ID	0x000	0x1ffffe0
Class Code and Revision ID	0x008	0x1ffffe4
Subsystem Device and Vendor ID	0x02c	0x1ffffe8
Interrupt Pin and Line	0x03c	0x1ffffec
RAS[1:0]* Bank Size	0xc08	0x1fffff0
RAS[3:2]* Bank Size	0xc0c	0x1fffff4
CS[2:0]* Bank Size	0xc10	0x1fffff8
CS[3]* & Boot CS* Bank Size	0xc14	0x1fffffc

6.5.4 Expansion ROM Functionality

The GT-64111 implements the PCI Expansion ROM as required by PC boot devices. The PCI Expansion ROM functionality is enabled by strapping DAdr[2] low at RESET (see Reset section.)

If the PCI Expansion ROM is disabled, expansion ROM register (offset 0x30 of PCI configuration space) acts as reserved register and returns all '0's when read.

When the expansion ROM is enabled by the pin strapping option, the PCI Expansion ROM BAR appears magically in the GT-64111's PCI configuration header. However, the Expansion ROM decoder shares functionality with the CS3*/BootCS* resource. In normal operation (i.e. after the BIOS initialization is complete), the Expansion ROM is disabled via bit 0 in the Expansion ROM BAR. During BIOS boot, however, the BIOS "turns on" the Expansion ROM decoder by setting bit 0. When the Expansion ROM decoder is "on" the following happens:

- The PCI target will act as if the Timeout0 and Timeout1 MSBs are '1' (which means initial value of 0x8f and 0x87 respectively). This is done to allow for the long default access time from 8-bit boot ROMs.
- The Device unit will bypass its address decoding for ALL transactions from PCI that are targeted to expansion ROM or CS[3]/BootCS* . All of these transactions will assert CS[3] regardless of the actual address.
- The GT-64111 will act this way as long as bit[0] of expansion ROM register is set to 1 (it's the BIOS responsibility to clear this bit when it is done executing/probing the Expansion ROM. (If for any reason the BIOS does not clear bit[0] of expansion ROM BAR, you can still program this bit to 0 from CPU/Local Master side.)

6.6 PCI Parity Support

GT-64111 implements all parity features required by PCI spec, including PAR,PERR* and SERR* generation and checking.

As an initiator, GT-64111 generates even parity on PAR signal for address phase and data phase of write transaction. It samples PAR on data phase of read transaction. If it detects bad parity and PErrEn bit in Status and Command configuration register is set, it asserts PERR*.

As a target, GT-64111 generates even parity on PAR signal for data phase of a read transaction. It samples PAR on address phase and data phase of write transaction. If it detects bad parity and PErrEn bit in Status and Command configuration register is set, it asserts PERR*.

GT-64111 might asserts SERR* if one of the following conditions occur:

- Detect bad address parity as a target
- Detect bad data parity on a write transaction as a master (detects PERR* asserted)
- Detect bad data parity on a read transaction as a master
- Detect ECC error on read from SDRAM or Device
- Performs master abort

- Detect target abort

SERR* will be asserted if SErrEn bit in *Status and Command* configuration register is set to 1 and if SERR* is not masked through *SERR Mask* register.

6.7 PCI Bus/Device Bus/CPU/Local Master Clock Synchronization

The PCI interface is designed to run asynchronously with respect to the AD and CPU/Local Master buses. The synchronization delay between these two clock domains can be reduced, however, by running the interfaces in synchronized mode. An example would be having the CPU/Local Master/AD buses running at 66MHz and the PCI bus running at a 33MHz frequency that was derived from the 66MHz.

Latency through the GT-64111 is reduced to a minimum when synchronized mode is selected. The synchronization mode is set via the SyncMode bits in the PCI Internal Command register (0xc00).

Note: PClk frequency must be smaller than TClk frequency by at least 1MHz. Please see AC Timing section for more information.

6.8 66MHz Capability Bit

The 66MHz capability bit in the PCI header is sampled from an external pin at RESET. **Note that the state of this bit does not in any way affect the speed of the PCI interface.** It only acts as an "advertisement" to other PCI devices (or the host CPU) that the GT-64111 is capable of running at 66MHz.

Please see the RESET strapping options section for more details.

6.9 Universal PCI Vio Pin

The Vio pin is used by the GT-64111 to determine the signalling voltage of the PCI interface (3.3V or 5V). This pin is normally connected to pin 88 on side B of a standard PCI connector when used in a PCI add-in card application.

NOTE: The Vio pin on the GT-64111 was used as the Vref pin on the GT-64011. Vref is used on the GT-64011 to set the voltage for the CPU interface to be either 3.3V or 5V.

6.10 PCI Interface Restrictions

Note: No PCI access should be attempted before 6 PClk cycles following deassertion of Rst* have expired.

6.10.1 Master

- a) Latency count, as specified in LatTimer (PCI Configuration Register 0x00c), should not be programmed to less than 6.

6.10.2 Slave

- a) The set bits in the Bank Size registers must be sequential.
- b) When the slave is locked, in order to prevent a deadlock, all transactions to internal registers (I/O or memory cycles) are not supported (retry will be issued).
- c) Timeout0 (PCI Internal register 0xc04), should not be programmed to less than 2.

6.10.3 Master and Slave

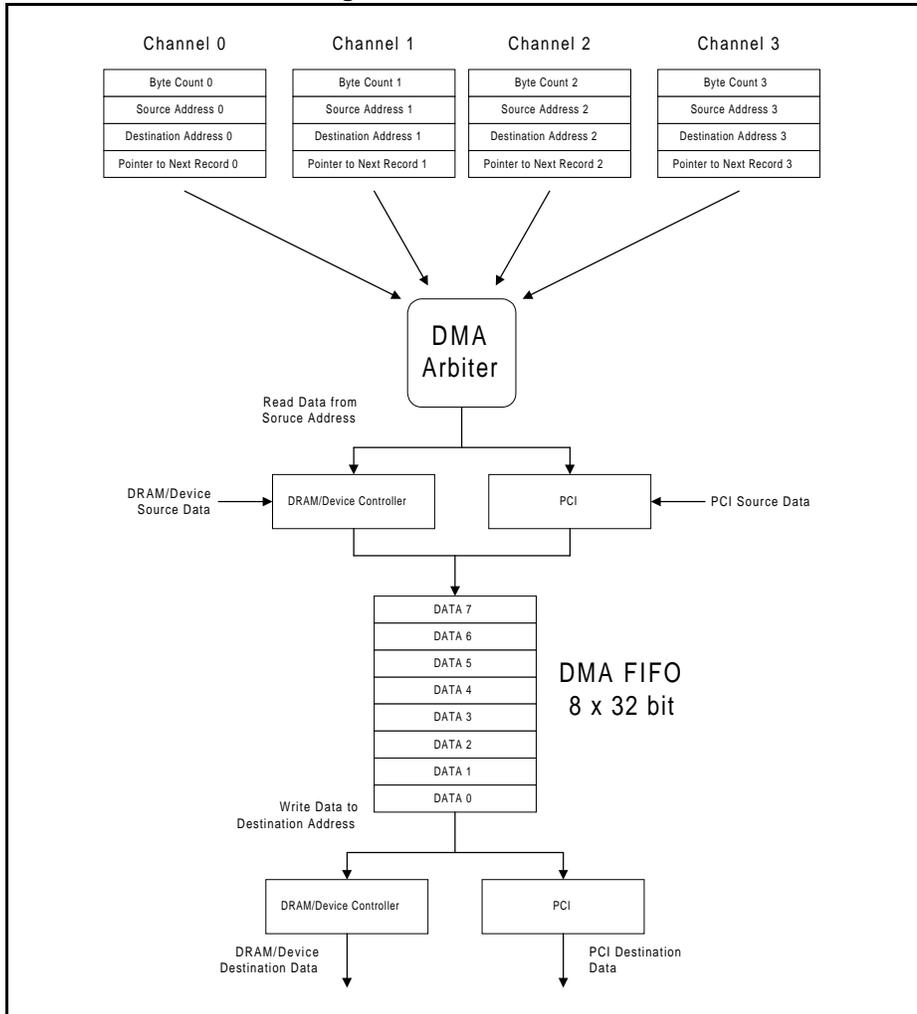
- a) PClk frequency must be smaller than TClk frequency by at least 1MHz.

7. DMA Controller

The GT-64111's DMA Controller consists of four independent channels. The DMA channels are used to optimize system performance by moving large amounts of data without CPU intervention. Rather than having the CPU read data from one source and write it to another, each DMA channels can be programmed to automatically transfer data independent of the CPU. This frees the CPU and allows it to continue executing other instructions simultaneous to the movement of data.

Each DMA channel can move data between DRAM and devices, between devices on the PCI bus, or between DRAM and devices, and devices on the PCI bus. The four DMA channels request to execute a DMA and if there are simultaneous requests, a programmable arbiter which DMA channel will be serviced (see Section 7.5 for more information about the DMA Arbiter). All DMA transfers use an internal 32-byte FIFO for moving data (see Figure 24). Data is transferred from the source into the internal FIFO, and from the internal FIFO to the destination. Each DMA channel can be programmed to move up to 64 KBytes of data per transaction. The burst length of each transfer of DMA can be set from 1 to 32 bytes. Accesses can be non-aligned both in the source and the destination.

Figure 24: DMA Controller



7.1 DMA Channel Registers

Each DMA Channel record consists of the following data fields which can be written by the CPU, PCI, or DMA controller in the process of fetching a new record from memory:

- **Byte count (0x800 - 0x80c).** This register is programmed with a 16-bit number which contains the number of bytes of data that this channel must DMA. The maximum number of bytes which a the DMA channel can be configured to transfer is 64K. This register will decrement at the end of every burst of transmitted data from source to destination. When the byte count register is 0, the DMA transaction is finished.
- **Source address (0x810 - 0x81c).** This register is programmed with a 32-bit address. This is the source address for data and can be from the DRAM, Device or from PCI. This register will either increment, decrement, or hold the same value according to bits 3:2 of the Channel Control Register (see Section 7.2.2).
- **Destination address (0x820 - 0x82c).** This register is programmed with a 32-bit address. This is the destination address for data and can be to the DRAM/Device or to PCI. This register will either increment, decrement, or hold the same value according to bits 5:4 of the Channel Control Register (see Section 7.2.3).
- **Pointer to the next record (0x830 - 0x83c).** The register contains a 32-bit address where the values for the next DMA Channel record can be loaded for chained operation. This can be from the DRAM/Device controller or from PCI. The byte count, source address, and destination address must be located at sequential addresses. This register is only used when the channel is configured for Chained Mode (see Section 7.2.5). A value of '0' (NULL) for this register indicates this is the last record in the chain. See below for more information about Chained DMA mode.

7.2 DMA Channel Control Register (0x840 - 0x84c)

Each DMA Channel has its own unique Control Register where certain DMA modes can be programmed. Following are the bit descriptions for each field in the control register.

7.2.1 AddControl[1:0], GT-64111-P-1 ONLY

AddControl[1:0] are for Source and Destination address control for PCI devices (regardless of the CPU Interface unit's address decoding). In other words, the DMA will access PCI Memory regardless of the results of the address decoding in the CPU Interface unit if the proper bit is set.

TABLE 22. Setting AddControl[1:0]

AddControl[0]	AddControl[1]	Source	Destination
0	0	CPU Address Space	CPU Address Space
1	0	PCI Memory Space	CPU Address Space
0	1	CPU Address Space	PCI Memory Space
1	1	PCI Memory Space	PCI Memory Space

7.2.2 SrcDir, bits[3:2]

The SrcDir field contains information about how the source address for the DMA transfer is handled. These bits, if set to '00' (default), will automatically increment the source address. If set to '01', the source address will automatically decrement. If set to '10', the source address will remain constant throughout the DMA burst. '11' is a reserved setting and these bits must not be set to this value.

7.2.3 DestDir, bits[5:4]

The DestDir field contains information about how the destination address for the DMA transfer is handled. These bits, if set to '00' (default), will automatically increment the destination address. If set to '01', the destination address will automatically decrement. If set to '10', the destination address will remain constant throughout the DMA burst. '11' is a reserved setting and these bits must not be set to this value.

7.2.4 DatTransLim, bits[8:6]

The DatTransLim field contains the burst limit of each data transfer. The burst limit can vary from 1 byte to 32 bytes in modulo-2 steps (i.e. 1, 2, 4,..., 32) as shown in Table 23.

TABLE 23. Setting DataTransLim

Bits 8:6	Transfer Limit of each DMA Access
101	1 Byte
101	2 Bytes
000	4 Bytes
001	8 Bytes
011	16 Bytes
111	32 Bytes

7.2.5 ChainMod, bit 9

ChainMod determines whether this channel is set in chained mode or not. The default setting of '0' enables chained mode for the channel. Therefore, at the completion of a DMA transaction, the Pointer to Next Record Register provides the address of a new DMA Record. If this register contains a value of '0' (NULL), this indicates that this is the last record in the chain.

In chained mode (bit 9 set to 0), a channel can be enabled by two different methods.

1. The channel record's parameters for the current transaction (Byte Count, Source, Destination, and Next Record Pointer) should be initialized in DRAM/Device memory space or PCI devices. The address of the first record should be initialized by writing it to the Next Record Pointer Register of the channel. The channel should be enabled by setting ChanEn to '1' (see Section 7.2.8), and setting FetNexRec (see Section 7.2.9) to '1'. Setting these two bits can be completing during the same write or FetNexRec should be set to '1' on the first write and then the DMA can be initiated by setting ChanEn to '1' on another write. If in block mode, the DMA will start once the particular channel has been arbitrated for. If in demand mode, the DMAReq* must be asserted and then the DMA will start once the particular channel has been arbitrated for.
2. The channel's record's parameters for the current transaction (Byte Count, Source, Destination, and Next Record Pointer) should be initialized in the proper DMA Channel Registers. In block mode, the DMA can be initiated by setting ChanEn to '1' and the DMA will start once the particular channel has been arbitrated for. If in demand mode, the DMAReq* must be asserted and then the DMA will start once the particular channel has been arbitrated for.

Fetching the data for the next record (i.e. loading Byte Count, Source, Destination, and Next Record Pointer registers) is not dependent on DMAReq*. This action will occur automatically as long as the channel is enabled and FetNexRec is set to '1' or the Byte Count has reached a terminal count and the Next Record Pointer is not NULL.

See Figure 25 for a diagram of chained mode DMA. If ChainMod is set to '1', chained mode is disabled. Note that in non-chained mode the Byte Count, Source, and Destination Registers should be initialized prior to enabling the channel.

7.2.6 IntMode, bit 10

IntMode controls when this channel asserts the DMAComp (DMA Complete) Interrupt. The default setting of '0' sets the channel to assert the DMAComp Interrupt every time the DMA byte count reaches 0. If the channel is set to chained mode, and IntMode is set to '1', the DMAComp Interrupt will only be asserted when both the Pointer to Next Record Register has a NULL value and Byte Count is 0. If chained mode is disabled, the setting of IntMode is irrelevant and DMAComp Interrupt will be asserted every time the Byte Count reaches 0.

7.2.7 TransMod, bit 11

TransMod indicates whether the channel is set to operate in demand mode or block mode. The default setting of '0' set the channel to operate in demand mode where DMA accesses are initiated by externally asserting one of the four DMAReq[3:0]* pins. If TransMod is set to '1', the channel is set to operate in block mode where DMA accesses are initiated by setting ChanEn, Bit 12. In Block mode, the DMAReq* lines are ignored.

7.2.8 ChanEn, bit 12

ChanEn can enable or disable the DMA channel. When ChanEn is set to '0', the channel is disabled. When ChanEn is set to '1', the DMA is initiated based on the current setting loaded in the channel record (i.e. Byte Count, Source Address and Destination Address). *Note that the DMA channel can be enabled or disabled via ChanEn if the channel is in Demand or Block Mode.*

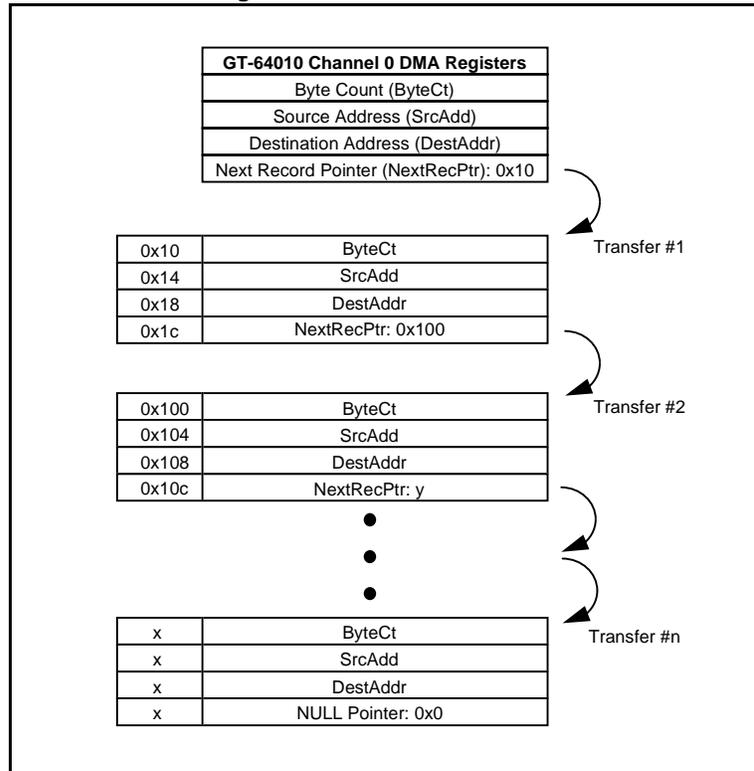
7.2.9 FetNexRec, bit 13

FetNexRec is a field which is only meaningful when chained mode is enabled for the channel. Setting this bit to '1' will force a fetch of the next record based on the value in the Pointer to Next Record Register. This bit can be set even if the current DMA has not yet completed. This bit is reset back to '0' after the fetch of the new record is complete.

7.2.10 DMAActSt, bit 14 (Read Only)

DMAActSt is a read only field and can be polled to see the DMA activity status of the channel. If this bit is set to '0', the channel is not active. If this bit is set to '1', the channel is active.

Figure 25: Chained Mode DMA



7.3 Restarting a Disabled Channel (previously active)

In Non-Chained mode, ChanEn should be set to '1'.

In Chained mode, the software should find out if the first fetch took place. If it did, only ChanEn should be set to '1'. If it did not, the FetNexRec should also be set to '1'.

7.4 Reprogramming an Active Channel

To reprogram an active channel, the channel should first be disabled by setting ChanEn to '0'. Then it must be assured that the channel is no longer active (for example by polling the DMAActSt of the channel). New DMA parameters should be programmed prior to re-enabling the channel via setting ChanEn to '1'.

7.5 Arbitration

The DMA controller has a programmable arbitration scheme between its four channels. The channels are grouped into two groups, one group includes channel 0 and 1, and the other group includes channels 2 and 3. The channels in each group can be programmed to have priority so that a selected channel has the higher priority, or to have the same priority in round robin. The priority between the two groups can be programmed in a similar way so that a selected group has a higher priority, or to have the same priority in round robin. The priority scheme has additional flexibility with the programmable Priority Option. With the Priority Option the DMA bandwidth allocation can be divided in a fairer way. For example, if the PrioOpt bit is set to '0' and the PrioGrps field is set as '10', the requesting devices will get the DMA in the order 0,1,2,0,1,3,0,1,2,0,1,3,..... (assuming that PrioChan1/0 and PrioChan3/2 are set to round robin), while if the PrioOpt bit is set to '1' the requesting devices will get the DMA in the order 0,1,0,1,0,1,2,3,2,3,2,3,..... The DMA arbiter control register can be reprogrammed any time regardless of the channels' status (active or not active).

Some arbitration examples follow to facilitate the understanding of this register are shown in Table 24.

TABLE 24. Channel Arbitration Examples

# of Requesting Channel	Example Channels	Arbiter Control Register Value	Channel Service Order
4	All	0x40	0,2,1,3,0,2,1,3,.....
4	All	0x0	0,1,2,3,0,1,2,3,.....
3	0,1,2	0x40	0,2,1,2,0,2,1,2,.....
3	0,1,2	0x0	0,1,2,0,1,2,0,1,2,.....
4	All	0x45	1,3,1,3,1,3,.....,0,2,0,2,0,2,.....
4	All	0x5	1,0,3,2,1,0,3,2,1,0,3,2,.....
3	0,1,2	0x45	1,2,1,2,1,2,.....,0,0,0,0,0,0,.....
3	0,1,2	0x5	0,1,2,0,1,2,.....
4	All	0x55	3,3,3,3,3,3,2,2,2,2,1,1,1,1,0,0,0,.....
4	All	0x15	3,2,1,3,2,0,3,2,1,3,2,0,.....
3	0,1,2	0x55	2,2,2,2,1,1,1,1,0,0,0,0,.....
3	0,1,2	0x15	2,1,2,0,2,1,2,0,.....
3	0,2,3	0x55	3,3,3,....,2,2,....,0,0,0,.....
3	0,2,3	0x15	3,2,0,3,2,0,3,2,0,.....

7.6 DMAReq[3:0]*

The DMAReq[3:0]* input pins are asserted by an external device to request a DMA transfer in Demand mode. The DMAReq* should be asserted as long as the transfer initiator has at least DataTransLim of bytes to provide (in case that it is the source) or as long as it has space to absorb at least DataTransLim of bytes (in case that it is the destination). The DMAReq* should be deasserted by the source when the transfer initiator sees that it does not have at least DataTransLim of bytes to provide (i.e. FIFO empty). DMAReq* should also be deasserted by the destination when the it does not have enough space to absorb at least DataTransLim of bytes (i.e. FIFO full) AND DMAAck* is asserted LOW.

The DMAReq* is sampled on every clock cycle but it influences arbitration only in the DMA arbitration cycle or when all channels are idling. The DMA arbitration cycle is the cycle in which the destination unit inside the GT-64111 acknowledges the last written data from the DMA unit.

7.7 DMAAck[3:0]*

The DMAAck[3:0] output pins are asserted by the GT-64111 to indicate that a current DMA request is being serviced. The DMAAck* is asserted only when the GT-64111 accesses a Device. It is asserted when ALE is asserted and should be qualified with CSTiming*.

7.8 Design Information

The following sections contain more detailed information about designing with GT-64111's DMA Controller. The following definitions are used throughout this section:

1. Device: A device located on the memory bus mapped to one of the GT-64111's Chip Selects (including BootCS).
2. PCI Agent: Any device located on the PCI bus.
3. DRAM: DRAM memory located on the memory bus.

7.8.1 DMA in Demand Mode

Demand mode is especially designed for transferring data between Memory (Device, DRAM, PCI agent) and a Device. This is because the DMAAck* is asserted only when the GT-64111 is accessing a Device. In this mode the transfer initiator (usually a Device) asserts DMAReq* to signal the GT-64111 that a new DMA transfer should begin. As an acknowledgment response, the GT-64111 asserts the DMAAck* to signal that the asserted DMAReq* is currently being processed.

In each DMA transfer, the DMA attempts to read the amount of DataTransLim from the source address and writes it to destination address. In the source direction, at the beginning and end of the DMA, there may be less than DataTransLim transfers if the address is not aligned or the remaining Byte Count to be transferred is smaller than the DataTransLim. In the destination direction, the DMA writes all data that was read from the source to the destination. This may happen in two DMA accesses if the destination address is not aligned.

The channel will stay active until the Byte Count reaches the terminal count or until the CPU disables the channel. Note that if the DMAReq* is always asserted, then this is equivalent to transfer data in Block Mode.

7.8.1.1 DemandMode DMA examples/recommendations

Source: DRAM/PCI, Destination: DRAM/PCI

In Demand mode, then DMAAck* should be externally generated (i.e. polling accesses of the GT-64111 to certain addresses). Typically, in this case it is better to use BlockMode because Memory is typically always ready and DMAAck* is NEVER asserted.

Source: Device, Destination: DRAM or PCI

The Device transfer initiator asserts DMAReq* when it has at least DataTransLim number of bytes to provide. It should deassert the DMAReq* when no more data is ready and DMAAck* is asserted. Even if another master (like a PCI master) drives the DMAReq* then the DMAAck* can signal to that master that the GT-64111 is currently accessing the device for read. Note that DMAAck* must always be qualified with CSTiming*.

Source: DRAM or PCI, Destination: Device

The Device transfer initiator asserts a DMAReq* when it can absorb DataTransLim number of bytes to be written to it. Even if another master drives the DMAReq* then the DMAAck* can signal the master that the GT-64111 is currently accessing the device for write.

7.8.2 DMA in Block Mode

In block mode no hand shake signals are used to initiate DMA transfers. The DMA unit will complete the transfer once the CPU has programmed the DMA and enabled it.

7.8.3 Non-Chain Mode

In non-chain mode the CPU or PCI master initiates the DMA channel parameters (Source, Destination Byte Count and command Registers). The DMA will start to transfer data after the enable bit in the Command register is set to 1. The DMA remains in an active state until the Byte Count reaches a terminal count or until the channel is disabled.

7.8.4 Chain Mode

In chain mode the DMA channel parameters (Source, Destination Byte Count and Pointer to Next Record) are read from records located in Memory, Device or PCI. The DMA channel stays in the active state until Pointer to Next Record is NULL and the Byte Count reaches the terminal count. In this mode, an interrupt can be asserted every time the byte count reaches the terminal count or when BOTH the Byte Count reaches the terminal count and the Pointer to Next Record is NULL.

7.8.5 Dynamic DMA chaining

Dynamic chaining is when DMA records are added to a chain which a DMA channel is actively working on. The main issue is to synchronize between when the GT-64111 reads the last chain record (the NULL pointer) to the time the CPU changes the current last DMA record. Following is an algorithm which provides this synchronization mechanism.

1. Prepare the new record.
2. Change the last record's Pointer to Next Record to point to the new record.
3. Read the DMA control register.

```
If the DMAActSt bit is 0 (NOT active) {
```

```
    Update the Pointer to Next Record in the GT-64111 and assert the FetNexRec bit
```

```
}
```

```
else {
```

```
    read the Pointer to Next Record GT-64111. If it's equal to NULL {
```

```
        Mark (by using a flag or something) that in the next DMA chain complete interrupt you'll need to -
```

```
        [{}]
```

```
        Update the NRP register in the GT-64010 and Write the Fetch Next Record }]]]
```

```
}
```

```
}
```

7.9 DMA Restrictions

1. Transfers of less than 4 bytes are not supported.
2. When Source or Destination address is decremented, both addresses should be word-aligned (that is, A1 and A0 should be both zero), and Byte Count should be a multiple of 4 (this applies for burst limits greater than 4 bytes).
3. When the burst limit is less than 4 bytes, no decrement mode (source or destination) is not supported.

4. When using the address hold option in the source direction (see Section 7.2.2), the source address should keep the following rules:
 - word-aligned if burst limit is greater or equal to 4 bytes.
 - bits [1:0] equal to 00, 01 or 10 if burst limit is equal to 2 bytes.
 - no restriction for burst limit equal to 1 byte.

5. When using the address hold option in the destination direction (see Section 7.2.3), the following rules should be kept:
 - both Source and Destination addresses should be word-aligned if burst limit is greater or equal to 4 bytes.
 - bit [0] of both Source and Destination addresses should be equal to 0 if burst limit is equal to 2 bytes.
 - no restriction for burst limit equal to 1 byte.

6. Fly-by transfers are not supported.

7. Records' addresses must be a multiple of 16 bytes.

8. If the destination is a device and if DataTransLimit is smaller or equal 4 bytes, the DMAAck* asserts during the same cycle as the arbitration cycle. Therefore, DMAReq*, which is typically de-asserted based on the assertion of DMAAck*, is NOT seen in the DMA arbitration cycle. So although the device does not want to be accessed, a new transfer may begin.
 - If DataTransLimit is bigger than 4 bytes then there is no problem. In this case, it is recommended to have a device that can accept bursts.

 - A solution when using one channel only and DataTransLim is less equal to 4 is as follows:
 - STATE A: The first request should be issued after the channel is enabled and the Device has enough room for DataTransLim. DMAReq* should be asserted for 1 cycle and then deasserted.
 - STATE B: While DMAAck* is asserted, if the Device has enough room for data, assert the DMAReq* for 1 cycle and then deassert the request. Remain in STATE B. If the Device has no room for data then do not assert the DMAReq*. Go to STATE A.

 - For 16-bit devices, use 4 byte source aligned addresses for data in DRAM, and Device destination addresses aligned to 4 bytes + 2 while DataTransLim = 4 bytes.

8. Timer/Counters

There are three 24-bit wide and one 32-bit wide timer/counter on the GT-64111. Each one can be selected to operate as a timer or as a counter. In Counter mode, the counter will count down to terminal count, will stop and issue an interrupt. In Timer mode, it will count down, will issue an interrupt on terminal count, and will reload itself to the programmed value and continue to count. Reads from the counter or timer are done from the counter itself, while writes are to its register. For example, note that even though the registers are programmed to an initial value of '0' the counters will read 0xfffff. In order to reprogram a timer/counter, it should first be disabled, then it should be loaded with a new value and after that it should be enabled as appropriate (counter or timer).

NOTE: There are no external input pins for enable/disable nor are there any output timer pins on the GT-64111.

9. Interrupt Controller

The GT-64111 includes an interrupt controller that routes internal interrupt requests to both the CPU/Local Master and the PCI bus.

The interrupt controller ORs all internal interrupt sources and asserts an interrupt to the CPU/Local Master or to the PCI when one or more internal interrupts are asserted. There is one Cause register and two Mask registers. The Cause register has one bit for each interrupt source. If the source asserts an interrupt, its respective bit in the Cause register will be set. This bit can be read by the CPU/Local Master or from the PCI bus.

The interrupt is acknowledged by the CPU/Local Master or by the PCI bus by resetting its bit in the Cause register (writing zero to the specific bit and one to all other bits). ONE EXCEPTION for the above is the CPUInt ([25:21] and PCIInt ([29:26])) which are used by the PCI to generate interrupt to the CPU and vice versa. These are SET by writing zero from the interrupt originating side and CLEARED by writing zero from the interrupt destination side. Each interrupt source has one mask bit in the CPU/Local Master Mask register and one bit in the PCI Mask register. A zero in the CPU/Local Master Mask register bit will mask the interrupt from asserting an interrupt to the CPU/Local Master. A zero in the PCI Mask register bit will mask the interrupt from asserting an interrupt to the PCI.

IntSum in the Interrupt Cause register is the logical OR of bits[29:1], regardless of the Mask registers' values. This is in order to be notified via polling if any interrupt occurred within the GT-64111. Therefore, bit[0] of both the CPU/Local Master Mask and PCI Mask registers is read-only '0'.

CPU/Local Master IntSum in the Interrupt Cause register is the logical OR of bits[29:26,20:1], masked by bits[29:26,20:1] of the CPU/Local Master Mask register. Therefore, bits[25:21] of the CPU/Local Master Mask register, being non-relevant to interrupts directed to the CPU/Local Master, are read-only '0'. Also bits[31:30], being summaries, are read-only '0'.

PCIIntSum in the Interrupt Cause register is the logical OR of bits[25:1], masked by bits[25:1] of the PCI Mask register. Therefore, bits[29:26] of the PCI Mask register, being non-relevant to interrupts directed to the PCI, are read-only '0'. Also bits[31:30], being summaries, are read-only '0'.

10. Reset Configuration

The GT-64111 must acquire some knowledge about the system before it is configured by the software. Special modes of operation are sampled on RESET in order to enable the GT-64111 to function as required. Certain pins must be pulled up or down (4.7K Ohm recommended) externally to accomplish this. The following configuration pins are continuously sampled from Rst* assertion until 3 TClk cycles after Rst* is deasserted.

Pin	Configuration Function
Interrupt*:	Endianess
0 -	Big endian data format
1 -	Little endian data format
DAdr[11:10]:	Device Boot Bus Width
00 -	8 bits
01 -	16 bits
10 -	32 bits
11 -	64 bits
DAdr[9]:	LEAdrE/DMAReq[2]* Selection
0 -	DMAReq[2]*
1 -	LEAdrE
DAdr[8]:	OEB Polarity
0 -	Active LOW
1 -	Active HIGH
DAdr[7]:	External Latches Presence
0 -	Latches are present
1 -	System without latches
DAdr[6]:	Enable/DisableCS[2:0] PCI BAR for address matching and size response
0 -	Enable
1 -	Disable
DAdr[5]:	DMAReq[1]*/ParErr* Selection
0 -	DMAReq[1]* (no parity)
1 -	ParErr*
DAdr[4]:	DMAReq[0]*/Ready* Selection
0 -	Ready*
1 -	DMAReq[0]*
DAdr[3]:	Enable/disable CS[3] & BootCS PCI BAR for address matching and size response
0 -	Enable
1 -	Disable

Pin	Configuration Function
DAdr[2]:	Enable PCI Expansion ROM
0 -	Enable
1 -	Disable
DAdr[1]:	Enable/Disable Swapped RAS[3:2] PCI BAR for address matching and size response
0 -	Enable
1 -	Disable
DAdr[0]:	Enable/Disable Swapped CS[3] & Boot CS PCI BAR for address matching and size response
0 -	Enable
1 -	Disable
DMAReq[3]*:	Autoload Enable
0 -	Enable
1 -	Disable
DMAReq[1]*/ParErr*:	Enable/Disable internal registers I/O mapped PCI BAR for address matching and size response
0 -	Enable
1 -	Disable
DMAReq[0]*/Ready*:	Enable/Disable RAS[3:2] PCI BAR for address matching and size response
0 -	Enable
1 -	Disable
Pin 15:	Enable 66MHz PCI Bus Capability in PCI Header ¹
0 -	33MHz PCI Bus Operation Indicated
1 -	66MHz PCI Bus Operation Indicated

1. This pin was a Vss on the GT-64011.

NOTES:

1. DAdr[9] should be pulled LOW whenever LEAdrE is not used in the system (e.g., DRAM is not operating in decrement mode).
2. If Autoload enable is sampled low during reset, device and vendor ID[31:0], class code and revision ID[31:0], Subsystem ID and Subsystem Vendor ID[31:0], Interrupt Pin, Interrupt Lines[15:0], RAS[1:0]* Bank Size, RAS[3:2]* Bank Size, CS[2:0]* Bank Size, CS[3] & BootCS* Bank Size will be autoloading starting from address 0x1FFF.FFE0.
3. If either DAdr[1] or DAdr[0] is sampled '0' on Rst*, the GT-64111 will be initialized as a multi-function device (bit 7 in the Header Type register set to 1, 0xe).
4. If a PCI BAR is disabled for address matching and size response, a PCI configuration read to this register will return 0x0. PCI configuration writes to this BAR will remain valid (i.e. the value of the configuration write will remain in the register). But, if a disabled BAR is programmed with a base address, and there is a PCI address on the PAD[31:0] bus which hits in the disabled BAR, the GT-64111 will ignore this transaction as if there was NO hit (i.e. DevSel* will NOT

be asserted).

5. If a PCI BAR is disabled for address matching and size response, a BIOS query of this disabled BAR for its size will respond with 0x0. In other words, if the disabled PCI BAR is first written to with 0xFFFF.FFFF, and then the disabled PCI BAR is read, the data returned will be 0x0.

11. Connecting the Memory Controller to DRAM and Devices

In order to connect the memory (DRAM and Devices) correctly, it is necessary to properly choose the system configuration. The GT-64111 supports two main configuration modes: without data latches or with data latches.

11.1 Working Without Data Latches

Only systems that do not have 64-bits wide memories can work without latches. In this configuration the only external latch required is for Device Control and Address (uni-directional 373 type).

Connection	Memory Width	Connect...	To...
DRAM Address	32-bit	DAdr[11:0]	DRAM address pins
Device Address ¹	32-bit	{dev_adr[21:2],DAdr[2:0]}	Device address pins
	16-bit	{dev_adr[21:0],DAdr[2:1]}	Device address pins
	8-bit	{dev_adr[21:0],DAdr[2:0]}	Device address pins
DRAM Data ^{2,3}	32-bit	AD[31:0]	DRAM data pins
Device Data ^{2,3}	32-bit	AD[31:0]	Device data pins
	16-bit	AD[16:0]	Device data pins
	8-bit	AD[7:0]	Device data pins
Device Control	32-bit or less	AD[31:0] ALE Control latch bit[0] output Control latch bit[1] output Control latch bit[23:2] outputs Control latch bit[27:24] outputs Control latch bit[31:28] outputs	Control latch inputs Control latch LE Becomes BootCS* Becomes DevRW* Becomes dev_adr [21:0] Becomes DMAAck[3:0]* Becomes CS[3:0]*

Notes:

- dev_adr[21:0] is the output of the control latch connected to AD[23:2], sampled by ALE.
- Regardless of data endianness,
 - ECAS[0]* and EWr[0]* always correspond to AD[7:0]
 - ECAS[1]* and EWr[1]* always correspond to AD[15:8].
 - ECAS[2]* and EWr[2]* always correspond to AD[23:16].
 - ECAS[3]* and EWr[3]* always correspond to AD[31:24].
- For load balancing, one can connect OWr[3:0]* and OCAS[3:0]* as well.

11.2 Working With Data Latches

11.2.1 64-bit DRAM

Connection	Memory Width	Connect...	To...
DRAM Address ¹	64-bit	DAdr[11:0] DAdr[11:0] Even latch outputs Odd latch outputs LEAdrE LEAdrO	Even latch inputs Odd latch inputs Even DRAM address pins Odd DRAM address pins Even latch LE Odd latch LE
DRAM Address ²	64-bit	DAdr[11:0] ⁴ DAdr[11:0] Odd latch outputs LEAdrO	Even DRAM address pins Odd latch inputs Odd DRAM address pins Odd latch LE
DRAM Address ³	64-bit	DAdr[11:0] ⁴ DAdr[11:0] Even latch outputs LEAdrO	Odd DRAM address pins Even latch inputs Even DRAM address pins Even latch LE
DRAM Data (Latched) ⁷	64-bit	AD[31:0] Even latch I/Os B side '0' LEE OEE* OEB ⁵ AD[31:0] Odd latch I/Os B side '0' LEO OEO* OEB ⁵	Even latch I/Os A side Even bank data pins Even latch CLKAB and CLKBA Even latch LEAB and LEBA Even latch OEBA* Even latch OEAB Odd latch I/Os A side Odd bank data pins Odd latch CLKAB and CLKBA Odd latch LEAB and LEBA Odd latch OEBA* Odd latch OEAB

Notes:

1. System supports decrement.
2. System is little endian without decrement.
3. System is big endian without decrement.
4. Signals can be optionally buffered.
5. Be careful if OEB is programmed at reset to have reverse polarity.
6. SysADC[3:0] from the CPU/Local Master too, if parity is supported.
7. Regardless of endianness,
 - ECAS[0]* and OCAS[0]* always corresponds to SysAD[7:0] and AD[7:0].
 - ECAS[1]* and OCAS[1]* always corresponds to SysAD[15:8] and AD[15:8].
 - ECAS[2]* and OCAS[2]* always corresponds to SysAD[23:16] and AD[23:16].
 - ECAS[3]* and OCAS[3]* always corresponds to SysAD[31:24] and AD[31:24].

11.2.2 32-bit DRAM

Connecting 32-bit DRAM is the same for the odd and even bank. It is optional to have one bidirectional buffer.

Connection	Memory Width	Connect...	To...
DRAM Address ⁴	32-bit	DAdr[11:0]	DRAM address pins
DRAM Data (Latched) ^{1,2}	32-bit	AD[31:0] Even latch I/Os B side '0' LEE OEE* OEB ³	Even latch I/Os A side Even bank data pins Even latch CLKAB and CLKBA Even latch LEAB and LEBA Even latch OEBA* Even latch OEAB
DRAM Data (No Latch) ^{1,2}	32-bit	AD[31:0]	Even bank data pins

Notes:

1. Example shows even bank choice, but odd bank can be selected instead.
2. Regardless of endianness,
 - ECAS[0]* always corresponds to SysAD[7:0], and AD[7:0].
 - ECAS[1]* always corresponds to SysAD[15:8], and AD[15:8].
 - ECAS[2]* always corresponds to SysAD[23:16], and AD[23:16].
 - ECAS[3]* always corresponds to SysAD[31:24], and AD[31:24].
3. Be careful if OEB is programmed at reset to have reverse polarity.
4. Signals can be optionally buffered for load balancing.

11.2.3 64-bit Devices

Connection	Memory Width	Connect...	To...
Device Address ¹	64-bit	DAdr[2:0] DAdr[2:0] Even latch outputs Odd latch outputs LEAdrE LEAdrO {dev_adr[21:2], BAdrE[2:1]} ⁴ {dev_adr[21:2], BAdrO[2:1]} ⁴	Even latch inputs Odd latch inputs Become burst address even (BAdrE[2:0]) Become burst address odd (BAdrO[2:0]) Even latch LE Odd latch LE Even bank address pins Odd bank address pins
Device Address ²	64-bit	DAdr[2:0] Odd latch outputs LEAdrO {dev_adr[21:2], DAdr[2:1]} ⁴ {dev_adr[21:2], BAdrO[2:1]} ⁴	Odd latch inputs Become burst address odd (BAdrO[2:0]) Odd latch LE Even bank address pins Odd bank address pins
Device Address ³	64-bit	DAdr[2:0] Even latch outputs LEAdrO {dev_adr[21:2], BAdrE[2:1]} ⁴ {dev_adr[21:2], DAdr[2:1]} ⁴	Even latch inputs Become burst address even (BAdrE[2:0]) Even latch LE Even bank address pins Odd bank address pins
Device Data (Latched) ⁶	64-bit	AD[31:0] Even latch I/Os B side '0' LEE OEE* OEB ⁵ AD[31:0] Odd latch I/Os B side '0' LEO OEO* OEB ⁵	Even latch I/Os A side Even bank data pins Even latch CLKAB and CLKBA Even latch LEAB and LEBA Even latch OEBA* Even latch OEAB Odd latch I/Os A side Odd bank data pins Odd latch CLKAB and CLKBA Odd latch LEAB and LEBA Odd latch OEBA* Odd latch OEAB
Device Control	64-bit	AD[31:0] ALE Control latch bit[0] output Control latch bit[1] output Control latch bit[23:2] outputs Control latch bit[27:24] outputs Control latch bit[31:28] outputs	Control latch inputs Control latch LE Becomes BootCS* Becomes DevRW* Becomes dev_adr [21:0] Becomes DMAAck[3:0]* Becomes CS[3:0]*

Notes:

1. System supports decrement.
2. System is little endian without decrement.
3. System is big endian without decrement.
4. dev_adr[21:0] is the output of the latch connected to AD[23:2], sampled by ALE.
5. Be careful if OEB is programmed at reset to have reverse polarity.
6. Regardless of endianness,
 - ECAS[0]* and OCAS[0]* always corresponds to SysAD[7:0] and AD[7:0].
 - ECAS[1]* and OCAS[1]* always corresponds to SysAD[15:8] and AD[15:8].
 - ECAS[2]* and OCAS[2]* always corresponds to SysAD[23:16] and AD[23:16].
 - ECAS[3]* and OCAS[3]* always corresponds to SysAD[31:24] and AD[31:24].

11.2.4 32-bit or Less Devices

It is optional to have one bi-directional buffer.

Connection	Memory Width	Connect...	To...
Device Address ²	32-bit 16-bit 8-bit	{dev_adr[21:2], DAdr[2:0]} {dev_adr[21:0], DAdr[2:1]} {dev_adr[21:0], DAdr[2:0]}	Device address pins Device address pins Device address pins
Device Data (Latched) ^{3,4}	32-bit or less	AD[31:0] or [15:0] or [7:0] Even latch I/Os B side '0' LEE OEE* OEB ⁵	Even latch I/Os A side Even bank data pins Even latch CLKAB and CLKBA Even latch LEAB and LEBA Even latch OEBA* Even latch OEAB
Device Data (No Latch)	32-bit or less	AD[31:0] or [15:0] or [7:0]	Device data pins
Device Control	32-bit or less	AD[31:0] ALE Control latch bit[0] output Control latch bit[1] output Control latch bit[23:2] outputs Control latch bit[27:24] outputs Control latch bit[31:28] outputs	Control latch inputs Control latch LE Becomes BootCS* Becomes DevRW* Becomes dev_adr [21:0] Becomes DMAAck[3:0]* Becomes CS[3:0]*

Notes:

1. Example shows even bank choice, but odd bank can be selected instead.
2. dev_adr[21:0] is the output of the latch connected to AD[23:2], sampled by ALE
3. Bidirectional latch is optional for buffering, and either odd or even bank can be chosen. This example shows an even bank connection.
4. Regardless of endianness,
 - EW[r]0* always corresponds to SysAD[7:0] and AD[7:0] regardless of endianness.
 - EW[r]1* always corresponds to SysAD[15:8] and AD[15:8] regardless of endianness.
 - EW[r]2* always corresponds to SysAD[23:16] and AD[23:16] regardless of endianness.
 - EW[r]3* always corresponds to SysAD[31:24] and AD[31:24] regardless of endianness.
5. Be careful if OEB is programmed at reset to have reverse polarity.

12. Big and Little Endian

12.1 Background

There are two bits in the GT-64111 which control byte swapping. One is located in the CPU/Local Master Interface Configuration Register (0x000) bit 12. The other is in PCI Internal Command register (0xc00) bit 0. Both bits are given the same value as sampled at Rst* via pullup/pulldown on Interrupt* pin. Both can be otherwise programmed after reset is de-asserted. As a master rule, if both bits are set to '1', the GT-64111 assumes Little-endian data format and NO byte swapping is done within the device. The nomenclature for this section is shown in Table 25.

TABLE 25. Nomenclature

Name	Definition
W, Word	32-bits of data, R4600 terminology.
DW, Double Word	64-bits of data, R4600 terminology.
Even Address	Address of which A[2] == 0. In Little-endian format this address points to the LEAST significant W of a DW. In Big-endian format this address points to the MOST significant W of a DW.
Odd Address	Address of which A[2] == 1. In Little-endian format this address points to the MOST significant W of a DW. In Big-endian format this address points to the LEAST significant W of a DW.
Even Word	LEAST significant W of a DW.
Odd Word	MOST significant W of a DW.

12.1.1 Bit 12 of the CPU/Local Master Interface Configuration register

Bit 12 of the CPU/Local Master Interface Configuration register (0x000) affects the following:

- Set to '1' (Little-endian mode): No byte swapping within the CPU/Local Master Interface unit on any data transfer
- Set to '0' (Big-endian mode): Byte swapping of data transfers to/from GT-64111 internal registers (including Configuration Data register, 0xcfc). No byte swapping of data transfers of which the source/target is external.

12.1.2 Bit 0 of the PCI Internal Command register

Bit 0 of the PCI Internal Command register (0xc00) affects the following:

- Set to '1' (No byte swapping): No byte swapping within the PCI Interface unit of any data transfer.
- Set to '0' (Byte swapping): No byte swapping of data transfers to/from PCI Interface unit's internal registers. Byte swapping of data transfers of which the source/target is external

12.2 Configuring a System for Big and Little Endian

Table 26 shows all combinations of the resources and swapping bits with sample data.

- CPU/Local Master bit = Bit 12 of the CPU/Local Master Interface Configuration register (0x000).
- PCI bit = Bit 0 of the PCI Internal Command register (0xc00).

The sample data is 0x04030201.

TABLE 26. Configuring for Big and Little Endian

Resource	Swap Bits (CPU/Local Master bit:PCI bit)			
	11	00	01	10
Internal Registers (CPU/Local Master access)	04030201	01020304	01020304	04030201
Internal Registers (PCI access)	04030201	04030201	04030201	04030201
Internal PCI Configuration Registers (CPU/Local Master access)	04030201	01020304	01020304	04030201
Internal PCI Configuration Registers (PCI access)	04030201	04030201	04030201	04030201
External PCI Configuration Registers	04030201	04030201	01020304	01020304
Memory (DRAM and Devices) (CPU/Local Master access)	04030201	04030201	04030201	04030201
Memory (DRAM and Devices) (PCI access)	04030201	01020304	04030201	01020304
CPU/Local Master to PCI (Except external PCI Configuration Registers)	04030201	01020304	04030201	01020304

13. Using the GT-64111 Without the CPU/Local Master Interface

Table 27 lists the pins that must be strapped when the GT-64111 is used without the CPU/Local Master interface (i.e. PCI Memory Controller only). Please note that Rst* and TCik must always be connected. Each pin must be strapped with a separate resistor unless otherwise noted.

TABLE 27. CPU-less Pin Strapping

Pin	Strapping ¹
ValidOut*	Pulled up to Vdd through a resistor
Release*	Pulled up to Vdd through a resistor
SysAD[31:0] ²	Pulled up to Vdd through a resistor
SysCmd[8:0] ³	Pulled up to Vdd through a resistor
ValidIn*	No Connect
WrRdy*	No Connect
Interrupt*	Sampled at Rst*, See Reset Section.

1. Galileo recommends using 4.7KOhm resistors.

2. SysAD[31:0] can be pulled up through a single resistor instead of 32 separate resistors.

3. SysCmd[8:0] can be pulled up through a single resistor instead of 9 separate resistors.

14. Using the GT-64111 Without the PCI Interface

Table 28 lists the pins that must be strapped when the GT-64111 is used with the PCI interface. Please note that Rst* must always be connected. Each pin must be strapped with a separate resistor.

TABLE 28. PCI-less Pin Strapping

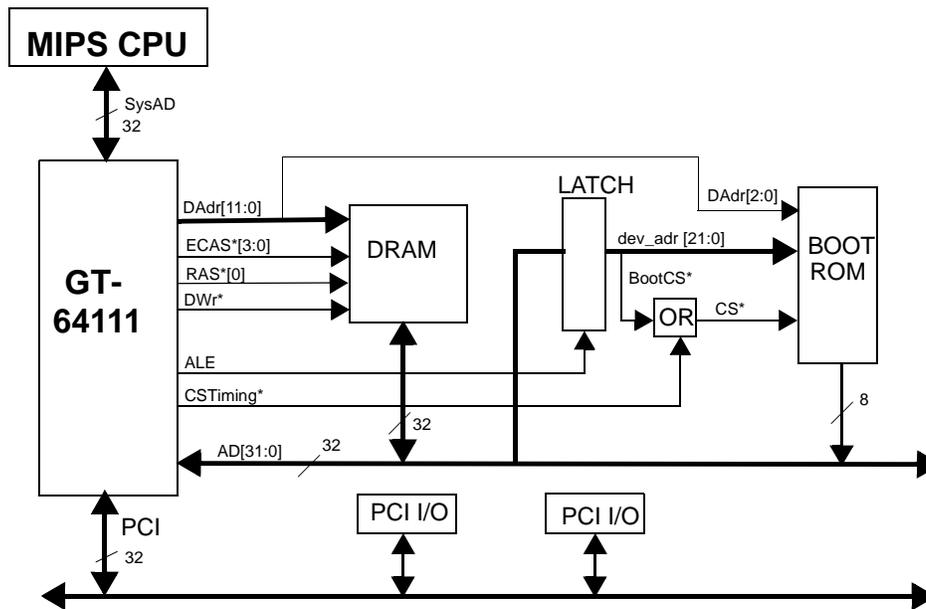
Pin	Strapping ¹
PCik	Pulled up to Vdd through a resistor
DevSel*	Pulled up to Vdd through a resistor
Stop*	Pulled up to Vdd through a resistor
Par	No Connect
PErr*	Pulled up to Vdd through a resistor
Frame*	Pulled up to Vdd through a resistor
IRdy*	Pulled up to Vdd through a resistor
TRdy*	Pulled up to Vdd through a resistor
Gnt*	Pulled down to GND through a resistor
IdSel*	Pulled down to GND through a resistor
SErr*	No Connect
Req*	No Connect
Int*	No Connect
AD[31:0]	No Connect
CBE*[3:0]	No Connect

1. Galileo recommends using 4.7KOhm resistors.

15. APPLICATIONS: SYSTEM CONFIGURATIONS

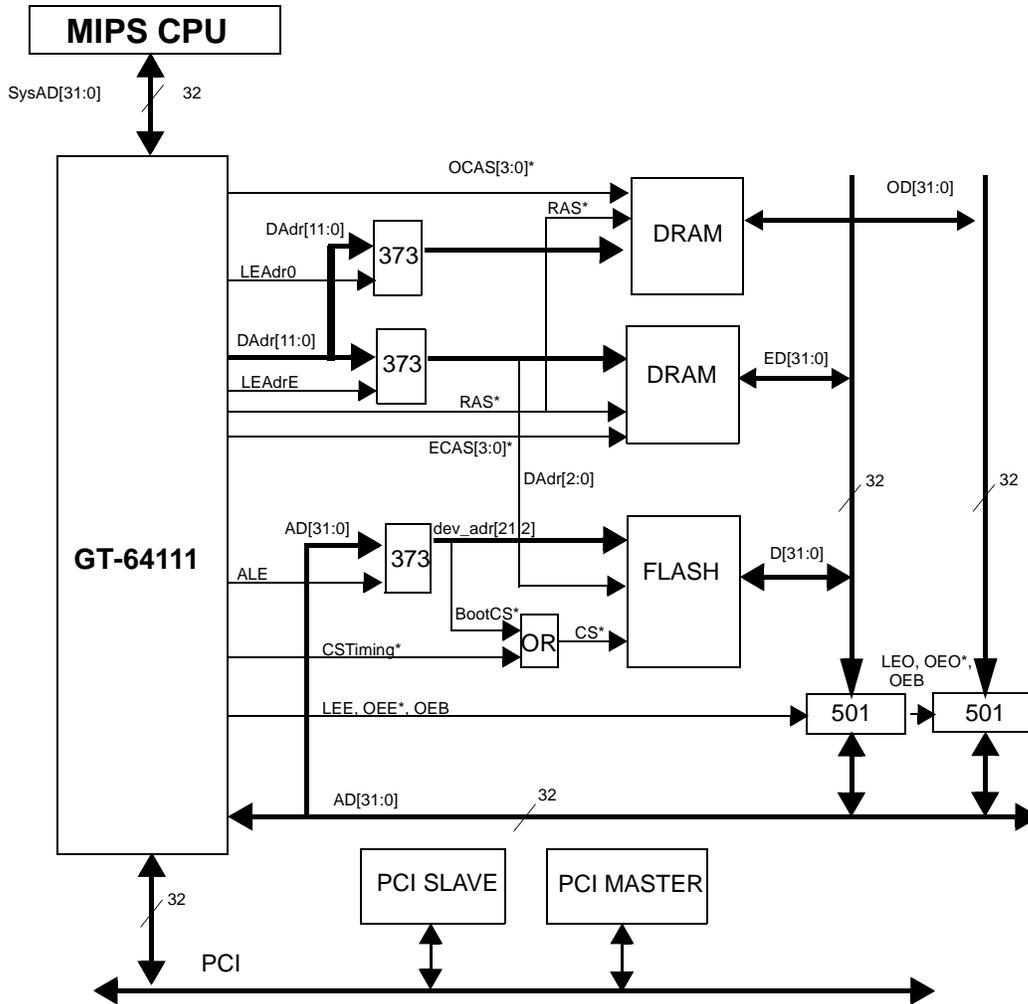
15.1 Minimal System Configuration

A minimal system configuration is shown below. It includes an 8-bit wide boot ROM, a 32-bit wide DRAM, and a PCI interface to industry standard I/O devices. This configuration can be appealing to applications that need high performance and are limited to a minimal board space.



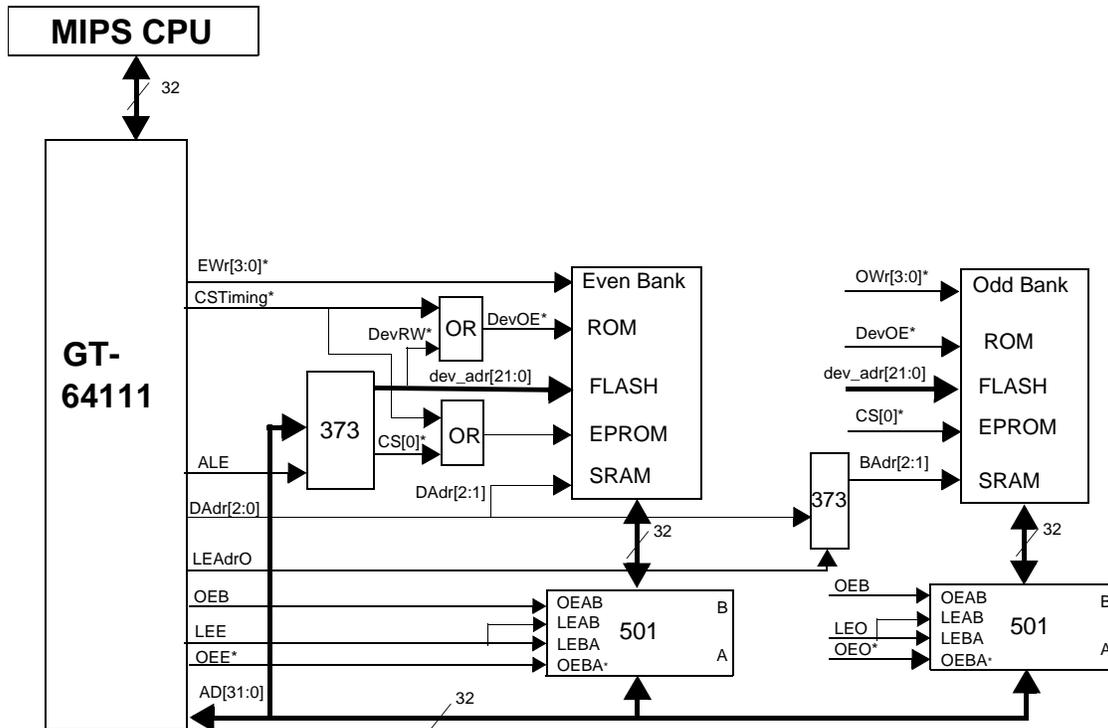
15.2 Typical System

The high performance system shown below includes 64-bit wide memories and 32-bit I/O devices on the PCI bus. The system includes Flash for storing code and data, and DRAM as main memory. In this system data can be moved via DMA or PCI master accesses between the PCI bus and the Flash or DRAM at full bus bandwidth, at 200 Mbytes per second. The CPU/Local Master can read from the DRAM at peak bandwidth of 264Mbytes per second. CPU/Local Master writes have peak bandwidth of 264Mbytes per second for all devices through the GT-64111 on-chip write buffer.



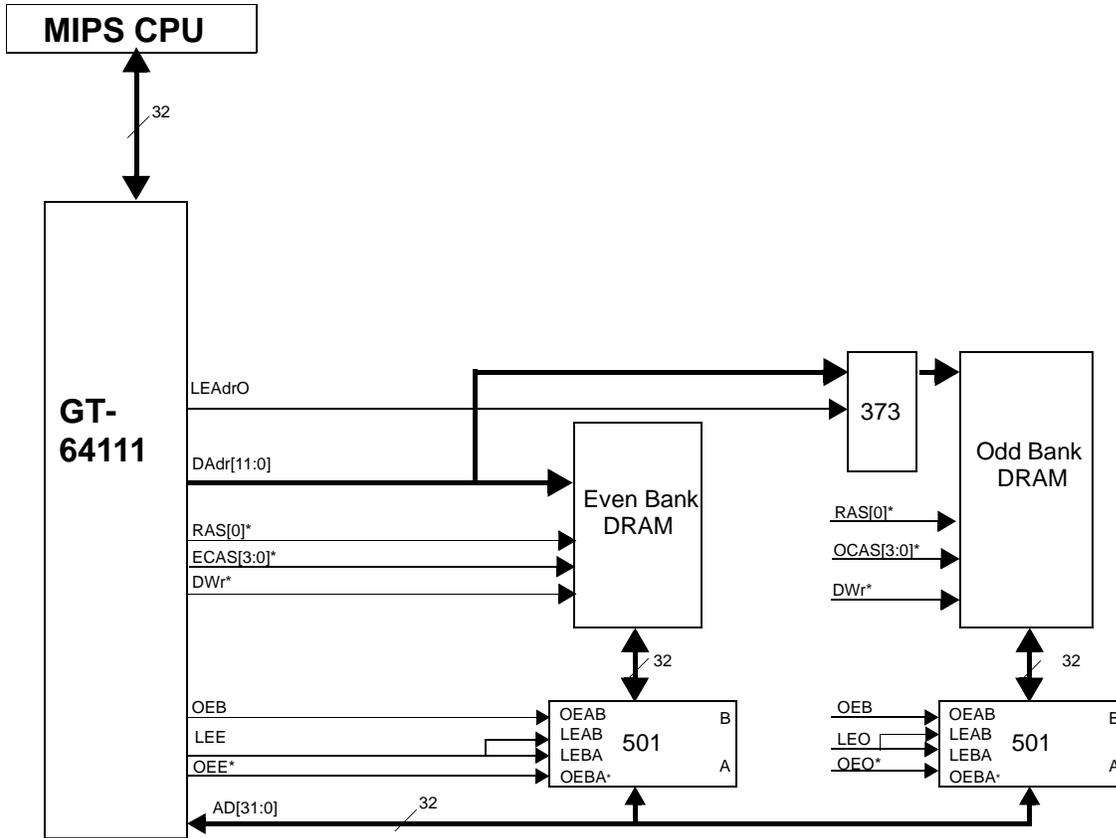
15.3 Interface to Asynchronous Devices

In this case, we show the connectivity between the GT-64111 and 64 bit-wide standard memory devices (e.g. SRAM). In this example the latches selected are industry standard FCT16501 for data, FCT16373 for the address, and FCT16373 for the burst address for the odd bank. The data latches that interface to the AD bus are used to interleave the data in read and write access from the GT-64111 and enable data rate of one data per cycle at 66MHz (200 Mbytes per second peak rate). FCT16373 logic chips are used to latch the address, the CS* and the DevRW* for the Devices. The latch for the odd bank burst address is needed for the address interleaving. This system configuration is for little endian, no decrement.



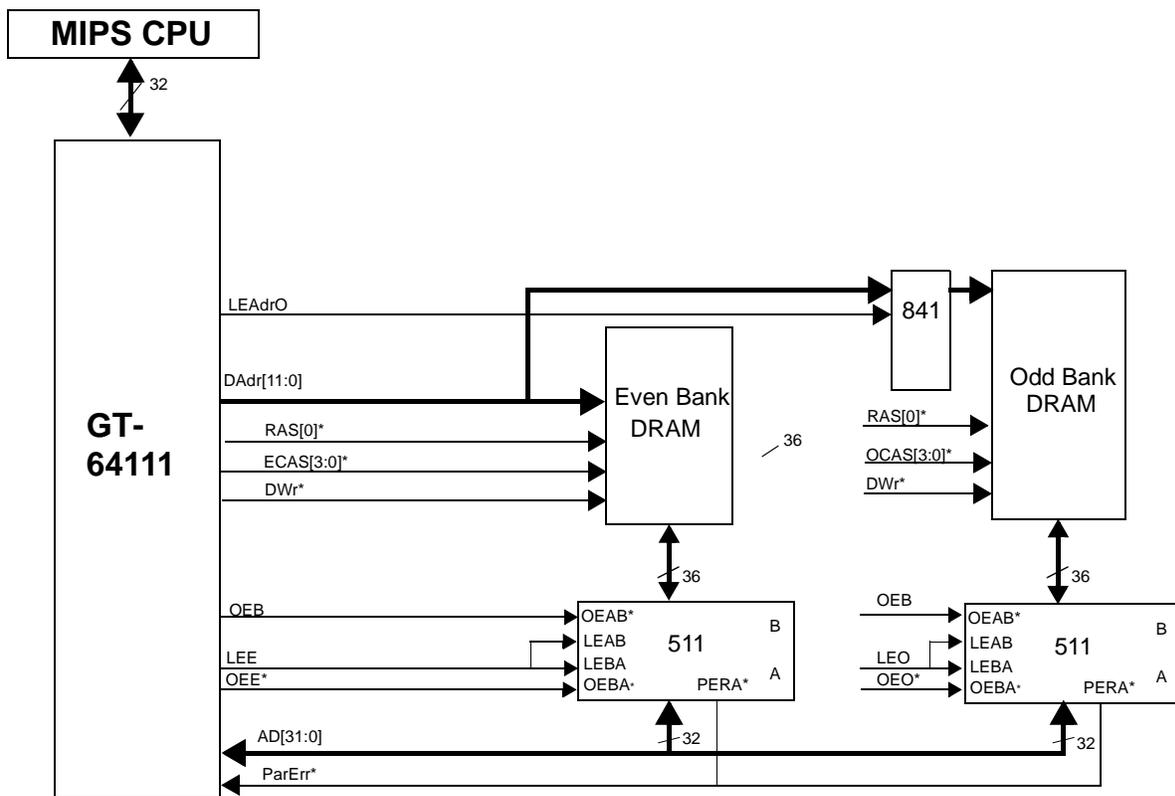
15.4 Interface to DRAM

The DRAM and the device interface in a typical system share the same data latches and address latches. In this example the DRAM is 64-bit wide and the even and odd banks share the same RAS[0]* pin. Address for the odd bank is driven from an FCT16373 latch which is controlled by LEAdrO. The data latches used in this example are FCT16501 to the AD bus. This system configuration is for little endian, no decrement.



15.5 A System With Parity

In this case, the FCT16511 is used to generate parity for all the write accesses to the devices and the DRAM. In a CPU/Local Master read access the FCT16511 will check parity and will assert the ParErr* signal when an error is detected. The GT-64111 will indicate to the CPU/Local Master that the returned data is erroneous via SysCmd[5] and will interrupt the CPU/Local Master if the bank that the CPU/Local Master read from was programmed to have parity integrity checks. The GT-64111 also asserts SysCmd[4] to indicate to the CPU/Local Master if the read access was from an address with parity integrity so that the CPU/Local Master will check parity internally as well. In PCI read accesses, an active ParErr* to a bank that has parity integrity, will cause an assertion of PErr* on the PCI. Notice that with the FCT16511 the OEAB* polarity is active low, as opposed to the FCT16501, and thus OEB from the GT-64111 should be programmed accordingly at reset. This system configuration is for little endian, no decrement.



16. Designing for Compatibility with the GT-64011

The GT-64111 is nearly drop-in compatible with the GT-64011 device. With careful hardware and software design it is possible to design a system that can accept both devices. This section highlights the differences between the two chips, and explains how to design to handle these differences.

16.1 Major Hardware Differences Between the GT-64011 and GT-64111

The only major differences between the two devices are:

- **The GT-64111 requires a Vcc of 3.3V; the GT-64011 is a 5V part.** You will need to design your board to deliver the proper voltage to the supply plane depending on which device is installed. Zero-ohm resistors are a good way to do this.
- **The Vref pin on the GT-64011 is replaced by Vio on the GT-64111.** The GT-64011 used Vref to set the CPU interface voltage to either 3.3V or 5V depending on the voltage sampled on the pin. The GT-64111 uses this pin to set the PCI voltage to either 3.3V or 5V; the CPU interface voltage is always 3.3V on the GT-64111. Your system may need a jumper or zero-ohm resistor to account for this change.
- **Pin 15 is a Vss on the GT-64011; it is 66MHz PCI Compatible Enable on the GT-64111.** If your system does not need the 66MHz Compatibility bit set then tie this to Vss directly. If you need to be able to upgrade from a GT-64011 and want to be able to advertise (in configuration space) 66MHz capability, then tie this pin to a jumper that can be Vss or Vcc. In any case, the PCI bus will still run at 66MHz.

16.2 All Differences Between the GT-64011 and GT-64111

Table 29, below, outlines all differences between the GT-64011 and GT-64111 and include comments on their potential system implications.

TABLE 29. Differences Between the GT-64011 and GT-64111

Function	GT-64011	GT-64111	Comment on Compatibility
Vcc	5V	3.3V	Board must have the capability of supplying either 5V or 3.3V to Vcc.
Pin 80	Vref	Vio	You may need a jumper to connect this pin to Vref for GT-64011 designs; Vio for GT-64111 designs.
Pin 15	Vss	66MHz Capability Enable	You may need a jumper to enable the "advertisement" of 66MHz capability in the PCI header (see above). This pin does not affect the actual speed of the PCI interface.
PCI Bus Frequency	33MHz	66MHz	No issues other than the 66MHz Capability bit.
4300 Bus Mode Support	None	Yes	ValidOut* pulled-up to Vdd through a 4.7KOhm resistor.
Linear Burst Address Support	None	Enabled through bit 9 of register 0x454	There should be no issues as long as your software does not set reserved bit in registers (especially 0x454).
Default Class Code	0x0600	0x0580	There may be issues with drivers written for class code 0x0600. The class code in the GT-64111 can be overwritten by software if this is the case.
ReVID	0x01	0x10	There should be no issues as long as your software/drivers account for the fact that ReVIDs change with silicon stepping.

Function	GT-64011	GT-64111	Comment on Compatibility
Base Address Enable Register RESET state	Enabled	Most disabled	Your software may need to manually enable the less often used BARs that are now disabled by default. (This change was made for PC add-in cards without boot ROMs.)
Prefetch bit in Memory BARs	Read/Write	Hardwired to "1"	No issues.
Errata fixes		All known errata corrected.	Please check your GT-64011 for workarounds that may no longer be necessary.

17. REGISTER TABLES

The GT-64111's internal registers can be accessed by the CPU/Local Master or from the PCI bus. They are memory-mapped for the CPU/Local Master and memory- or I/O-mapped for the PCI. The registers' address is comprised of the value in the "Internal Space Decode" register and the register offset. The value in the "Internal Space Decode" register [10:0] is matched against bits [31:21] of the actual address; therefore, this value should be the actual address bits [31:21] shifted right once.

For example, to access "Channel 0 DMA Byte Count" register (offset 0x800) immediately after Reset*, the full address will be the default value in the "Internal Space Decode" register which is 0x0a0 shifted left once, which gives 0x140, two zero's and the offset 0x800, to become a 32-bit address of 0x14000800. The location of the registers in the memory space can be changed by changing the value programmed into the "Internal Space Decode" register. For example after changing the value in the "Internal Space Decode" register by writing to 0x14000068 a value of "0bd", an access to the "Channel 0 DMA Byte Count" register will be with 0x17a00800.

Detailed information about setting the registers is contained in their respective sections of this data sheet.

17.1 Access to On-Chip PCI Configuration Space Registers

An access to a PCI configuration register is performed differently than accesses to all other registers. The access is performed indirectly by writing the PCI configuration register offset into the Configuration Address register and then reading or writing the data from/to the Configuration Data register.

For example, to read data from the Status and Command register, the register offset "0x004" is written into the Configuration Address register, offset 0xcfc8 (or full address from the previous example 0xbd000cfc8). Then, reading from the Configuration Data register (offset 0xcfc), will return the data of the Status and Command register.

17.2 Register Map

Description	Offset
CPU/Local Master Interface	
CPU/Local Master Interface Configuration	0x000
Processor Address Space	
RAS[1:0] Low Decode Address	0x008
RAS[1:0] High Decode Address	0x010
RAS[3:2] Low Decode Address	0x018
RAS[3:2] High Decode Address	0x020
CS[2:0] Low Decode Address	0x028
CS[2:0] High Decode Address	0x030
CS[3] & Boot CS Low Decode Address	0x038
CS[3] & Boot CS High Decode Address	0x040
PCI I/O Low Decode Address	0x048
PCI I/O High Decode Address	0x050
PCI Memory 0 Low Decode Address	0x058
PCI Memory 0 High Decode Address	0x060
Internal Space Decode	0x068

Bus Error Address Low Processor	0x070
Read Only '0'	0x078
PCI Memory 1 Low Decode Address	0x080
PCI Memory 1 High Decode Address	0x088
DRAM and Device Address Space	
RAS[0] Low Decode Address	0x400
RAS[0] High Decode Address	0x404
RAS[1] Low Decode Address	0x408
RAS[1] High Decode Address	0x40c
RAS[2] Low Decode Address	0x410
RAS[2] High Decode Address	0x414
RAS[3] Low Decode Address	0x418
RAS[3] High Decode Address	0x41c
CS[0] Low Decode Address	0x420
CS[0] High Decode Address	0x424
CS[1] Low Decode Address	0x428
CS[1] High Decode Address	0x42c
CS[2] Low Decode Address	0x430
CS[2] High Decode Address	0x434
CS[3] Low Decode Address	0x438
CS[3] High Decode Address	0x43c
Boot CS Low Decode Address	0x440
Boot CS High Decode Address	0x444
Address Decode Error	0x470
DRAM Configuration	
DRAM Configuration	0x448
DRAM Parameters	
DRAM Bank0 Parameters	0x44c
DRAM Bank1 Parameters	0x450
DRAM Bank2 Parameters	0x454
DRAM Bank3 Parameters	0x458
Device Parameters	

Device Bank0 Parameters	0x45c
Device Bank1 Parameters	0x460
Device Bank2 Parameters	0x464
Device Bank3 Parameters	0x468
Device Boot Bank Parameters	0x46c
DMA Record	
Channel 0 DMA Byte Count	0x800
Channel 1 DMA Byte Count	0x804
Channel 2 DMA Byte Count	0x808
Channel 3 DMA Byte Count	0x80c
Channel 0 DMA Source Address	0x810
Channel 1 DMA Source Address	0x814
Channel 2 DMA Source Address	0x818
Channel 3 DMA Source Address	0x81c
Channel 0 DMA Destination Address	0x820
Channel 1 DMA Destination Address	0x824
Channel 2 DMA Destination Address	0x828
Channel 3 DMA Destination Address	0x82c
Channel 0 Next Record Pointer	0x830
Channel 1 Next Record Pointer	0x834
Channel 2 Next Record Pointer	0x838
Channel 3 Next Record Pointer	0x83c
DMA Channel Control	
Channel 0 Control	0x840
Channel 1 Control	0x844
Channel 2 Control	0x848
Channel 3 Control	0x84c
DMA Arbiter	
Arbiter Control	0x860
Timer/Counter	
Timer /Counter 0	0x850
Timer /Counter 1	0x854
Timer /Counter 2	0x858

Timer /Counter 3	0x85c
Timer /Counter Control	0x864
PCI Internal	
Command	0xc00
Time Out & Retry	0xc04
RAS[1:0] Bank Size	0xc08
RAS[3:2] Bank Size	0xc0c
CS[2:0] Bank Size	0xc10
CS[3] & Boot CS Bank Size	0xc14
SErr Mask	0xc28
Interrupt Acknowledge	0xc34
Base Address Registers' Enable	0xc3c
Configuration Address	0xcf8
Configuration Data	0xcfc
Interrupts	
Interrupt Cause	0xc18
CPU/Local Master Mask	0xc1c
PCI Mask	0xc24
PCI Configuration	
Device and Vendor ID	0x000
Status and Command	0x004
Class Code and Revision ID	0x008
BIST, Header Type, Latency Timer, Cache Line	0x00c
RAS[1:0] Base Address	0x010
RAS[3:2] Base Address	0x014
Subsystem Device and Vendor ID	0x02c
CS[2:0] Base Address	0x018
CS[3] & Boot CS Base Address	0x01c
Internal Registers Memory Mapped Base Address	0x020
Internal Registers I/O Mapped Base Address	0x024
Expansion ROM Base Address Register	0x030
Interrupt Pin and Line	0x03c
PCI Configuration, Function 1	

RAS[1:0] Swapped Base Address	0x010
CAS[3:2] Swapped Base Address	0x014
CS[3] and Boot CS Swapped Base Address and Expansion ROM Base	0x01c

17.3 CPU/Local Master Interface

CPU/Local Master Interface Configuration, Offset: 0x000

Bits	Field name	Function	Initial Value
10:0	Reserved	Read Only '0'.	0x0
11	WriteMode	Write mode. 0 - Pipelined writes mode 1 - R4000 mode (2 dead-cycles minimum between consecutive address-phases)	0x0
12	Endianess	Byte Orientation. 0 - Big Endian 1 - Little Endian	Sampled at Rst* via the Interrupt* pin
31:13	Reserved		0x0

17.4 CPU/Local Master Decode

RAS[1:0] Low Decode Address, Offset: 0x008

Bits	Field Name	Function	Initial Value
10:0	Low	DRAM banks 1 and 0 will be accessed when the decoded addresses are between Low and High.	0x000
31:11	Reserved		0x0

RAS[1:0] High Decode Address, Offset: 0x010

Bits	Field Name	Function	Initial Value
6:0	High	DRAM banks 1 and 0 will be accessed when the decoded addresses are between Low and High.	0x07
31:7	Reserved		0x0

RAS[3:2] Low Decode Address, Offset: 0x018

Bits	Field Name	Function	Initial Value
10:0	Low	DRAM banks 3 and 2 will be accessed when the decoded addresses are between Low and High.	0x008
31:11	Reserved		0x0

RAS[3:2] High Decode Address, Offset: 0x020

Bits	Field Name	Function	Initial Value
6:0	High	DRAM banks 3 and 2 will be accessed when the decoded addresses are between Low and High.	0x0f
31:7	Reserved		0x0

CS[2:0] Low Decode Address, Offset: 0x028

Bits	Field Name	Function	Initial Value
10:0	Low	Device banks 2, 1 and 0 will be accessed when the decoded addresses are between Low and High.	0x0e0
31:11	Reserved		0x0

CS[2:0] High Decode Address, Offset: 0x030

Bits	Field Name	Function	Initial Value
6:0	High	Device banks 2, 1 and 0 will be accessed when the decoded addresses are between Low and High.	0x70
31:7	Reserved		0x0

CS[3] & Boot CS Low Decode Address, Offset: 0x038

Bits	Field Name	Function	Initial Value
10:0	Low	Device bank 3 and the boot bank will be accessed when the decoded addresses are between Low and High.	0x0f8
31:11	Reserved		0x0

CS[3] & Boot CS High Decode Address, Offset: 0x040

Bits	Field Name	Function	Initial Value
6:0	High	Device bank 3 and the boot bank will be accessed when the decoded addresses are between Low and High.	0x7f
31:7	Reserved		0x0

PCI I/O Low Decode Address, Offset: 0x048

Bits	Field Name	Function	Initial Value
10:0	Low	The PCI I/O address space will be accessed when the decoded addresses are between Low and High.	0x080
31:11	Reserved		0x0

PCI I/O High Decode Address, Offset: 0x050

Bits	Field Name	Function	Initial Value
6:0	High	The PCI I/O address space will be accessed when the decoded addresses are between Low and High.	0x0f
31:7	Reserved		0x0

PCI Memory 0 Low Decode Address, Offset: 0x058

Bits	Field Name	Function	Initial Value
10:0	Low	The PCI memory 0 address space will be accessed when the decoded addresses are between Low and High.	0x090
31:11	Reserved		0x0

PCI Memory 0 High Decode Address, Offset: 0x060

Bits	Field Name	Function	Initial Value
6:0	High	The PCI memory 0 address space will be accessed when the decoded addresses are between Low and High.	0x1f
31:7	Reserved		0x0

Internal Space Decode, Offset: 0x068

Bits	Field Name	Function	Initial Value
10:0	IntDecode	Registers inside the GT-64111 will be accessed when MasAD bits 31:21 match the value programmed in bits 10:0.	0x0a0
31:11	Reserved		0x0

Bus Error Address Processor, Offset: 0x070

Bits	Field Name	Function	Initial Value
31:0	llegLoAdd	This register captures bits 31:0 of an illegal 32-bit address.	0x00000000

Reserved, Offset: 0x078

Bits	Field Name	Function	Initial Value
31:0	Reserved	Read Only '0'.	0x0

PCI Memory 1 Low Decode Address, Offset: 0x080

Bits	Field Name	Function	Initial Value
10:0	Low	The PCI memory address space will be accessed when the decoded addresses are between Low and High.	0x790
31:11	Reserved		0x0

PCI Memory 1 High Decode Address, Offset: 0x088

Bits	Field Name	Function	Initial Value
6:0	High	The PCI memory address space will be accessed when the decoded addresses are between Low and High.	0x1f
31:7	Reserved		0x0

17.5 Device Decode

RAS[0] Low Decode Address, Offset: 0x400

Bits	Field Name	Function	Initial Value
7:0	Low	DRAM bank 0 will be accessed when the decoded addresses are between Low and High.	0x00
31:8	Reserved		0x0

RAS[0] High Decode Address, Offset: 0x404

Bits	Field Name	Function	Initial Value
7:0	High	DRAM bank 0 will be accessed when the decoded addresses are between Low and High.	0x07
31:8	Reserved		0x0

RAS[1] Low Decode Address, Offset: 0x408

Bits	Field Name	Function	Initial Value
7:0	Low	DRAM bank 1 will be accessed when the decoded addresses are between Low and High.	0x08
31:8	Reserved		0x0

RAS[1] High Decode Address, Offset: 0x40c

Bits	Field Name	Function	Initial Value
7:0	High	DRAM bank 1 will be accessed when the decoded addresses are between Low and High.	0x0f
31:8	Reserved		0x0

RAS[2] Low Decode Address, Offset: 0x410

Bits	Field Name	Function	Initial Value
7:0	Low	DRAM bank 2 will be accessed when the decoded addresses are between Low and High.	0x10
31:8	Reserved		0x0

RAS[2] High Decode Address, Offset: 0x414

Bits	Field Name	Function	Initial Value
7:0	High	DRAM bank 2 will be accessed when the decoded addresses are between Low and High.	0x17
31:8	Reserved		0x0

RAS[3] Low Decode Address, Offset: 0x418

Bits	Field Name	Function	Initial Value
7:0	Low	DRAM bank 3 will be accessed when the decoded addresses are between Low and High.	0x18
31:8	Reserved		0x0

RAS[3] High Decode Address, Offset: 0x41c

Bits	Field Name	Function	Initial Value
7:0	High	DRAM bank 3 will be accessed when the decoded addresses are between Low and High.	0x1f
31:8	Reserved		0x0

CS[0] Low Decode Address, Offset: 0x420

Bits	Field Name	Function	Initial Value
7:0	Low	Device bank 0 will be accessed when the decoded addresses are between Low and High.	0xc0
31:8	Reserved		0x0

CS[0] High Decode Address, Offset: 0x424

Bits	Field Name	Function	Initial Value
7:0	High	Device bank 0 will be accessed when the decoded addresses are between Low and High.	0xc7
31:8	Reserved		0x0

CS[1] Low Decode Address, Offset: 0x428

Bits	Field Name	Function	Initial Value
7:0	Low	Device bank 1 will be accessed when the decoded addresses are between Low and High.	0xc8
31:8	Reserved		0x0

CS[1] High Decode Address, Offset: 0x42c

Bits	Field Name	Function	Initial Value
7:0	High	Device bank 1 will be accessed when the decoded addresses are between Low and High.	0xcf
31:8	Reserved		0x0

CS[2] Low Decode Address, Offset: 0x430

Bits	Field Name	Function	Initial Value
7:0	Low	Device bank 2 will be accessed when the decoded addresses are between Low and High.	0xd0
31:8	Reserved		0x0

CS[2] High Decode Address, Offset: 0x434

Bits	Field Name	Function	Initial Value
7:0	High	Device bank 2 will be accessed when the decoded addresses are between Low and High.	0xdf
31:8	Reserved		0x0

CS[3] Low Decode Address, Offset: 0x438

Bits	Field Name	Function	Initial Value
7:0	Low	Device bank 3 will be accessed when the decoded addresses are between Low and High.	0xf0
31:8	Reserved		0x0

CS[3] High Decode Address, Offset: 0x43c

Bits	Field Name	Function	Initial Value
7:0	High	Device bank 3 will be accessed when the decoded addresses are between Low and High.	0xfb
31:8	Reserved		0x0

Boot CS Low Decode Address, Offset: 0x440

Bits	Field Name	Function	Initial Value
7:0	Low	Boot bank will be accessed when the decoded addresses are between Low and High.	0xfc
31:8	Reserved		0x0

Boot CS High Decode Address, Offset: 0x444

Bits	Field Name	Function	Initial Value
7:0	High	Boot bank will be accessed when the decoded addresses are between Low and High.	0xff
31:8	Reserved		0x0

Address Decode Error, Offset: 0x470

Bits	Field Name	Function	Initial Value
31:0	ErrAddr	The addresses of accesses to invalid address ranges (those not in the range programmed in the DRAM or device decode registers) will be captured in this register.	Undefined Value

17.6 DRAM Configuration

DRAM Configuration, Offset: 0x448

Bits	Field name	Function	Initial Value
13:0	RefIntCnt	Refresh interval count value.	0x0200
15:14	Reserved	When written, this bits can be safely programmed to any value. When read, these bits will respond with an undefined value.	N/A
16	StagRef	Staggered refresh. 0 - Staggered refresh 1- All banks are refreshed together	0x0
17	ADSFunct	Defines the function of the DAdr[11]/ADS* pin. 0 - DAdr11 only 1 - ADS* only	0x0
18	DRAMLatch	Sets the latch operation mode. 0 -The latch control signals are active. 1 - The external data latches are transparent in DRAM accesses when CAS is programmed to be one cycle long	0x0
31:19	Reserved	When written, these bits can be safely programmed to any value. When read, these bits will respond with an undefined value.	N/A

17.7 DRAM Parameters

DRAM Bank0 Parameters, Offset: 0x44c

Bits	Field name	Function	Initial Value
0	CASWr	The number of cycles CAS* is LOW in a write access. 0 - One cycle 1 - Two cycles	0x1
1	RASToCASWr	The number of cycles between RAS* going active and CAS* going active in a write access. 0 - Two cycles 1 - Three cycles	0x1

Bits	Field name	Function	Initial Value
2	CASRd	The number of cycles CAS* is LOW in a read access. 0 - One cycle 1 - Two cycles	0x1
3	RAStoCASRd	The number of cycles between RAS* going active and CAS* going active in a read access. 0 - Two cycles 1 - Three cycles	0x1
5:4	Refresh	DRAM type support. 00 - 1/2K Refresh (9 bits row, 9 to 12 bits column) 01 - 1K Refresh (10 bits row, 9 to 12 bits column) 10 - 2K Refresh (11 bits row, 9 to 12 bits column) 11 - 4K Refresh (12 bits row, 9 to 12 bits column)	0x0
6	BankWidth	Width of DRAM bank. 0- 32 (36) bit wide DRAM 1- 64 (72) bit wide interleaved DRAM	0x0
7	BankLoc	Location of a 32-bit wide bank. 0- Even 1- Odd	0x0
8	Parity	Parity support for the bank. 0- No parity support 1- Parity supported	0x0
9	Reserved	Must be Programmed '0'.	0x0
31:10	Reserved	When written, these bits can be safely programmed to any value. When read, these bits will respond with an undefined value.	N/A

DRAM Bank1 Parameters, Offset: 0x450

Bits	Field Name	Function	Initial Value
31:0	Various	Fields function as in DRAM Bank0.	0xf

DRAM Bank2 Parameters, Offset: 0x454

Bits	Field Name	Function	Initial Value
0:8	Various	Fields function as in DRAM Bank0.	0xf
9	LinearBurst	Sub-block order or linear burst order DRAM select. 0 - Sub-block order 1 - Linear Burst order	0x0
31:10	Various	Fields function as in DRAM Bank0.	0x0

DRAM Bank3 Parameters, Offset: 0x458

Bits	Field Name	Function	Initial Value
31:0	Various	Fields function as in DRAM Bank0.	0xf

17.8 Device Parameters

Device Bank0 Parameters, Offset: 0x45c

Bits	Field name	Function	Initial Value
2:0	TurnOff	The number of cycles between the deassertion of DevOE* (an externally extracted signal which is the logical OR between CSTiming* and inverted DevRW*) to a new AD bus cycle.	0x7
6:3	AccToFirst	The number of cycles in a read access from the assertion of CS* to the cycle that the data will be latched (by the external latches). Can be extended via the Ready* pin.	0xf
10:7	AccToNext	The number of cycles in a read access from the cycle that the first data was latched to the cycle that the next data will be latched (in burst accesses). Can be extended via the Ready* pin.	0xf
13:11	ADStoWr	The number of cycles from ADS* active to the assertion of EWr* or OWr*.	0x7
16:14	WrActive	The number of cycles EWr* or OWr* are active. Can be extended via the Ready* pin.	0x7
19:17	WrHigh	The number of cycles between deassertion and assertion of EWr* or OWr*.	0x7
21:20	DevWidth	Device width. 00 - 8 bits 01 - 16 bits 10 - 32 bits 11 - 64 bits	0x2
22	Reserved	Must be programmed '1'.	0x1
23	DevLoc	32-bit, 16-bit, or 8-bit device location. 0 - Even bank 1 - Odd bank	0x0
24	Reserved	Read only.	0x0
25	LatchFunct	Latch function in read cycles. 0 - Always transparent 1 - Latch enable signals are active.	0x0
27:26	Reserved	Read only.	0x1
29:28	Reserved	Read only.	0x1
30	Parity	Parity support for the bank. 0- No parity support 1- Parity supported	0x0
31	Reserved	When written, this bit can be safely programmed to any value. When read, this bit will respond with an undefined value.	N/A

Device Bank1 Parameters, Offset: 0x460

Bits	Field Name	Function	Initial Value
31:0	Various	Fields function as in Device Bank0.	0x146ffff

Device Bank2 Parameters, Offset: 0x464

Bits	Field Name	Function	Initial Value
31:0	Various	Fields function as in Device Bank0.	0x146ffff

Device Bank3 Parameters, Offset: 0x468

Bits	Field Name	Function	Initial Value
31:0	Various	Fields function as in Device Bank0.	0x14?ffff

Device Boot Bank Parameters, Offset: 0x46c

Bits	Field Name	Function	Initial Value
31:0	Various	Fields function as in Device Bank0.	0x14?ffff

In case of the CS[3]* or Boot Bank, bits 23:20 are shown as '?' because bits 21:20 are sampled at reset via DAdr[11:10] to define the width of the device.

17.9 DMA Record

Channel 0 DMA Byte Count, Offset: 0x800

Bits	Field Name	Function	Initial Value
15:0	ByteCt	The number of bytes that are left in DMA transfers.	0x0
31:16	Reserved		0x0

Channel 1 DMA Byte Count, Offset: 0x804

Bits	Field Name	Function	Initial Value
15:0	ByteCt	The number of bytes that are left in DMA transfers.	0x0
31:16	Reserved		0x0

Channel 2 DMA Byte Count, Offset: 0x808

Bits	Field Name	Function	Initial Value
15:0	ByteCt	The number of bytes that are left in DMA transfers.	0x0
31:16	Reserved		0x0

Channel 3 DMA Byte Count, Offset: 0x80c

Bits	Field Name	Function	Initial Value
15:0	ByteCt	The number of bytes that are left in DMA transfers.	0x0
31:16	Reserved		0x0

Channel 0 DMA Source Address, Offset: 0x810

Bits	Field Name	Function	Initial Value
31:0	SrcAdd	The address that the DMA controller will read the data from.	0x0

Channel 1 DMA Source Address, Offset: 0x814

Bits	Field Name	Function	Initial Value
31:0	SrcAdd	The address that the DMA controller will read the data from.	0x0

Channel 2 DMA Source Address, Offset: 0x818

Bits	Field Name	Function	Initial Value
31:0	SrcAdd	The address that the DMA controller will read the data from.	0x0

Channel 3 DMA Source Address, Offset: 0x81c

Bits	Field Name	Function	Initial Value
31:0	SrcAdd	The address that the DMA controller will read the data from.	0x0

Channel 0 DMA Destination Address, Offset: 0x820

Bits	Field Name	Function	Initial Value
31:0	DestAdd	The address that the DMA controller will write the data to.	0x0

Channel 1 DMA Destination Address, Offset: 0x824

Bits	Field Name	Function	Initial Value
31:0	DestAdd	The address that the DMA controller will write the data to.	0x0

Channel 2 DMA Destination Address, Offset: 0x828

Bits	Field Name	Function	Initial Value
31:0	DestAdd	The address that the DMA controller will write the data to.	0x0

Channel 3 DMA Destination Address, Offset: 0x82c

Bits	Field Name	Function	Initial Value
31:0	DestAdd	The address that the DMA controller will write the data to.	0x0

Channel 0 Next Record Pointer, Offset: 0x830

Bits	Field Name	Function	Initial Value
31:0	NextRecPtr	The address for the next record of DMA. A value of 0 means a NULL pointer (end of the chained list).	0x0

Channel 1 Next Record Pointer, Offset: 0x834

Bits	Field Name	Function	Initial Value
31:0	NextRecPtr	The address for the next record of DMA. A value of 0 means a NULL pointer (end of the chained list).	0x0

Channel 2 Next Record Pointer, Offset: 0x838

Bits	Field Name	Function	Initial Value
31:0	NextRecPtr	The address for the next record of DMA. A value of 0 means a NULL pointer (end of the chained list).	0x0

Channel 3 Next Record Pointer, Offset: 0x83c

Bits	Field Name	Function	Initial Value
31:0	NextRecPtr	The address for the next record of DMA. A value of 0 means a NULL pointer (end of the chained list).	0x0

17.10 DMA Channel Control

Channel 0 Control, Offset: 0x840

Bits	Field name	Function	Initial Value
1:0	AddControl	Sets the locations of the source/destination of the DMA access (64011/14/60 Rev P-1 and later ONLY): 00 - Source and destination are in the local address space. 01 - Source is in PCI Memory space and destination in the local address space. 10 - Destination is in PCI Memory space and source in the local address space. 11 - Source and destination are in PCI Memory space. These bits are RESERVED (must be = '00') in the GT-64011-P-0 and GT-64010A.	0x0
3:2	SrcDir	Source Direction. 00 - Increment source address 01 - Decrement source address 10 - Hold in the same value	0x0
5:4	DestDir	Destination Direction. 00 - Increment destination address 01 - Decrement destination address 10 - Hold in the same value	0x0
8:6	DataTransLim	Data Transfer Limit in each DMA access. 101 - 1 Byte 110 - 2 Bytes 000 - 4 Bytes 001 - 8 Bytes 011 - 16 Bytes 111 - 32 Bytes	0x0
9	ChainMod	Chained Mode. 0 - Chained mode; when a DMA access is terminated, the parameters of the next DMA access will come from a record in memory that a NextRecPtr register points at. 1 - Non-Chained mode; only the values that are programmed by the CPU/Local Master (or PCI) directly into the ByteCt, SrcAdd, and DestAdd registers are used.	0x0
10	IntMode	Interrupt Mode. 0 - Interrupt asserted every time the DMA byte count reaches terminal count. 1 - Interrupt every NULL pointer (in Chained mode)	0x0
11	TransMod	Transfer Mode. 0 - Demand 1 - Block	0x0
12	ChanEn	Channel Enable. 0 - Disable 1 - Enable	0x0

Bits	Field name	Function	Initial Value
13	FetNexRec	Fetch Next Record. 1 - Forces a fetch of the next record (even if the current DMA has not ended). This bit is reset after fetch is completed (meaningful only in Chained mode).	0x0
14	DMAActSt	DMA Activity Status (read only). 0 - Channel is not active 1 - Channel is active	0x0
31:15	Reserved		0x0

Channel 1 Control, Offset: 0x844

Bits	Field Name	Function	Initial Value
31:0	Various	Fields function as in Channel 0 Control.	0x0

Channel 2 Control, Offset: 0x848

Bits	Field Name	Function	Initial Value
31:0	Various	Fields function as in Channel 0 Control.	0x0

Channel 3 Control, Offset: 0x84c

Bits	Field Name	Function	Initial Value
31:0	Various	Fields function as in Channel 0 Control.	0x0

17.11 Arbiter Control, Offset: 0x860

Bits	Field name	Function	Initial Value
1:0	PrioChan1/0	Priority between Channel 0 and Channel 1. 00 - Round Robin 01 - Priority to channel 1 over channel 0 10 - Priority to channel 0 over channel 1 11 - Reserved	0x0
3:2	PrioChan3/2	Priority between Channel 2 and Channel 3. 00 - Round Robin 01 - Priority to channel 3 over 2 10 - Priority to channel 2 over 3 11 - Reserved	0x0
5:4	PrioGrps	Priority between the group of channels 0/1 and the group of channels 2/3. 00 - Round Robin 01 - Priority to channels 2/3 over 0/1 10 - Priority to channels 0/1 over 2/3 11 - Reserved	0x0
6	PrioOpt	Defines the arbiter behavior for high priority device. 0 - High priority device will relinquish the bus for a requesting device for one DMA transaction after it was serviced. 1 - High priority device will be granted as long as it requests the bus.	0x0
31:7	Reserved		0x0

17.12 Timer / Counter

Timer/Counter 0, Offset: 0x850

Bits	Field Name	Function	Initial Value
31:0	TC0Value	The counter or timer initial value.	0x0

Timer/Counter 1, Offset: 0x854

Bits	Field Name	Function	Initial Value
23:0	TC1Value	The counter or timer initial value.	0x0
31:24	Reserved		0x0

Timer/Counter 2, Offset: 0x858

Bits	Field Name	Function	Initial Value
23:0	TC2Value	The counter or timer initial value.	0x0
31:24	Reserved		0x0

Timer/Counter 3, Offset: 0x85c

Bits	Field Name	Function	Initial Value
23:0	TC3Value	The counter or timer initial value.	0x0
31:24	Reserved		0x0

Timer/Counter Control, Offset: 0x864

Bits	Field name	Function	Initial Value
0	EnTC0	The timer/counter will count only when it is enabled. 0 - Disable 1 - Enable	0x0
1	SelTC0	Timer or counter selection. 0 - Counter 1 - Timer	0x0
2	EnTC1	The timer/counter will count only when it is enabled. 0 - Disable 1 - Enable	0x0
3	SelTC1	Timer or counter selection. 0 - Counter 1 - Timer	0x0
4	EnTC2	The timer/counter will count only when it is enabled. 0 - Disable 1 - Enable	0x0
5	SelTC2	Timer or counter selection . 0 - Counter 1 - Timer	0x0
6	EnTC3	The timer/counter will count only when it is enabled. 0 - Disable 1 - Enable	0x0
7	SelTC3	Timer or counter selection. 0 - Counter 1 - Timer	0x0
31:8	Reserved		0x0

17.13 PCI Internal

Command, Offset: 0xc00

Bits	Field name	Function	Initial Value
0	ByteSwap	When set to zero, the GT-64111 swaps the incoming and outgoing PCI data. If there is a PCI Address hit in an enabled SWAP BAR, the data will be transferred OPPOSITE as it would according to the setting of ByteSwap.	Set to the same value sampled at reset into bit[12] of the CPU/ Local Master Interface Configuration register.
2:1	SyncMode ¹	Indicates the ratio between TClk and PClk as follows: 00 - When the PClk ranges from DC to 66MHz (default mode; use following settings for higher performance) 01 - When PClk frequency is HIGHER than or EQUAL to half the TClk frequency (e.g. when TClk is 66MHz, SyncMode can be set to 01 if the PCI frequency is HIGHER than or equal to 33MHz). 1x - When the two clocks are synchronized (derived from the same clock) and PClk frequency is HIGHER than or EQUAL to half the TCLK frequency(e.g. TClk = 66MHz, PClk = 33MHz)	0x0
31:3	Reserved		0x0

1. Regardless of the selected sync mode, PClk frequency must be smaller than Tclk frequency by at least 1MHz

Time Out & ReTry, Offset: 0xc04

Bits	Field name	Function	Initial Value
7:0	Timeout0	Specifies in PCI clock units the number of clocks the GT-64111, as a slave, holds the PCI bus before the generation of retry termination. Used for the first data transfer.	0x0f
15:8	Timeout1	Specifies in PCI clock units the number of clocks the GT-64111, as a slave, holds the PCI bus before the generation of disconnect termination. Used for data transfers following the first data. The number of PCI clock cycles between the last Trdy* rise and the Stop* falling are n+1, where 'n' is the Timeout1 value.	0x07
23:16	RetryCtr	Specifies the number of retries of the GT-64111 Master. The GT-64111 generates an interrupt when this timer expires. A value of 0x00 means "retry forever". The number in RetryCtr does not include the first access of the transaction.	0x00
31:24	Reserved		0x0

RAS[1:0] Bank Size, Offset: 0xc08

Bits	Field Name	Function	Initial Value
31:12	BankSize	Specifies the RAS[1:0] address mapping in conjunction with the RAS[1:0] Base Address register. Set to '0' indicates that the corresponding bit in the address and in the base address must be equal in order to have a hit. Set to '1' indicates that the corresponding bit in the address is a don't-care. For example, bit 12 set to '1' indicates that the RAS[1:0] size is 8KBytes (address bits [12:0] are changeable/don't-care). The set bits in the Bank Size must be sequential (e.g. 000...001, 000...011, 000...111 are correct values, whereas 000...010 and 000...100 are not).	0x00ff
11:0	Reserved		0x0

RAS[3:2] Bank Size, Offset: 0xc0c

Bits	Field Name	Function	Initial Value
31:12	BankSize	Specifies the RAS[3:2] address mapping in conjunction with the RAS[3:2] Base Address register. Same description and setting restrictions as outlined for RAS[1:0] Bank Size, Offset: 0xc08.	0x00ff
11:0	Reserved		0x0

CS[2:0] Bank Size, Offset: 0xc10

Bits	Field Name	Function	Initial Value
31:12	BankSize	Specifies the CS[2:0] address mapping in conjunction with the CS[2:0] Base Address register. Same description and setting restrictions as outlined for RAS[1:0] Bank Size, Offset: 0xc08.	0x01ff
11:0	Reserved		0x0

CS[3] and Boot CS Bank Size, Offset: 0xc14

Bits	Field Name	Function	Initial Value
31:12	BankSize	Specifies the CS[3] and Boot CS address mapping in conjunction with the CS[3] and Boot CS Base Address register. Same description and setting restrictions as outlined for RAS[1:0] Bank Size, Offset: 0xc08.	0x00ff
11:0	Reserved		0x0

SErr Mask, Offset: 0xc28

Bits	Field Name	Function	Initial Value
0	AddrErr	Mask bit. When set, SErr* is asserted when the GT-64111 detects a parity error on the address lines.	0x0
1	MasWrErr	Mask bit. When set, SErr* is asserted when the GT-64111 detects a parity error during a master write operation.	0x0
2	MasRdErr	Mask bit. When set, SErr* is asserted when the GT-64111 detects a parity error during a master read operation.	0x0
3	MemErr	Mask bit. When set, SErr* is asserted when a memory parity error has been detected (applicable only when an external parity checking device is used).	0x0
4	MasAbort	Mask bit. When set, SErr* is asserted when the GT-64111 performs master abort.	0x0
5	TarAbort	Mask bit. When set, SErr* is asserted when the GT-64111 detects a target abort.	0x0
31:6	Reserved		0x0

Interrupt Acknowledge, Offset: 0xc34

Bits	Field Name	Function	Initial Value
31:0	IntAck	The data is meaningless. A CPU/Local Master read operation to this register causes the GT-64111 to perform an Interrupt Acknowledge cycle on the PCI bus.	0x00000000

Base Address Registers' Enable, Offset: 0xc3c

Bits	Field name	Function	Initial Value
31:9	Reserved		0x0
8	RAS[1:0]En	Controls address matching with RAS[1:0] base/size. 0 - Enable 1 - Disable	0x0
7	RAS[3:2]En	Controls address matching with RAS[3:2] base/size. 0 - Enable 1 - Disable	Sampled at Reset via DMAReq[0]*/Ready*
6	CS[2:0]En	Controls address matching with CS[2:0] base/size. 0 - Enable 1 - Disable	Sampled at Reset via DAdr[6]
5	CS[3] & Boot CSEn	Controls address matching with CS[3] & Boot CS base/size. 0 - Enable 1 - Disable	Sampled at Reset via DAdr[3]
4	IntMeMEen	Controls address matching with internal registers-Memory mapped base/size. 0 - Enable 1 - Disable	0x0

Bits	Field name	Function	Initial Value
3	IntIOEn	Controls address matching with internal registers I/O mapped base/size. 0 - Enable 1 - Disable	0x1
2	SwRAS[1:0]En	Controls address matching with Swapped RAS[1:0] base/size. 0 - Enable 1 - Disable	0x1
1	SwRAS[3:2]En	Controls address matching with Swapped RAS[3:2] base/size. 0 - Enable 1 - Disable	0x1
0	SwCS[3] & Boot CSEn	Controls address matching with Swapped CS[3] & Boot CS base/size. 0 - Enable 1 - Disable	0x1

The GT-64111 prevents disabling both memory mapped base/size address matching and I/O mapped base/size address matching at the same time (bits 3 and 4 cannot simultaneously be set to 1).

Configuration Address, Offset: 0xcf8

Bits	Field Name	Function	Initial Value
7:2	RegNum	Indicates the register number.	0x00
10:8	FunctNum	Indicates the function type.	0x0
15:11	DevNum	Indicates the device number.	0x00
23:16	BusNum	Indicates the bus number.	0x00
31	ConfigEn	When set, an access to the Configuration Data register is translated into a Configuration or Special cycle on the PCI bus.	0x0

Configuration Data, Offset: 0xcfc

Bits	Field Name	Function	Initial Value
31:0	Config	The data is transferred to/from the PCI bus when the CPU/Local Master accesses this register and the ConfigEn bit in the Configuration Address register is set. A CPU/Local Master access to this register causes the GT-64111 to perform a Configuration or Special cycle on the PCI bus.	0x000

17.14 Interrupts

Interrupt Cause, Offset: 0xc18 (all bits are cleared by writing a value of '0' by the CPU/ Local Master or PCI, unless stated otherwise)

Bits	Field Name	Function	Initial Value
0	IntSum	Interrupt summary. Logical OR of all the interrupt bits, regardless of the Mask registers' values.	0x0 Read only
1	MemOut	Asserts when the CPU/Local Master or PCI accesses an address out of range in the Device Decoders or a burst access to 8-/16-bit devices.	0x0
2	DMAOut	Asserts when the DMA accesses an address out of range.	0x0
3	CPU/Local Master-Out	Asserts when the CPU/Local Master accesses an address out of the CPU/Local Master decode.	0x0
4	DMA0Comp	Asserts at completion of DMA Channel 0 transfer.	0x0
5	DMA1Comp	Asserts at completion of DMA Channel 1 transfer.	0x0
6	DMA2Comp	Asserts at completion of DMA Channel 2 transfer.	0x0
7	DMA3Comp	Asserts at completion of DMA Channel 3 transfer.	0x0
8	T0Exp	Asserts when Timer 0 expires.	0x0
9	T1Exp	Asserts when Timer 1 expires.	0x0
10	T2Exp	Asserts when Timer 2 expires.	0x0
11	T3Exp	Asserts when Timer 3 expires.	0x0
12	MasRdErr	Asserts when the GT-64111 detects a parity error during a master read operation.	0x0
13	SlvWrErr	Asserts when the GT-64111 detects a parity error during a slave write operation.	0x0
14	MasWrErr	Asserts when the GT-64111 detects a parity error during a master write operation.	0x0
15	SlvRdErr	Asserts when the GT-64111 detects a parity error during a slave read operation.	0x0
16	AddrErr	Asserts when the GT-64111 detects a parity error on the address lines.	0x0
17	MemErr	Asserts when a memory parity error is detected. Applicable only when an external parity checking device is used.	0x0
18	MasAbort	Asserts upon master abort.	0x0
19	TarAbort	Asserts upon target abort.	0x0
20	RetryCtr	Asserts when the retry counter expires.	0x0
25:21	CPU/Local Master-Int	These bits are set by the CPU/Local Master by writing '0' to generate an interrupt on the PCI bus. They are cleared when the PCI writes '0'.	0x0
29:26	PCIInt	These bits are set by the PCI by writing '0' to generate an interrupt on the CPU/Local Master. They are cleared when the CPU/Local Master writes '0'.	0x0

Bits	Field Name	Function	Initial Value
30	CPU/Local Master-IntSum	Interrupt summary. Logical OR of bits[29:26,20:1], masked by bits[29:26,20:1] of the CPU/Local Master Mask register.	0x0
31	PCIIntSum	Interrupt summary. Logical OR of bits[25:1], masked by bits[25:1] of the PCI Mask register.	0x0

CPU/Local Master Mask, Offset: 0xc1c

Bits	Field Name	Function	Initial Value
31:0	CPU/Local Master-Mask	Mask to the CPU/Local Master interrupt line for the appropriate bits in the Interrupt Cause register. Bits 0, 25:21, 31:30 are read-only "0". 0 - Mask Interrupt 1 - Do not Mask Interrupt	0x00000000

PCI Mask, Offset: 0xc24

Bits	Field Name	Function	Initial Value
31:0	PCIMask	Mask to the PCI interrupt line for the appropriate bits in the Interrupt Cause register. Bits 0, 31:26 are read-only "0". 0 - Mask Interrupt 1 - Do not Mask Interrupt	0x00000000

17.15 PCI Configuration Registers

Device and Vendor ID, Offset: 0x000

Bits	Field name	Function	Initial Value
31:16	DevID	Provides the unique GT-64111 ID number (0x146).	0x4146
15:0	VenID	Provides the manufacturer of the GT-64111 (0x11ab).	0x11ab

Status and Command, Offset: 0x004

Bits	Field name	Function	Initial Value
0	IOEn	Controls the GT-64111's response to I/O accesses. 0 - Disable 1 - Enable	0x0
1	MEMEn	Controls the GT-64111's response to Memory accesses. 0 - Disable 1 - Enable	0x0
2	MasEn	Controls the GT-64111's ability to act as a master on the PCI bus. 0 - Disable 1 - Enable	0x0
3	Reserved		0x0
4	MemWrInV	Controls the GT-64111's ability to generate Memory Write & Invalidate command on the PCI bus. 0 - Disable 1 - Enable	0x0
5	Reserved		0x0
6	PErrEn	Controls the GT-64111's ability to respond to parity errors on the PCI by asserting the PErr* pin. 0 - Disable 1 - Enable	0x0
7	Reserved		0x0
8	SErrEn	Controls the GT-64111's ability to assert the SErr* pin. 0 - Disable 1 - Enable	0x0
21:9	Reserved		0x0
22	66MHzEn	66MHz Capable (GT-64111 PCI interface is capable of running at 66MHz regardless of this bit value).	Sampled at Reset via pin 15
23	TarFastBB	Read only bit. Indicates that the GT-64111 is capable of accepting fast back-to-back transactions on the PCI bus.	0x1
24	DataParDet	This bit is set by the GT-64111 when it detects a data parity error during master operation.	0x0
27:25	DevSelTim	These pins indicate the GT-64111 's DevSel timing (medium), per the PCI standard.	0x1 Read only
28	TarAbort	This bit is set upon Target Abort.	0x0
29	MasAbort	This pin is set upon Master Abort.	0x0

Bits	Field name	Function	Initial Value
30	SysErr	This pin is set upon System Error.	0x0
31	DetParErr	This pin is set upon detection of Parity error (in both, master and slave operations).	0x0

Class Code and Revision ID, Offset: 0x008¹

Bits	Field name	Function	Initial Value
7:0	RevID	Indicates the GT-64111 Revision number. GT-64111-P-0 = 0x10 ¹	0x10
15:8	Reserved		0x0
23:16	SubClass	Indicates the GT-64111 Subclass (0x80 - other memory controller)	0x80
31:24	BaseClass	Indicates the GT-64111 Base Class (0x5 - memory controller).	0x05

1. RevID does not start at 0x01 in order to leave "space" for future frevs of the GT-64011

BIST, Header Type, Latency Timer, Cache Line, Offset: 0x00c

Bits	Field name	Function	Initial Value
7:0	CacheLine	Specifies the GT-64111's cache line size	0x00
15:8	LatTimer	Specifies in units of PCI bus clocks the value of the latency timer of the GT-64111.	0x00
23:16	HeadType	Specifies the layout of bytes 10h through 3fh.	0x00
31:24	BIST	Built In Self Test, Reserved	0x00

The BIST Field is reserved and is hardwired to 0.

Device and Vendor ID (0x000), Class Code and Revision ID (0x008), and Header Type (0x00e) fields are ready only from the PCI bus. These fields can be modified and read via the CPU/Local Master bus.

For more information on these fields, please refer to the PCI specification.

RAS[1:0] Base Address, Offset: 0x010

Bits	Field Name	Function	Initial Value
2:0	Reserved		0x0
3	Prefetch	READ ONLY	0x1
11:4	Reserved		0x0
31:12	Base	Defines the address assignment of RAS[1:0] (see RAS[1:0] Bank Size	0x00000

1. The GT-64111 Class Code is different than in the GT-64011. Please see the PCI section for details.

RAS[3:2] Base Address, Offset: 0x014

Bits	Field Name	Function	Initial Value
2:0	Reserved		0x0
3	Prefetch	READ ONLY	0x1
11:4	Reserved		0x0
31:12	Base	Defines the address assignment of RAS[3:2] (see RAS[3:2] Bank Size).	0x01000

CS[2:0] Base Address, Offset: 0x018

Bits	Field Name	Function	Initial Value
2:0	Reserved		0x0
3	Prefetch	READ ONLY	0x1
11:4	Reserved		0x0
31:12	Base	Defines the address assignment of CS[2:0] (see CS[2:0] Bank Size).	0x1c000

CS[3] and Boot CS Base Address, Offset: 0x01c

Bits	Field Name	Function	Initial Value
2:0	Reserved		0x0
3	Prefetch	READ ONLY	0x1
11:4	Reserved		0x0
31:12	Base	Defines the address assignment of CS[3] and Boot CS (see CS[3] and Boot CS Bank Size).	0x1f000

Internal Registers Memory Mapped Base Address, Offset: 0x020

Bits	Field Name	Function	Initial Value
11:0	Reserved		0x0
31:12	MemMapBase	Defines the address assignment of the GT-64111's internal registers.	0x14000

Internal Registers I/O Mapped Base Address, Offset: 0x024

Bits	Field Name	Function	Initial Value
11:0	Reserved		0x0
31:12	IOMapBase	Defines the address assignment of the GT-64111's internal registers.	0x14000

Board/System Device and Vendor ID, Offset: 0x02c

Bits	Field name	Function	Initial Value
15:0	VenID	Provides the unique Board/System ID number.	0x0
31:16	DevID	Provides the unique Board/System ID number.	0x0

Expansion ROM Base Address Register, Offset: 0x030

Bits	Field Name	Function	Initial Value
0	ERDecEn	Expansion ROM Decode Enable 0 - Disable 1 - Enable	0x0
11:1	Reserved		0x0
31:12	ERBase	Defines the address of the expansion ROM memory space region assigned to the GT-64111. This is where the expansion ROM code will appear in system memory when bit 0 of this register contains a value of 1 and bit 1 of this device's Command Register contains a value of 1.	0x1f000

Interrupt Pin and Line, Offset: 0x03c

Bits	Field name	Function	Initial Value
7:0	IntLine	Provides interrupt line routing information.	0x00
15:8	IntPin	Indicates which interrupt pin is used by the GT-64111. The GT-64111 uses INTA.	0x01
31:16	Reserved		0x0

17.15.1 FUNCTION 1 CONFIGURATION REGISTERS

These registers can only be accessed by specifying Function 1 during PCI Configuration cycles.

Function 1 RAS[1:0] Swapped Base Address, Offset: 0x010

Bits	Field Name	Function	Initial Value
2:0	Reserved		0x0
3	Prefetch	READ ONLY	0x1
11:4	Reserved		0x0
31:12	Base	Defines the address assignment of swapped RAS[1:0] (see RAS[1:0] Bank Size).	0x0000

Function 1 RAS[3:2] Swapped Base Address, Offset: 0x014

Bits	Field Name	Function	Initial Value
2:0	Reserved		0x0
3	Prefetch	READ ONLY	0x1
11:4	Reserved		0x0
31:12	Base	Defines the address assignment of swapped RAS[3:2] (see RAS[3:2] Bank Size).	0x01000

Function 1 CS[3] and Boot CS Swapped Base Address, Offset: 0x01c

Bits	Field Name	Function	Initial Value
2:0	Reserved		0x0
3	Prefetch	READ ONLY	0x1
11:4	Reserved		0x0
31:12	Base	Defines the address assignment of swapped CS[3] and Boot CS (see CS[3] and Boot CS Bank Size).	0x1f000

For more information on these fields, please refer to the PCI specification.

18. PINOUT TABLE, 208 pin PQFP (sorted by number)

Pin #	Signal Name	Pin #	Signal Name	Pin #	Signal Name
1	VDD	36	PAD[15]	71	SysCmd[1]
2	PAD[27]	37	PAD[14]	72	SysCmd[0]
3	PAD[26]	38	VSS	73	SysAD[0]
4	PAD[25]	39	PAD[13]	74	SysAD[1]
5	PAD[24]	40	PAD[12]	75	SysAD[2]
6	CBE[3]*	41	PAD[11]	76	SysAD[3]
7	IDSel	42	PAD[10]	77	SysAD[4]
8	VSS	43	PAD[9]	78	SysAD[5]
9	VDD	44	VSS	79	VSS
10	PAD[23]	45	VDD	80	Vio
11	PAD[22]	46	PAD[8]	81	VDD
12	PAD[21]	47	CBE[0]*	82	SysAD[6]
13	PAD[20]	48	PAD[7]	83	SysAD[7]
14	PAD[19]	49	PAD[6]	84	SysAD[8]
15	VSS	50	PAD[5]	85	SysAD[9]
16	VDD	51	VSS	86	SysAD[10]
17	VSS	52	VDD	87	SysAD[11]
18	PAD[18]	53	PAD[4]	88	SysAD[12]
19	PAD[17]	54	PAD[3]	89	SysAD[13]
20	PAD[16]	55	PAD[2]	90	VSS
21	CBE[2]*	56	PAD[1]	91	TCIk
22	Frame*	57	PAD[0]	92	VDD
23	VSS	58	VSS	93	SysAD[14]
24	VDD	59	Must be pulled to VDD ¹	94	SysAD[15]
25	IRdy*	60	DMAReq[3]*	95	SysAD[16]
26	TRdy*	61	Interrupt*	96	SysAD[17]
27	DevSel*	62	SysCmd[8]	97	SysAD[18]
28	Stop*	63	SysCmd[7]	98	VSS
29	Lock*	64	SysCmd[6]	99	VDD
30	PErr*	65	SysCmd[5]	100	SysAD[19]
31	VSS	66	SysCmd[4]	101	SysAD[20]
32	VDD	67	VSS	102	SysAD[21]
33	SErr*	68	VDD	103	SysAD[22]
34	Par	69	SysCmd[3]	104	SysAD[23]
35	CBE[1]*	70	SysCmd[2]	105	SysAD[24]

Pin #	Signal Name	Pin #	Signal Name	Pin #	Signal Name
106	SysAD[25]	141	AD[23]	176	OCAS[2]*
107	SysAD[26]	142	AD[22]	177	OCAS[1]*
108	SysAD[27]	143	VSS	178	OCAS[0]*
109	SysAD[28]	144	VDD	179	RAS[3]*
110	VSS	145	AD[21]	180	RAS[2]*
111	VDD	146	AD[20]	181	RAS[1]*
112	SysAD[29]	147	AD[19]	182	RAS[0]*
113	SysAD[30]	148	AD[18]	183	DAdr[11]/ADS*
114	SysAD[31]	149	AD[17]	184	DAdr[10]/OWr[3]*
115	ValidOut*	150	AD[16]	185	VSS
116	ValidIn*	151	AD[15]	186	DAdr[9]/OWr[2]*
117	WrRdy*	152	AD[14]	187	DAdr[8]/OWr[1]*
118	Release*	153	AD[13]	188	DAdr[7]/OWr[0]*
119	DMAReq[0]*/Ready*	154	VSS	189	DAdr[6]/EWr[3]*
120	DMAReq[1]*/ParErr*	155	AD[12]	190	DAdr[5]/EWr[2]*
121	LEAdrE/DMAReq[2]*	156	AD[11]	191	DAdr[4]/EWr[1]*
122	LEAdrO	157	AD[10]	192	DAdr[3]/EWr[0]*
123	OEB	158	AD[9]	193	DAdr[2]/BAAdr[2]
124	OEE*	159	AD[8]	194	DAdr[1]/BAAdr[1]
125	OEO*	160	AD[7]	195	DAdr[0]/BAAdr[0]
126	VSS	161	AD[6]	196	Int*
127	LEE	162	AD[5]	197	Rst*
128	LEO	163	AD[4]	198	VDD
129	ALE	164	AD[3]	199	PClk
130	CSTiming*	165	VSS	200	VSS
131	AD[31]/CS[3]*	166	AD[2]	201	Gnt*
132	AD[30]/CS[2]*	167	AD[1]/DevRW*	202	Req*
133	AD[29]/CS[1]*	168	AD[0]/BootCS*	203	VSS
134	AD[28]/CS[0]*	169	DWr*	204	PAD[31]
135	AD[27]/DMAAck[3]*	170	ECAS[3]*	205	PAD[30]
136	AD[26]/DMAAck[2]*	171	ECAS[2]*	206	PAD[29]
137	AD[25]/DMAAck[1]*	172	ECAS[1]*	207	PAD[28]
138	VSS	173	ECAS[0]*	208	VSS
139	VDD	174	VDD		
140	AD[24]/DMAAck[0]*	175	OCAS[3]*		

1. Pin 59 must NOT be tied directly to VDD. It must be pulled up to VDD through a resistor (Galileo recommends 4.7KOhm).

19. DC CHARACTERISTICS - PRELIMINARY/SUBJECT TO CHANGE

19.1 Absolute Maximum Ratings

Symbol	Parameter	Min.	Max.	Unit
Vdd	Supply Voltage	-0.3	4	V
Vi	Input Voltage	-0.3	5.5	V
Vo	Output Voltage	-0.3	Vdd+0.3	V
Io	Output Current		24	mA
Iik	Input Protect Diode Current		+/-20	mA
Iok	Output Protect Diode Current		+/-20	mA
Tc	Operating Case Temperature	0	105	C
Tstg	Storage Temperature	-40	125	C
ESD			2000	V

19.2 Recommended Operating Conditions

Symbol	Parameter	Min.	Typ.	Max.	Unit
Vdd	Supply Voltage	3.15	3.3	3.45	V
Vi	Input Voltage (peripheral @ 3.3V)	0		3.45	V
Vi	Input Voltage (peripheral @ 5.0V)	0		5.25	
Vo	Output Voltage	0		Vdd	V
Tc	Operating Case Temperature	0		70	C
Cin	Input Capacitance		7.2		pF
Cout	Output Capacitance		7.2		pF

19.3 DC Electrical Characteristics Over Operating Range

(Tc=0-70°C; Vdd=+3.3V, +/-5%)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Vih	Input HIGH level	Guaranteed Logic HIGH level	2.0		Vperipheral + 0.5	V
Vil	Input LOW level	Guaranteed Logic LOW level	-0.5		0.8	V

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Voh	Output HIGH Voltage: DWr*, DAdr[0]/BAdr[0], DAdr[1]/BAdr[1], DAdr[2]/ BAdr[2], DAdr[3]/EWr[0]*, DAdr[6:4]/EWr[3:1]*, DAdr[10:7]/OWr[3:0]*, DAdr[11]/ADS*, RAS[3:0]*, ECAS[3:0]*, OCAS[3:0]*, AD[31:28]/ CS[3:0]*, AD[27:24]/ DMAAck[3:0]*, AD[23:2], Output HIGH Voltage: AD[1]/DevRW*, AD[0]/ BootCS*, CSTiming*, ALE, LEO, LEE, OEO*, OEE*, OEB, LEAdrO, LEAdrE/DMAReq[2]*	IoH = 16 mA	2.4			V
Voh	Output HIGH Voltage: SysAd[31:0], SysCmd[8:0], WrRdy*, ValidIn*	IoH = 12 mA	2.4			V
Voh	Output HIGH Voltage: Interrupt*	IoH = 8 mA	2.4			V
Vol	Output LOW Voltage: DWr*, DAdr[0]/BAdr[0], DAdr[1]/BAdr[1], DAdr[2]/ BAdr[2], DAdr[3]/EWr[0]*, DAdr[6:4]/EWr[3:1]*, DAdr[10:7]/OWr[3:0]*, DAdr[11]/ADS*, RAS[3:0]*, ECAS[3:0]*, OCAS[3:0]*, AD[31:28]/ CS[3:0]*, AD[27:24]/ DMAAck[3:0]*, AD[23:2], AD[1]/DevRW*, AD[0]/ BootCS*, CSTiming*, ALE, LEO, LEE, OEO*, OEE*, OEB, LEAdrO, LEAdrE/DMAReq[2]*	IoL = 16 mA			0.4	V
Vol	Output HIGH Voltage: SysAd[31:0], SysCmd[8:0], WrRdy*, ValidIn*	IoL = 12 mA			0.4	V
Vol	Output LOW Voltage: Interrupt*	IoL = 8 mA			0.4	V
lih	Input HIGH Current				+-1	uA
lil	Input LOW Current				+-1	uA
lozh	High Impedance Output Current				+-1	uA
lozl	High Impedance Output Current				+-1	uA

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Vh	Input Hysteresis		TBD	TBD	TBD	mV
Icc	Operating Current	VCC=3.45V, f = 66MHz			200	mA

19.4 Thermal Data

Table 30 shows the package thermal data for the GT-64111. Please check with Galileo if you are in doubt as to thermal considerations for your system.

Table 30: 208 PQFP Thermal Data

Parameter	Definition	Value
θ_{jc}	Thermal resistance: junction to case, 0 m/s airflow	12 C/W
θ_{ca}	Thermal resistance: case to ambient 0 m/s airflow	18.1 C/W
	1 m/s airflow	16.5 C/W
	2 m/s airflow	15.1 C/W

20. AC TIMING - TARGETS/SUBJECT TO CHANGE

(TC_{Case}= 0-70°C; VDD= +3.3V, +/- 5%)

Symbol	Signals	Description	Min	Max	Unit
t1	TCIk	Pulse Width High	6		ns
t2	TCIk	Pulse Width Low	6		ns
t3	TCIk	Clock Period	15	30	ns
t4	TCIk	Rise Time		2.5	ns
t5	TCIk	Fall Time		2.5	ns
t6	Rst*	Active	10		TCIk
t7	DMAReq[3]*, LEAdrE/ DMAReq[2]*, DMAReq[1]*/ParErr*, AD[31:0], DMAReq[0]*/ Ready*	Setup (as DMAReq[0]*)	5		ns
t8	DMAReq[0]*/Ready*,	Setup (as Ready*)	7		ns
t9	WrRdy*, ValidIn*, SysAD[31:0], SysCmd[8:0], Interrupt*	Delay	2	9	ns
t10	DAdr[11:0]	Delay (Row Address)	3	15	ns
t11	DAdr[11:0]	Delay (Column Address)	2	11	ns
t12	BAdr[2:0], ADS*	Delay	2	10	ns
t13	EW[3:0]*, OW[3:0]*	Delay From TCIk Falling Edge	2	8	ns
t14	DWr*, CSTiming*, ALE,	Delay	2	8	ns
t15	ECAS[3:0]*, OCAS[3:0]*, OEB, OEO*, OEE*, AD[31:0]	Delay	2	8	ns
t16	ALE, LEO, LEE	Delay from TCIk Falling Edge	2	9	ns
t17	ValidOut*, Release*, DMAReq[3]*, LEAdrE/ DMAReq[2]*, DMAReq[1]*/ParErr*, SysAD[31:0], SysCmd[8:0], AD[31:0], DMAReq[0]*/Ready*	Hold	1		ns
t18	ValidOut*, Release*, SysAD[31:0], SysCmd[8:0]	Setup	3		ns

t19	LEAdrE/DMAReq[2]*, LEAdrO	Delay	2	9	ns
t20	LEAdrE/DMAReq[2]*, LEAdrO	Delay From TClk Falling Edge	2	9	ns
t21	LEO, LEE	Delay	2	8	ns
t22	RAS[3:0]*	Delay	3	8	ns

TABLE 31. PCI Signals

Symbol	Signals	Description	Min	Max	Unit
	PClk	Clock Period	15		ns
	PAD[31:0], Frame*, IRdy*, TRdy*, DevSel*, Gnt*	Setup	4		ns
	CBE[3:0], Par, Stop*, Lock*, IDSel, PErr*	Setup	3		ns
	PAD[31:0], CBE[3:0]*, Par, Frame*, IRdy*, TRdy*, Stop*, Lock*, IDSel*, DevSel*, Gnt*, PErr*	Hold	0		ns
	PAD[31:0], CBE[3:0], Par, Frame*, IRdy*, TRdy*, Stop*, DevSel*, Req*, PErr*, SErr*, Int*	Output Delay	2	7	ns

Notes:

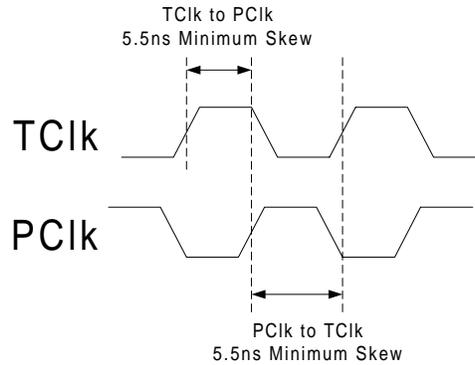
1. All Delays, Setup, and Hold times are referred to TClk rising edge, unless stated otherwise.
2. All outputs are specified for 50pF load except: WrRdy*, ValidIn*, ALE, LEAdrO, LEAdrE/DMAReq[2]* - 30pF, Interrupt* - 20 pF.

20.1 TClk/PClk Restrictions

The TClk frequency must be greater than PClk by at least 1 MHz ($f_{tclk} > f_{pclk} + 1 \text{ MHz}$). This restriction applies to all sync modes.

There is one exception to this restriction. If $f_{tclk} = f_{pclk}$ and the two clocks are synchronized (derived from the same clock generator), a minimum skew of 5.5ns must be observed between rising edge of TClk and PClk, as shown in Figure 26. Galileo recommends using an inverted TClk as PClk in order to guarantee this skew.

Figure 26: TCik = PCik Skew Requirement



In addition to the above restriction, there are few sync modes specific restrictions, summarized in Table 32.

TABLE 32. TCik/PCik Restrictions

Sync Mode	PCik Frequency Range	Restrictions
0	from DC up to TCik	$T_{pclk} > T_{tclk} + 1.5ns$, unless running with TCik = PCik synchronized.
1	from TCik/2 up to TCik	$f_{pclk} > f_{tclk}/2 + 1 \text{ MHz}$, unless running with synchronized $f_{pclk} = f_{tclk}/2$ and minimum skew of 5.5ns between PCik rise and every second TCik rise is guaranteed.
2	from TCik/2 up to TCik	TCik and PCik are synchronized. $f_{pclk} = f_{tclk}/2$ is allowed only if a minimum skew of 5.5ns between PCik rise and every second TCik rise is guaranteed.

The sync mode can be programmed by the CPU, the PCI or during autoloading. For sync mode information, see Section 17.13.

Figure 27: TCik and Reset Timing Waveform

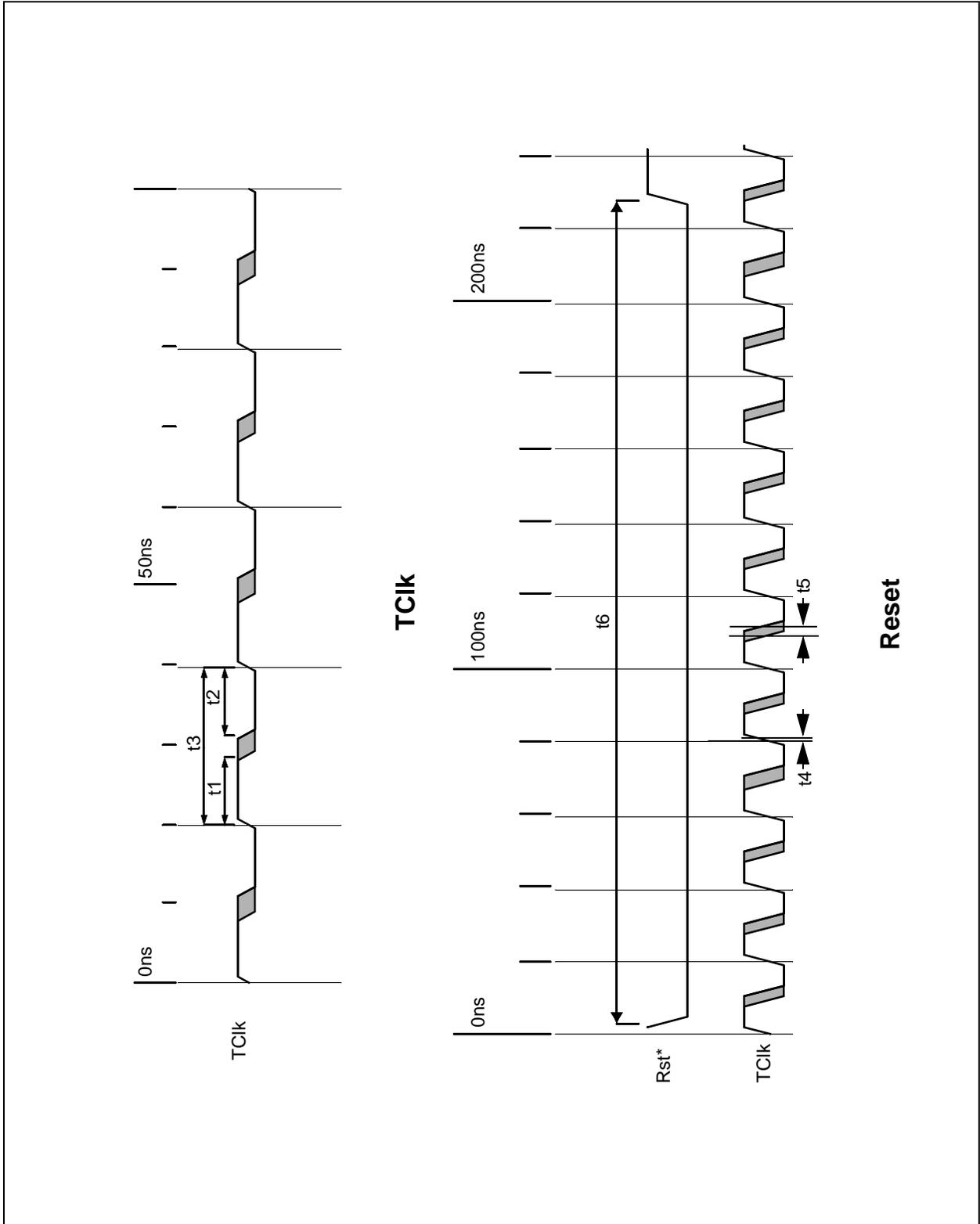


Figure 28: Block Write to DRAM, CasToRasWr = 1, CasWr = 0

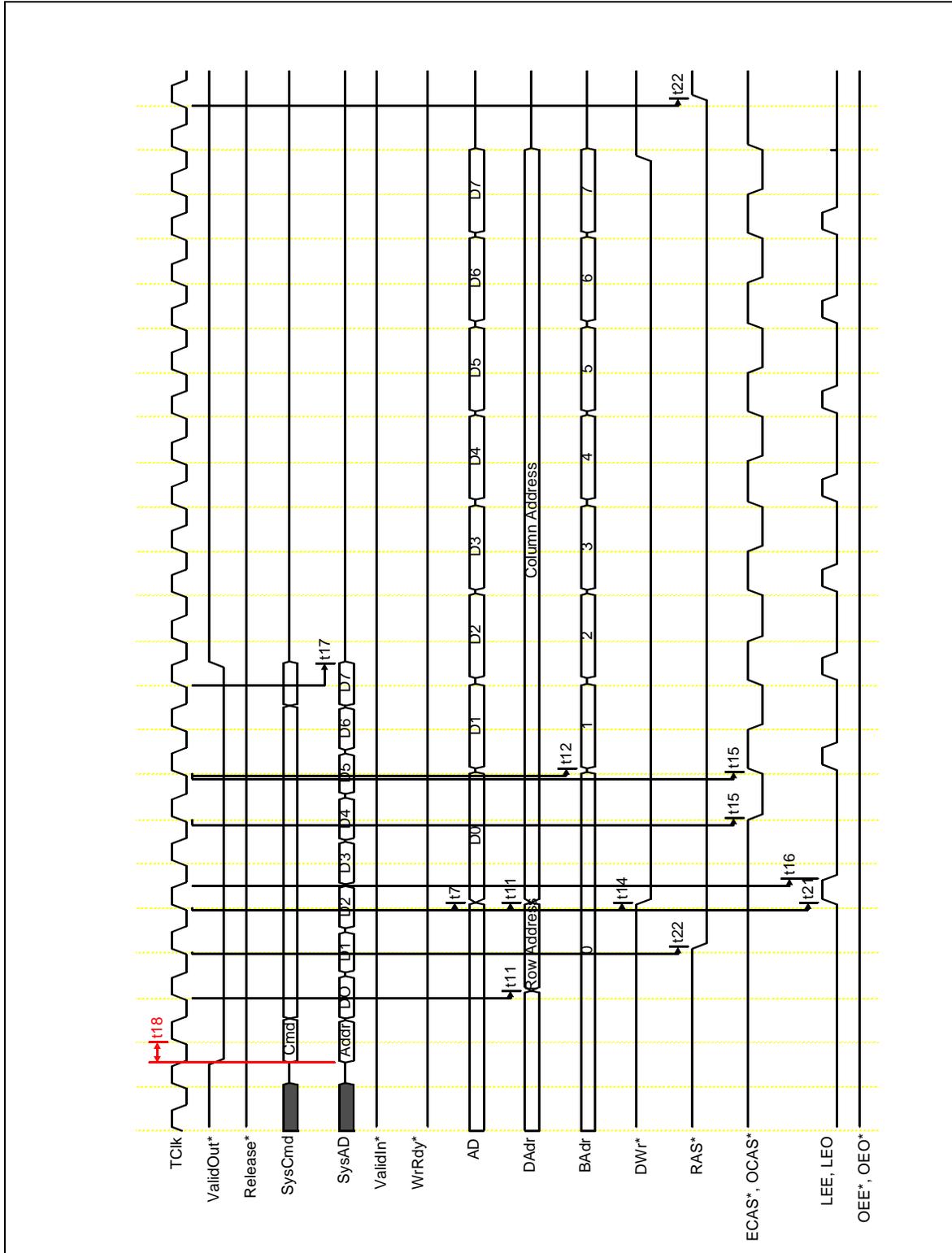
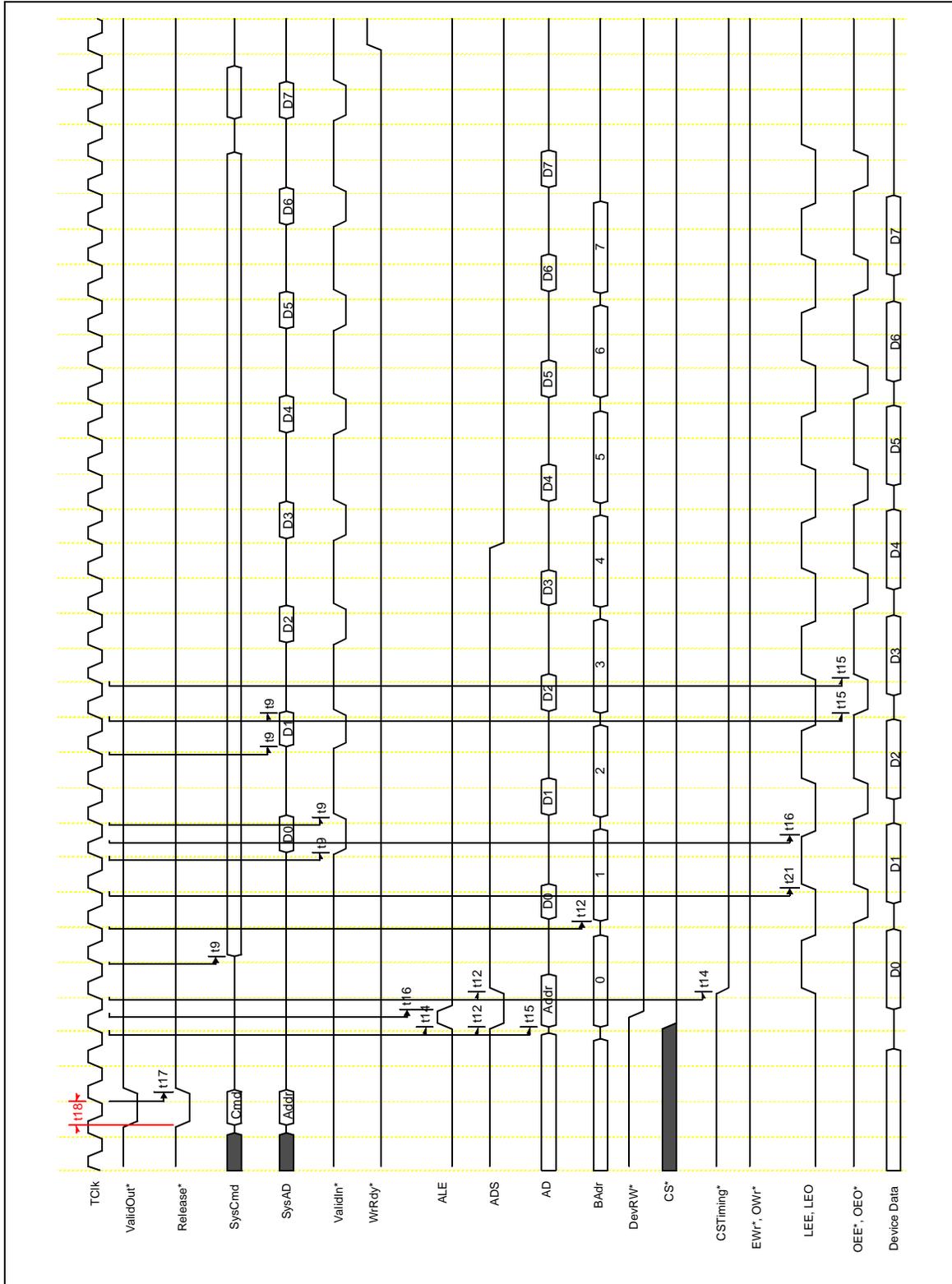


Figure 29: Block Read from 32-bit Device, AccToFirst = 3, AccToNext = 3



21. Functional Waveforms

Functional waveforms are not included in this datasheet. Transcribing waveforms from simulator outputs to “real world” documentation is extremely error prone and we do not currently have a tool that can do it effectively. Rather than risk introducing errors, Galileo Technology provides a separate electronic document that included several dozen functional waveforms. The waveform summary is available on our website: www.galileot.com (look in the “Library” area). Hard-copies can also be ordered by contacting us at 408-451-1400.

22. Packaging

Figure 30: 208 Lead PQFP Package Outline

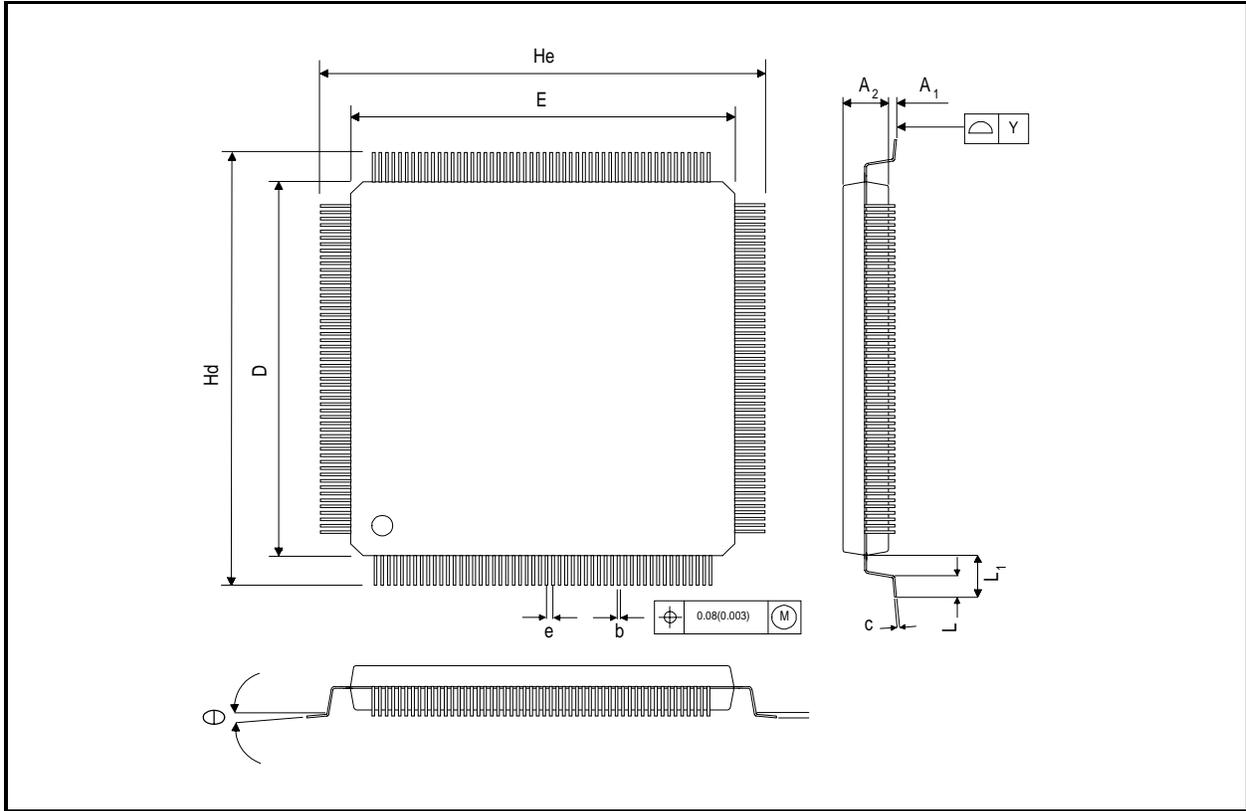


Table 33: 208 PQFP Package Dimensions

MILLIMETERS			
SYMBOL	MIN.	NOM.	MAX.
A ₁	0.05	0.25	0.50
A ₂	3.17	3.32	3.47
b	0.10	0.20	0.30
c	0.10	0.15	0.20
D	27.90	28.00	28.10
E	27.90	28.00	28.10
e		0.50	
Hd	30.35	30.60	30.85
He	30.35	30.60	30.85
L	0.45	0.60	0.75
L ₁		1.30	
Y			0.08
Q	0		7

23. Revision History

Table 34: Document History

Document Type	Rev. Number	Date	Comments
Product Review	0.9	1/19/98	First release, based on rev 1.3 GT-64011 spec.
Product Review	1.0	3/24/98	Second Release.
Data Sheet	1.1	FEB 4, 1999	<ol style="list-style-type: none"> 1. Add TCclk/PClk ratio restriction, Section 20.1. 2. CPU Restrictions, Section 3.8. 3. PCI parity support, Section 6.6. 4. Correct Device parameter regs initial values, Section 17.8. 5. Add PCI sync modes clarification, Section 17.13. 6. Add 66MHz capable bit, Section 6.8 Section 17.15. 7. ICC specification, Section 19.3. 8. Thermal Data, Section 19.4. 9. PCI AC Timing Update. Minimum setup requirement change from 3ns to 4ns on PAD[31:0], Frame*, IRdy*, TRdy*, DevSel*, Gnt*. All output delays changed from 6ns to 7ns, Section 20.